



# GD25R512ME

# DATASHEET



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## 1 FEATURES

- ◆ 512M-bit Serial Flash
  - 64M-Byte
  - 256 Bytes per programmable page
- ◆ Standard, Quad SPI, DTR, QPI
  - Standard SPI: SCLK, CS#, SI, SO, WP#, RESET#
  - Quad SPI: SCLK, CS#, IO0, IO1, IO2, IO3, RESET#
  - QPI: SCLK, CS#, IO0, IO1, IO2, IO3, RESET#
  - SPI DTR (Double Transfer Rate) Read
  - 3 or 4-Byte Address Mode
- ◆ High Speed Clock Frequency
  - 104MHz for fast read
  - Quad I/O Data transfer up to 416Mbits/s
  - QPI Mode Data transfer up to 416Mbits/s
  - DTR Quad I/O Data transfer up to 60MBytes/s
- ◆ Software/Hardware Write Protection
  - Write protect all/portion of memory via software
  - Enable/Disable protection with WP# Pin
  - Individual Block Protection
- ◆ Endurance and Data Retention
  - Minimum 100,000 Program/Erase Cycles
  - 20-year data retention typical
- ◆ RPMC Function
  - Four 32-bit Monotonic Counters
  - Volatile HMAC Key Register
  - Non-volatile Root Key Register
- ◆ Fast Program/Erase Speed
  - Page Program time: 0.15ms typical
  - Sector Erase time: 30ms typical
  - Block Erase time: 0.15/0.22s typical
  - Chip Erase time: 150s typical
- ◆ Flexible Architecture
  - Sector of 4K-Byte
  - Block of 32/64K-Byte
  - Erase/Program Suspend/Resume
- ◆ Low Power Consumption
  - 17 $\mu$ A typical stand-by current
  - 3 $\mu$ A typical power-down current
- ◆ Advanced Security Features
  - 128-bit Unique ID
  - 4K-Byte Security Registers With OTP Lock
- ◆ Single Power Supply Voltage
  - Full voltage range: 2.7~3.6V
- ◆ Package Information
  - SOP16 300mil
  - WSON8 (8x6mm)



## 2 GENERAL DESCRIPTIONS

The GD25R512ME (512M-bit) Serial flash supports the standard Serial Peripheral Interface (SPI), and supports the Quad SPI and DTR mode: Serial Clock, Chip Select, Serial Data I/O0 (SI), I/O1 (SO), I/O2 (WP#), I/O3, and RESET#. The Quad I/O & Quad output data is transferred with speed of 52MBytes/s, and the DTR Quad I/O data is transferred with speed of 60MBytes/s.

### CONNECTION DIAGRAM AND PIN DESCRIPTION

Figure 1 Connection Diagram for SOP16 package

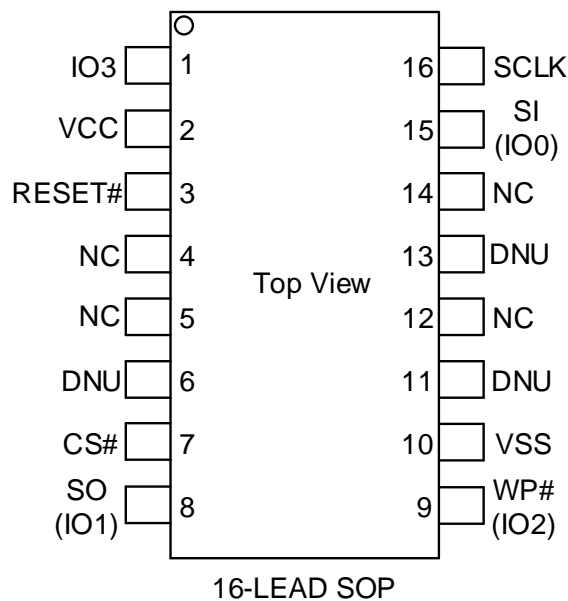


Table 1 Pin Description for SOP16 package

| Pin No. | Pin Name  | I/O | Description   |
|---------|-----------|-----|---|
| 1       | IO3       | I/O | Data Input Output 3                                   |
| 2       | VCC       |     | Power Supply  |
| 3       | RESET#    | I   | Reset Input   |
| 6/11/13 | DNU       |     | Do Not Use (It may connect to internal signal inside) |
| 7       | CS#       | I   | Chip Select Input                                     |
| 8       | SO (IO1)  | I/O | Data Output (Data Input Output 1)                     |
| 9       | WP# (IO2) | I/O | Write Protect Input (Data Input Output 2)             |
| 10      | VSS       |     | Ground  |
| 15      | SI (IO0)  | I/O | Data Input (Data Input Output 0)                      |
| 16      | SCLK      | I   | Serial Clock Input                                    |

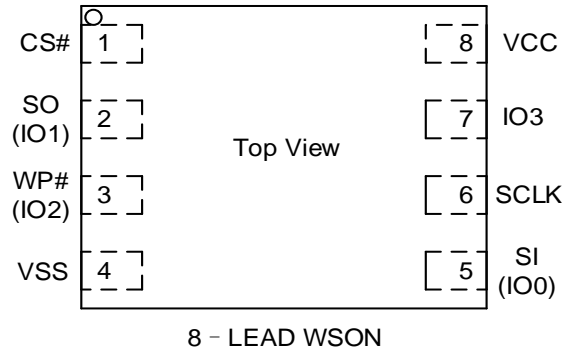
Note:

1. CS# must be driven high if chip is not selected. Please don't leave CS# floating any time after power is on.
2. The DNU pin must be floating. It may connect to internal signal inside.
3. The NC pin is not connected to any internal signal. It is OK to connect it to the system ground (GND) or leave it floating.
4. The RESET# pin is a dedicated hardware reset pin regardless of device settings or operation states. If the hardware



reset function is not used, this pin must be connected to VCC in the system.

**Figure 2 Connection Diagram for WSON8 package**



**Table 2 Pin Description for WSON8 package**

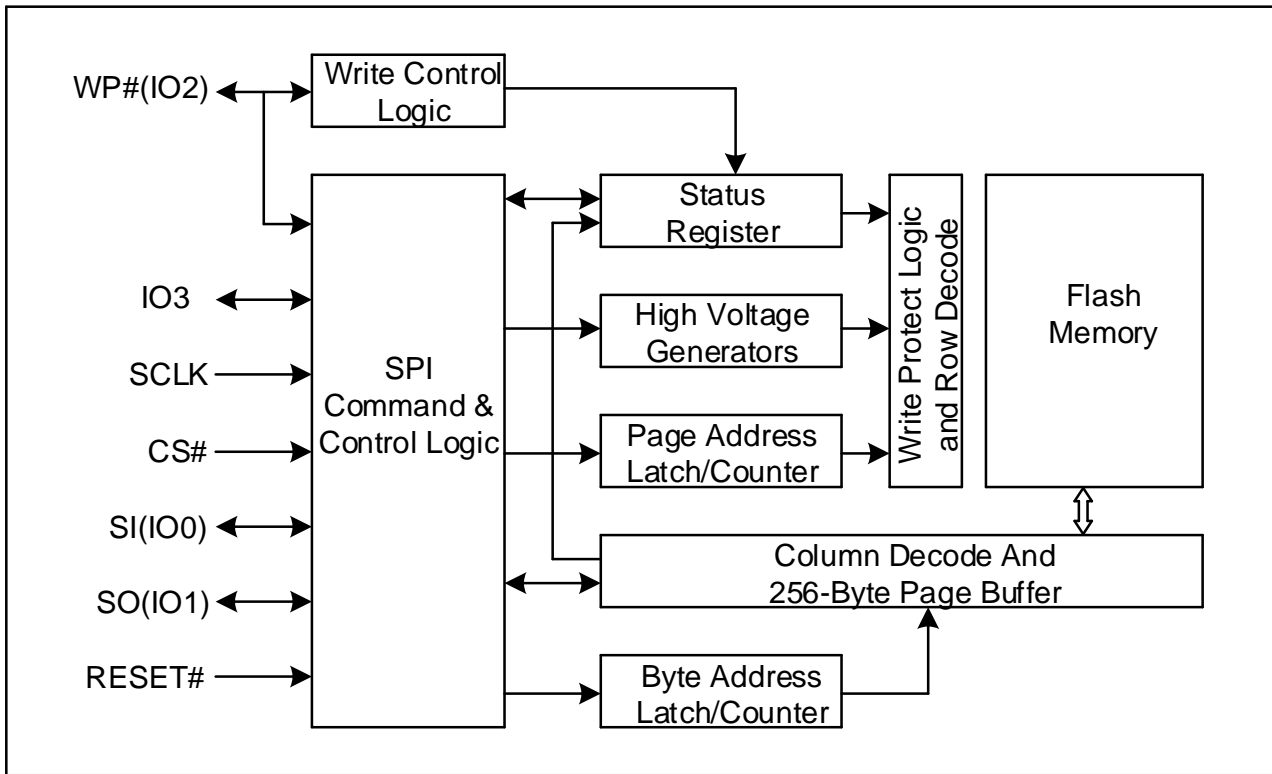
| Pin No. | Pin Name  | I/O | Description                               |
|---------|-----------|-----|---|
| 1       | CS#       | I   | Chip Select Input                         |
| 2       | SO (IO1)  | I/O | Data Output (Data Input Output 1)         |
| 3       | WP# (IO2) | I/O | Write Protect Input (Data Input Output 2) |
| 4       | VSS       |     | Ground                                    |
| 5       | SI (IO0)  | I/O | Data Input (Data Input Output 0)          |
| 6       | SCLK      | I   | Serial Clock Input                        |
| 7       | IO3       | I/O | Data Input Output 3                       |
| 8       | VCC       |     | Power Supply                              |

Note:

- CS# must be driven high if chip is not selected. Please don't leave CS# floating any time after power is on.



BLOCK DIAGRAM





### 3 MEMORY ORGANIZATION

#### GD25R512ME

| Each device has | Each block has | Each sector has | Each page has |         |
|-----------------|----------------|-----------------|---------------|---------|
| 64M             | 64/32K         | 4K              | 256           | Bytes   |
| 256K            | 256/128        | 16              | -             | pages   |
| 16K             | 16/8           | -               | -             | sectors |
| 1K/2K           | -              | -               | -             | blocks  |

#### UNIFORM BLOCK SECTOR ARCHITECTURE

##### GD25R512ME 64K Bytes Block Sector Architecture

| Block | Sector | Address range |           |
|-------|--------|---------------|-----------|
|       |        |               |           |
| 1023  | 16383  | 3FFF000H      | 3FFFFFFFH |
|       | .....  | .....         | .....     |
|       | 16368  | 3FF0000H      | 3FF0FFFH  |
| 1022  | 16367  | 3FEF000H      | 3FEFFFFH  |
|       | .....  | .....         | .....     |
|       | 16352  | 3FE0000H      | 3FE0FFFH  |
| ..... | .....  | .....         | .....     |
|       | .....  | .....         | .....     |
|       | .....  | .....         | .....     |
| ..... | .....  | .....         | .....     |
|       | .....  | .....         | .....     |
|       | .....  | .....         | .....     |
| 2     | 47     | 02F000H       | 02FFFFH   |
|       | .....  | .....         | .....     |
|       | 32     | 020000H       | 020FFFH   |
| 1     | 31     | 01F000H       | 01FFFFH   |
|       | .....  | .....         | .....     |
|       | 16     | 010000H       | 010FFFH   |
| 0     | 15     | 00F000H       | 00FFFFH   |
|       | .....  | .....         | .....     |
|       | 0      | 000000H       | 000FFFH   |





## 4 DEVICE OPERATIONS

### 4.1 SPI Mode

#### Standard SPI

The GD25R512ME features a serial peripheral interface on 4 signals bus: Serial Clock (SCLK), Chip Select (CS#), Serial Data Input (SI) and Serial Data Output (SO). Both SPI bus mode 0 and 3 are supported. Input data is latched on the rising edge of SCLK and data shifts out on the falling edge of SCLK.

#### Quad SPI

The GD25R512ME supports Quad SPI operation when using the “Quad Output Fast Read”, “Quad I/O Fast Read”, “Quad Page Program” (6BH/6CH, EBH/ECH, 32H/34H, C2H/3EH) commands. These commands allow data to be transferred to or from the device at four times the rate of the standard SPI. When using the Quad SPI command the SI and SO pins become bidirectional I/O pins: IO0 and IO1.

#### DTR Quad SPI

The GD25R512ME supports DTR Quad SPI operation when using the “DTR Quad I/O Fast Read” (EDH/EEH) command. These commands allow data to be transferred to or from the device at eight times the rate of the standard SPI, and data output will be latched on both rising and falling edges of the serial clock. When using the DTR Quad SPI command the SI and SO pins become bidirectional I/O pins: IO0 and IO1.

### 4.2 QPI Mode

The GD25R512ME supports Quad Peripheral Interface (QPI) operations only when the device is switched from Standard/Quad SPI mode to QPI mode using the “Enable the QPI (38H)” command. The QPI mode utilizes all four IO pins to input the command code. Standard/Quad SPI mode and QPI mode are exclusive. Only one mode can be active at any given times. “Enable the QPI (38H)” and “Disable the QPI (FFH)” commands are used to switch between these two modes. Upon power-up and after software reset using “Enable Reset (66H) and Reset (99H)” command, the default state of the device is Standard/Quad SPI mode.

### 4.3 RESET Function

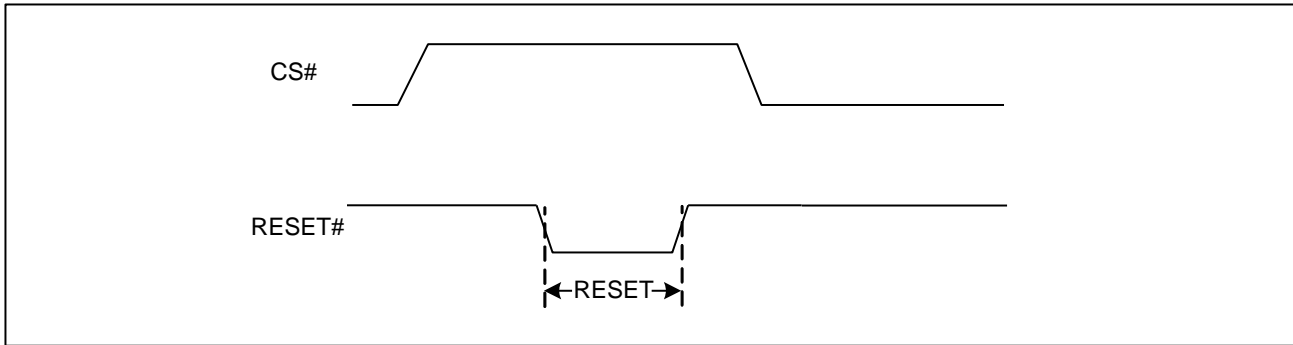
The RESET# pin allows the device to be reset by the control.

The RESET# pin goes low for a minimum period of tRLRH will reset the flash. After reset cycle, the flash is at the following states:

- Standby mode
- All the volatile bits will return to the default status as power on.



Figure 3 RESET Condition





## 5 DATA PROTECTION

The GD25R512ME provide the following data protection methods:

- ◆ Write Enable (WREN) command: The WREN command is set the Write Enable Latch bit (WEL). The WEL bit will return to reset by the following situation:
  - Power-Up/ Software reset (66H+99H)
  - Write Disable (WRDI)
  - Write Status Register (WRSR)
  - Write Extended Address Register (WEAR)
  - Write Nonvolatile Configuration Register (WNVCR)
  - Write Volatile Configuration Register (WVCR)
  - Page Program (PP)
  - Sector Erase (SE) / Block Erase (BE) / Chip Erase (CE)
  - Erase Security Registers / Program Security Registers
- ◆ Software Protection Mode:
  - The Block Protect (BP4, BP3, BP2, BP1, and BP0) bits define the section of the memory array that can be read but cannot be changed.
  - Individual Block Protection bit provides the protection selection of each individual block.
- ◆ Hardware Protection Mode: WP# goes low to protect the BP0~BP4 bits and SRP0 bit.
- ◆ Deep Power-Down Mode: In Deep Power-Down Mode, all commands are ignored except the Release from Deep Power-Down Mode command and reset command (66H+99H).

**Table 3. GD25R512ME Protected area size**

| Status Register Content |     |     |     |     | Memory Content |                      |         |              |
|-------------------------|-----|-----|-----|-----|----------------|----------------------|---------|--------------|
| BP4                     | BP3 | BP2 | BP1 | BP0 | Blocks         | Addresses            | Density | Portion      |
| X                       | 0   | 0   | 0   | 0   | NONE           | NONE                 | NONE    | NONE         |
| 0                       | 0   | 0   | 0   | 1   | 1023           | 03FF0000h-03FFFFFFh  | 64KB    | Upper 1/1024 |
| 0                       | 0   | 0   | 1   | 0   | 1022 to 1023   | 03FE0000h-03FFFFFFh  | 128KB   | Upper 1/512  |
| 0                       | 0   | 0   | 1   | 1   | 1020 to 1023   | 03FC0000h-03FFFFFFh  | 256KB   | Upper 1/256  |
| 0                       | 0   | 1   | 0   | 0   | 1016 to 1023   | 03F80000h-03FFFFFFh  | 512KB   | Upper 1/128  |
| 0                       | 0   | 1   | 0   | 1   | 1008 to 1023   | 03F00000h-03FFFFFFh  | 1MB     | Upper 1/64   |
| 0                       | 0   | 1   | 1   | 0   | 992 to 1023    | 03E00000h-03FFFFFFh  | 2MB     | Upper 1/32   |
| 0                       | 0   | 1   | 1   | 1   | 960 to 1023    | 03C00000h-03FFFFFFh  | 4MB     | Upper 1/16   |
| 0                       | 1   | 0   | 0   | 0   | 896 to 1023    | 03800000h-03FFFFFFh  | 8MB     | Upper 1/8    |
| 0                       | 1   | 0   | 0   | 1   | 768 to 1023    | 03000000h-03FFFFFFh  | 16MB    | Upper 1/4    |
| 0                       | 1   | 0   | 1   | 0   | 512 to 1023    | 02000000h-03FFFFFFh  | 32MB    | Upper 1/2    |
| 1                       | 0   | 0   | 0   | 1   | 0              | 00000000h-0000FFFFh  | 64KB    | Lower 1/1024 |
| 1                       | 0   | 0   | 1   | 0   | 0 to 1         | 00000000h-0001FFFFh  | 128KB   | Lower 1/512  |
| 1                       | 0   | 0   | 1   | 1   | 0 to 3         | 00000000h-0003FFFFh  | 256KB   | Lower 1/256  |
| 1                       | 0   | 1   | 0   | 0   | 0 to 7         | 00000000h-0007FFFFh  | 512KB   | Lower 1/128  |
| 1                       | 0   | 1   | 0   | 1   | 0 to 15        | 00000000h-000FFFFFFh | 1MB     | Lower 1/64   |
| 1                       | 0   | 1   | 1   | 0   | 0 to 31        | 00000000h-001FFFFFFh | 2MB     | Lower 1/32   |



|   |   |   |   |   |          |                      |      |            |
|---|---|---|---|---|----------|----------------------|------|------------|
| 1 | 0 | 1 | 1 | 1 | 0 to 63  | 00000000h-003FFFFFFh | 4MB  | Lower 1/16 |
| 1 | 1 | 0 | 0 | 0 | 0 to 127 | 00000000h-007FFFFFFh | 8MB  | Lower 1/8  |
| 1 | 1 | 0 | 0 | 1 | 0 to 255 | 00000000h-00FFFFFFh  | 16MB | Lower 1/4  |
| 1 | 1 | 0 | 1 | 0 | 0 to 511 | 00000000h-01FFFFFFh  | 32MB | Lower 1/2  |
| X | 1 | 1 | X | X | ALL      | 00000000h-03FFFFFFh  | 64MB | ALL        |
| X | 1 | 0 | 1 | 1 | ALL      | 00000000h-03FFFFFFh  | 64MB | ALL        |

**Table 4. GD25R512ME Individual Block Protection (WPS=0)**

| Block | Sector      | Address range |            | Individual Block Lock Operation   |
|-------|-------------|---------------|------------|---|
| 1023  | 16383       | 03FF F000h    | 03FF FFFFh | <b>1024 Blocks</b><br><b>Block Lock: 36H+Address</b><br><b>Block Unlock: 39H+Address</b><br><b>Read Block Lock: 3DH+Address</b><br><b>Global Block Lock: 7EH</b><br><b>Global Block Unlock: 98H</b> |
|       | .....       | .....         | .....      |   |
|       | 16368       | 03FF 0000h    | 03FF 0FFFh |   |
| 1022  | 16352~16367 | 03FE 0000h    | 03FE FFFFh |   |
| ..... | .....       | .....         | .....      |   |
| ..... | .....       | .....         | .....      |   |
| ..... | .....       | .....         | .....      |   |
| 1     | 16~31       | 0001 0000h    | 0001 FFFFh |   |
| 0     | 15          | 0000 F000h    | 0000 FFFFh |   |
|       | .....       | .....         | .....      |   |
|       | 0           | 0000 0000h    | 0000 0FFFh |   |

**Notes:**

1. Protection configuration: This bit is used to select which Write Protect scheme should be used.
2. Individual Block Protection bits are volatile lock bits. Each volatile bit corresponds to and provides volatile protection for an individual memory sector, which is locked temporarily (protection is cleared when the device is reset or powered down).
3. The first and last sectors will have volatile protections at the 4KB sector level. Each 4KB sector in these sectors can be individually locked by volatile lock bits setting.



## 6 REGISTERS

### 6.1 Status Register

**Table 5. Status Register-SR No.1**

| No. | Bit Name | Description                    | Note                  |
|-----|----------|--------------------------------|-----------------------|
| S7  | SRP0     | Status Register Protection Bit | Non-volatile writable |
| S6  | BP4      | Block Protect Bit              | Non-volatile writable |
| S5  | BP3      | Block Protect Bit              | Non-volatile writable |
| S4  | BP2      | Block Protect Bit              | Non-volatile writable |
| S3  | BP1      | Block Protect Bit              | Non-volatile writable |
| S2  | BP0      | Block Protect Bit              | Non-volatile writable |
| S1  | WEL      | Write Enable Latch             | Volatile, read only   |
| S0  | WIP      | Erase/Write In Progress        | Volatile, read only   |

**Table 6. Status Register-SR No.2**

| No. | Bit Name | Description                    | Note                        |
|-----|----------|--------------------------------|-----------------------------|
| S15 | SUS1     | Erase Suspend Bit              | Volatile, read only         |
| S14 | SRP1     | Status Register Protection Bit | Non-volatile writable       |
| S13 | EE       | Erase Error Bit                | Volatile, read only         |
| S12 | PE       | Program Error                  | Volatile, read only         |
| S11 | LB       | Security Register Lock Bit     | Non-volatile writable (OTP) |
| S10 | SUS2     | Program Suspend Bit            | Volatile, read only         |
| S9  | Reserved | Reserved                       | Reserved                    |
| S8  | ADS      | Current Address Mode           | Volatile, read only         |

The status and control bits of the Status Register are as follows:

#### **WIP bit**

The Write in Progress (WIP) bit indicates whether the memory is busy in program/erase/write status register or configuration register progress. When WIP bit sets to 1, means the device is busy in program/erase/write status register or configuration register progress, when WIP bit sets 0, means the device is not in program/erase/write status register or configuration register progress.

#### **WEL bit**

The Write Enable Latch (WEL) bit indicates the status of the internal Write Enable Latch. When set to 1 the internal Write Enable Latch is set, when set to 0 the internal Write Enable Latch is reset and no Write, Program or Erase command is accepted.

#### **BP4, BP3, BP2, BP1, BP0 bits**

The Block Protect (BP4, BP3, BP2, BP1, and BP0) bits are non-volatile. They define the size of the area to be software protected against Program and Erase commands. These bits are written with the Write Status Register (WRSR) command.



When the Block Protect (BP4, BP3, BP2, BP1, and BP0) bits are set to 1, the relevant memory area becomes protected against Page Program (PP), Sector Erase (SE) and Block Erase (BE) commands. The Block Protect (BP4, BP3, BP2, BP1, and BP0) bits can be written provided that the Hardware Protected mode has not been set. The Chip Erase (CE) command is executed only if none sector or block is protected.

**SRP0, SRP1 bits**

The Status Register Protect (SRP1 and SRP0) bits are non-volatile Read/Write bits in the status register. The SRP bits control the method of write protection: software protection, hardware protection, power supply lock-down or one time programmable protection.

| SRP1 | SRP0 | #WP | Status Register                          | Description  |
|------|------|-----|--|--|
| 0    | 0    | X   | Software Protected                       | The Status Register can be written to after a Write Enable command, WEL=1.(Default)                    |
| 0    | 1    | 0   | Hardware Protected                       | WP#=0, the Status Register locked and cannot be written to.  |
| 0    | 1    | 1   | Hardware Unprotected                     | WP#=1, the Status Register is unlocked and can be written to after a Write Enable command, WEL=1.      |
| 1    | 0    | X   | Power Supply Lock-Down <sup>(1)(2)</sup> | Status Register is protected and cannot be written to again until the next Power-Down, Power-Up cycle. |
| 1    | 1    | X   | One Time Program <sup>(2)</sup>          | Status Register is permanently protected and cannot be written to.                                     |

NOTE:

1. When SRP1, SRP0= (1, 0), a Power-Down, Power-Up cycle will change SRP1, SRP0 to (0, 0) state.
2. This feature is available on special order. Please contact GigaDevice for details.

**ADS bit**

The Address Status (ADS) bit is a read only bit that indicates the current address mode the device is operating in. The device is in 3-Byte address mode when ADS=0 (default), and in 4-Byte address mode when ADS=1.

**SUS1, SUS2 bits**

The SUS1 and SUS2 bits are read only bits in the status register (S15 and S10) that are set to 1 after executing an Program/Erase Suspend (75H) command (The Erase Suspend will set the SUS1 bit to 1, and the Program Suspend will set the SUS2 bit to 1). The SUS1 and SUS2 bits are cleared to 0 by Erase/Program Resume (7AH) command, software reset (66H+99H) command as well as a power-down, power-up cycle.

**LB bit**

The LB bit is non-volatile One Time Program (OTP) bit in Status Register (S11) that provide the write protect control and status to the Security Registers. The default state of LB bit is 0, the security registers are unlocked. The LB bit can be set to 1 using the Write Register instruction. The LB bit is One Time Programmable, once they are set to 1, the Security Registers will become read-only permanently.

**PE bit**

The Program Error (PE) bit is a read only bit that indicates a program failure. It will also be set when the user attempts to



program a protected array sector or access the locked OTP space. PE is cleared to "0" after program operation resumes

**EE bit**

The Erase Error (EE) bit is a read only bit that indicates an erase failure. It will also be set when the user attempts to erase a protected array sector or access the locked OTP space. EE is cleared to "0" after erase operation resumes

**6.2 Extended Address Register**

**Table 7 Extended Address Register**

| No. | Name     | Description | Note              |
|-----|----------|-------------|-------------------|
| EA7 | Reserved | Reserved    | Reserved          |
| EA6 | Reserved | Reserved    | Reserved          |
| EA5 | Reserved | Reserved    | Reserved          |
| EA4 | Reserved | Reserved    | Reserved          |
| EA3 | Reserved | Reserved    | Reserved          |
| EA2 | Reserved | Reserved    | Reserved          |
| EA1 | A25      | Address bit | Volatile writable |
| EA0 | A24      | Address bit | Volatile writable |

The extended address register is only used when the address mode is 3-Byte mode, as to set the higher address. The default value of the address bit is "0".

For the read operation, the whole array can be continually read out with one command. Data output starts from the selected 128Mb, and it can cross the boundary. When the last Byte of the segment is reached, the next Byte (in a continuous reading) is the first Byte of the next segment. However, the EAR (Extended Address Register) value does not change. The random access reading can only be operated in the selected segment.

The Chip erase command will erase the whole chip and is not limited by EAR selected segment. However, the sector erase, block erase, program operation are limited in selected segment and will not cross the boundary.

**A24, A25 bits**

The Extended Address Bits are used only when the device is operating in the 3-Byte Address Mode (ADS=0), which is volatile writable by C5H command.

If Configuration Register Byte <5> set to FEH, or an "Enter 4-Byte Address Mode (B7H)" instruction is issued, the device will require 4-Byte address input for all address related instructions, and the Extended Address Bit setting will be ignored.

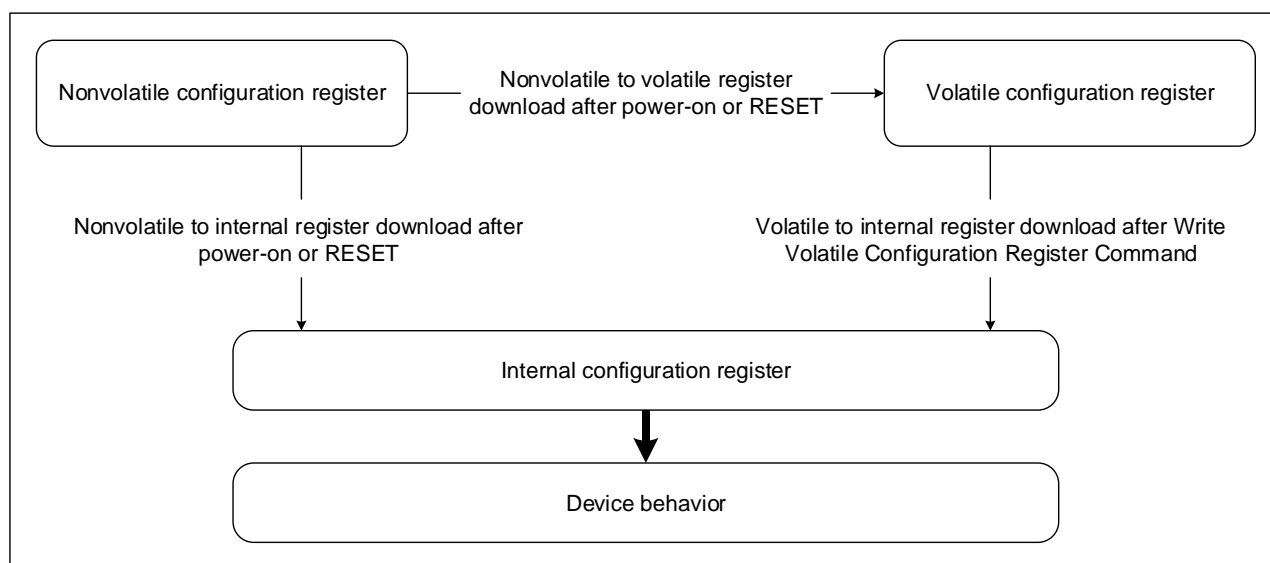
| A25, A24 | Address Range         |
|----------|-----------------------|
| 00       | 0000 0000h-00FF FFFFh |
| 01       | 0100 0000h-01FF FFFFh |
| 10       | 0200 0000h-02FF FFFFh |
| 11       | 0300 0000h-03FF FFFFh |



## 7 INTERNAL CONFIGURATION REGISTER

The memory configuration is set by an internal configuration register that is not directly accessible to users. The user can change the default configuration at power up by using the WRITE NONVOLATILE CONFIGURATION REGISTER. Information from the nonvolatile configuration register overwrites the internal configuration register during power on or after a reset.

The user can change the configuration during device operation using the WRITE VOLATILE CONFIGURATION REGISTER command. Information from the volatile configuration registers overwrite the internal configuration register immediately after the WRITE command completes.



### 7.1 Nonvolatile Configuration Register

Nonvolatile Configuration Register bits set the device configuration after power-up or reset. All bits are erased (FFh) unless stated otherwise. This register is read from and written to using the READ NONVOLATILE CONFIGURATION REGISTER and the WRITE NONVOLATILE CONFIGURATION REGISTER commands, respectively. The commands use the main array address scheme, but only the LSB is used to access different register settings, thereby providing up to 256 Bytes of registers (See the table below for the details). A WRITE command to a reserved address will set the device to the default status of the corresponding Byte.

**Table 8 Nonvolatile Configuration Register**

| Addr | Settings                                   | bit7   | bit6 | bit5 | bit4 | bit3 | bit2 | bit1 | bit0 | Description                     |
|------|--|--------|------|------|------|------|------|------|------|---------------------------------|
| <1>  | Dummy cycle configuration <sup>(6-7)</sup> | 0      | 0    | 0    | 0    | 0    | 0    | 1    | 1    | 3 Dummy                         |
|      |  | 0      | 0    | 0    | 0    | 0    | 1    | 0    | 0    | 4 Dummy                         |
|      |  | ...    | ...  | ...  | ...  | ...  | ...  | ...  | ...  | 05~1E: 5~30 Dummy (Default=06h) |
|      |  | Others |      |      |      |      |      |      |      |                                 |
| <3>  | On die termination                         | x      | x    | 1    | 1    | x    | x    | x    | x    | ODT Disabled (Default)          |
|      |  | x      | x    | 1    | 0    | x    | x    | x    | x    | 300-Ohm ODT                     |
|      |  | x      | x    | 0    | 1    | x    | x    | x    | x    | 150-Ohm ODT                     |





|     |                                   |        |        |   |   |   |   |   |   |                                  |
|-----|-----------------------------------|--------|--------|---|---|---|---|---|---|----------------------------------|
|     |                                   | x      | x      | 0 | 0 | x | x | x | x | 100-Ohm ODT                      |
|     | Driver strength configuration     | x      | x      | x | x | x | x | 1 | 1 | 50 Ohm                           |
|     |                                   | x      | x      | x | x | x | x | 1 | 0 | 35 Ohm                           |
|     |                                   | x      | x      | x | x | x | x | 0 | 1 | 25 Ohm (Default)                 |
|     |                                   | x      | x      | x | x | x | x | 0 | 0 | 18 Ohm                           |
|     |                                   | Others |        |   |   |   |   |   |   | Reserved                         |
| <4> | DLP enable                        | x      | x      | x | x | 1 | x | x | x | DLP Disabled (Default)           |
|     |                                   | x      | x      | x | x | 0 | x | x | x | DLP Enabled                      |
|     | Protection configuration          | x      | x      | x | x | x | 1 | x | x | BP Protection (Default)          |
|     |                                   | x      | x      | x | x | x | 0 | x | x | WPS Protection <sup>(8)</sup>    |
| <5> | Beyond 128Mb addr configuration   | 1      | 1      | 1 | 1 | 1 | 1 | 1 | 1 | 3-Byte Address (Default)         |
|     |                                   | 1      | 1      | 1 | 1 | 1 | 1 | 1 | 0 | 4-Byte Address                   |
|     |                                   | Others |        |   |   |   |   |   |   | Reserved                         |
| <6> | Not Use                           | x      | x      | x | x | x | x | x | 1 | Bit0 must <b>not</b> be set as 0 |
| <7> | Wrap configuration <sup>(9)</sup> | 1      | 1      | 1 | 1 | 1 | 1 | 1 | 1 | Wrap Disabled (Default)          |
|     |                                   | 1      | 1      | 1 | 1 | 1 | 1 | 1 | 0 | 64-Byte Wrap                     |
|     |                                   | 1      | 1      | 1 | 1 | 1 | 1 | 0 | 1 | 32-Byte Wrap                     |
|     |                                   | 1      | 1      | 1 | 1 | 1 | 1 | 0 | 0 | 16-Byte Wrap                     |
|     |                                   |        | Others |   |   |   |   |   |   |                                  |

Notes:

1. The number of cycles must be set to accord with the clock frequency, which varies by the type of FAST READ command (See Supported Clock Frequencies table). Insufficient dummy clock cycles for the operating frequency causes the memory to read incorrect data.
2. 03H/13H: SPI 0 dummy; QPI N/A
3. 05H/35H/9EH/9FH: SPI&QPI 0 dummy.
4. 3DH: SPI 0 dummy; QPI 8 dummy.
5. 4BH/5AH/B5H/85H: SPI&QPI 8 dummy.
6. 0BH/0CH/6BH/6CH/48H: SPI 8 dummy; QPI dummy follow CONFIGURATION REGISTER<1> (initiation = 6 dummy)
7. EBH/ECH/EDH/EEH: SPI&QPI dummy follow CONFIGURATION REGISTER<1> (initiation = 6 dummy)
8. When WPS protection is enabled, the entire memory array is being protected after Power-up or Reset.
9. Only Quad I/O (EBH and ECH) and DTR Quad I/O fast read (EDH and EEH) support wrap read.

## 7.2 Volatile Configuration Register

Volatile Configuration Register bits temporarily set the device configuration after power-up or reset. All bits are erased (FFh) unless stated otherwise. This register is read from and written to using the READ VOLATILE CONFIGURATION REGISTER and the WRITE VOLATILE CONFIGURATION REGISTER commands, respectively. The commands use the main array address scheme; however, only the LSB is used to access different register settings to provide up to 256 Bytes of registers (See the table below for the details). A WRITE command to a reserved address will set the device to the default status of the corresponding Byte.



**Table 9 Volatile Configuration Register**

| Addr   | Settings                                   | bit7   | bit6 | bit5 | bit4 | bit3 | bit2 | bit1     | bit0 | Description                        |
|--------|--|--------|------|------|------|------|------|----------|------|------------------------------------|
| <1>    | Dummy cycle configuration <sup>(6-7)</sup> | 0      | 0    | 0    | 0    | 0    | 0    | 1        | 1    | 3 Dummy                            |
|        |  | 0      | 0    | 0    | 0    | 0    | 1    | 0        | 0    | 4 Dummy                            |
|        |  | ...    | ...  | ...  | ...  | ...  | ...  | ...      | ...  | 05~1E: 5~30 Dummy<br>(Default=06h) |
|        |  | Others |      |      |      |      |      |          |      | Reserved                           |
| <3>    | On die termination                         | x      | x    | 1    | 1    | x    | x    | x        | x    | ODT Disabled (Default)             |
|        |  | x      | x    | 1    | 0    | x    | x    | x        | x    | 300-Ohm ODT                        |
|        |  | x      | x    | 0    | 1    | x    | x    | x        | x    | 150-Ohm ODT                        |
|        |  | x      | x    | 0    | 0    | x    | x    | x        | x    | 100-Ohm ODT                        |
|        | Driver strength configuration              | x      | x    | x    | x    | x    | x    | 1        | 1    | 50 Ohm                             |
|        |  | x      | x    | x    | x    | x    | x    | 1        | 0    | 35 Ohm                             |
|        |  | x      | x    | x    | x    | x    | x    | 0        | 1    | 25 Ohm (Default)                   |
|        |  | x      | x    | x    | x    | x    | x    | 0        | 0    | 18 Ohm                             |
| Others |  |        |      |      |      |      |      | Reserved |      |                                    |
| <4>    | DLP enable                                 | x      | x    | x    | x    | 1    | x    | x        | x    | DLP Disabled (Default)             |
|        |  | x      | x    | x    | x    | 0    | x    | x        | x    | DLP Enabled                        |
|        | Protection configuration                   | x      | x    | x    | x    | x    | 1    | x        | x    | BP Protection (Default)            |
|        |  | x      | x    | x    | x    | x    | 0    | x        | x    | WPS Protection <sup>(8)</sup>      |
| <5>    | Beyond 128Mb addr configuration            | 1      | 1    | 1    | 1    | 1    | 1    | 1        | 1    | 3-Byte Address (Default)           |
|        |  | 1      | 1    | 1    | 1    | 1    | 1    | 1        | 0    | 4-Byte Address                     |
|        |  | Others |      |      |      |      |      |          |      | Reserved                           |
| <6>    | Not Use                                    | x      | x    | x    | x    | x    | x    | x        | 1    | Bit0 must <b>not</b> be set as 0   |
| <7>    | Wrap configuration <sup>(9)</sup>          | 1      | 1    | 1    | 1    | 1    | 1    | 1        | 1    | Wrap Disabled (Default)            |
|        |  | 1      | 1    | 1    | 1    | 1    | 1    | 1        | 0    | 64-Byte Wrap                       |
|        |  | 1      | 1    | 1    | 1    | 1    | 1    | 0        | 1    | 32-Byte Wrap                       |
|        |  | 1      | 1    | 1    | 1    | 1    | 1    | 0        | 0    | 16-Byte Wrap                       |
|        |  | Others |      |      |      |      |      |          |      | Reserved                           |

Notes:

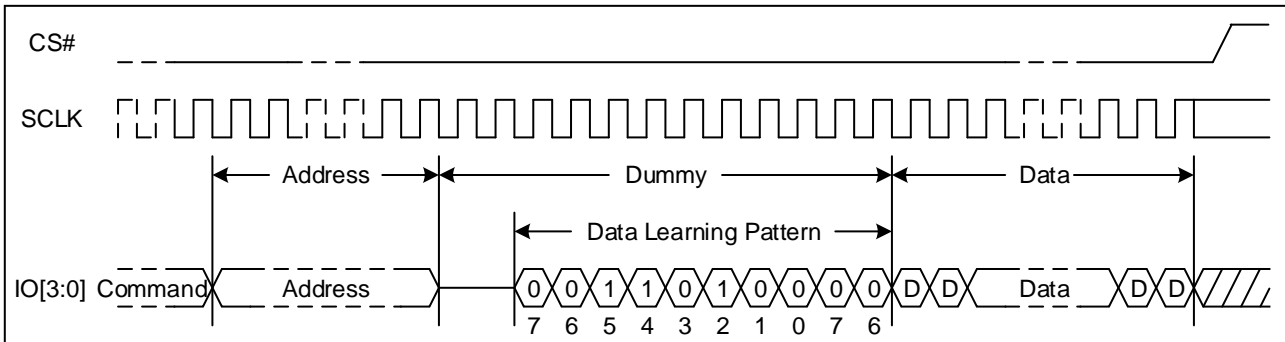
- The number of cycles must be set to accord with the clock frequency, which varies by the type of FAST READ command (See Supported Clock Frequencies table). Insufficient dummy clock cycles for the operating frequency causes the memory to read incorrect data.
- 03H/13H: SPI 0 dummy; QPI N/A
- 05H/35H/9EH/9FH: SPI&QPI 0 dummy.
- 3DH: SPI 0 dummy; QPI 8 dummy.
- 4BH/5AH/B5H/85H: SPI&QPI 8 dummy.
- 0BH/0CH/6BH/6CH/48H: SPI 8 dummy; QPI dummy follow CONFIGURATION REGISTER<1> (initiation = 6 dummy)
- EBH/ECH/EDH/EEH: SPI&QPI dummy follow CONFIGURATION REGISTER<1> (initiation = 6 dummy)
- When WPS protection is enabled, the entire memory array is being protected after Power-up or Reset.
- Only Quad I/O (EBH and ECH) and DTR Quad I/O fast read (EDH and EEH) support wrap read.



**DLP bit**

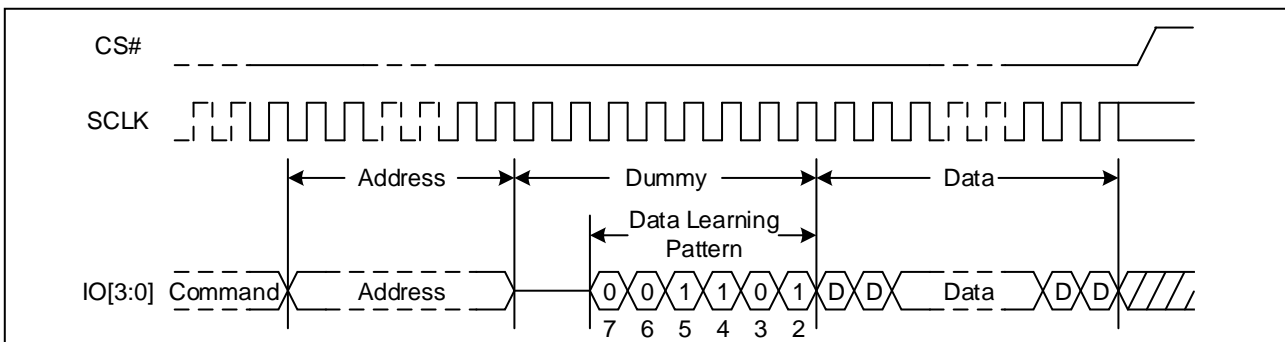
The DLP bit is Data Learning Pattern Enable bit, which is writable by B1/81H command. For Quad output, Quad I/O and Quad I/O DTR Fast Read commands, a pre-defined “Data Learning Pattern” can be used by the flash memory controller to determine the flash data output timing on 4 I/O pins. When DLP=1, from the third dummy clock, the flash will output “00110100” Data Learning Pattern sequence on each of the I/O or 4 I/O pins until data output. If the dummy clock is not enough for the output of the whole Data Learning Pattern, the last several bit of the Data Learning Pattern would be cut-off. During this period, controller can fine tune the data latching timing for each I/O pins to achieve optimum system performance. DLP=0 will disable the Data Learning Pattern output.

**Figure 4. Data Learning Pattern Sequence Diagram (STR, Dummy Clock ≥ 10)**



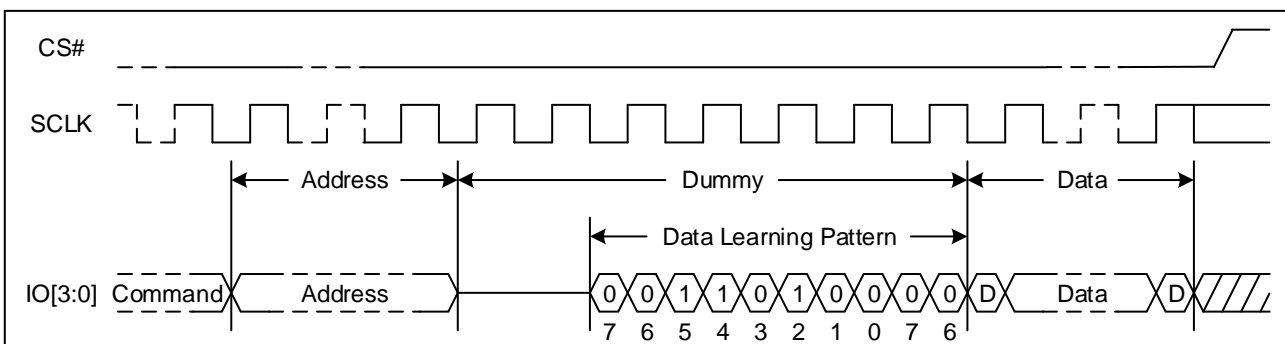
Note: 12 dummy cycle example

**Figure 5. Data Learning Pattern Sequence Diagram (STR, Dummy Clock < 10)**



Note: 8 dummy cycle example

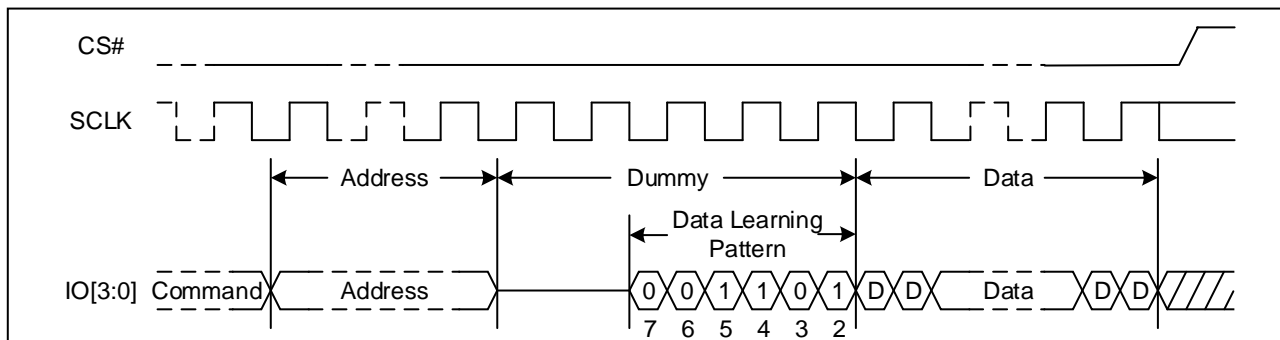
**Figure 6. Data Learning Pattern Sequence Diagram (DTR, Dummy Clock ≥ 6)**



Note: 7 dummy cycle example



**Figure 7. Data Learning Pattern Sequence Diagram (DTR, Dummy Clock < 6)**



Note: 5 dummy cycle example

### 7.3 Supported Clock Frequencies

**Table 10 Clock Frequencies**

| Number of Dummy Clock Cycle | Quad Output Fast Read (6BH/6CH) (Only QPI Mode) <sup>(1)</sup> | Quad I/O Fast Read (EBH/ECH) | DTR Quad I/O Fast Read (EDH/EEH) |
|-----------------------------|--|------------------------------|----------------------------------|
| 4                           | 40   | 40                           | 40                               |
| 6                           | 84   | 84                           | 60                               |
| 8 and above                 | 104  | 104                          | 60                               |

Note:

1. Quad Output Fast Read (6BH/6CH): SPI Mode 8 dummy.
2. Values are guaranteed by characterization and not 100% tested in production
3. Dummy clock cycle listed above is recommended. Please contact GigaDevice for clock frequency of dummy clock cycle configuration out of the table above.

### 7.4 Data Sequence Wraps by Density

**Table 11 Sequence of Bytes during Wrap**

| Starting Address | 16-Byte Wrap              | 32-Byte Wrap              | 64-Byte Wrap            |
|------------------|---------------------------|---------------------------|-------------------------|
| 0                | 0-1-2-...-15-0-1-...      | 0-1-2-...-31-0-1-...      | 0-1-2-...-63-0-1-...    |
| 1                | 1-2-...-15-0-1-2-...      | 1-2-...-31-0-1-2-...      | 1-2-...-63-0-1-2-...    |
| ...              | ....                      | ....                      | ....                    |
| 15               | 15-0-1-2-3-...-15-0-1-... | 15-16-17-...-31-0-1-...   | 15-16-17-...-63-0-1-... |
| ...              | ....                      | ....                      | ....                    |
| 31               | -                         | 31-0-1-2-3-...-31-0-1-... | 31-32-33-...-63-0-1-... |
| ...              | ....                      | ....                      | ....                    |
| 63               | -                         | -                         | 63-0-1-...-63-0-1-...   |



## 8 COMMAND DESCRIPTIONS

All commands, addresses and data are shifted in and out of the device, beginning with the most significant bit on the first rising edge of SCLK after CS# is driven low. Then, the one-Byte command code must be shifted in to the device, with most significant bit first on SI, and each bit is latched on the rising edges of SCLK.

Every command sequence starts with a one-Byte command code. Depending on the command, this might be followed by address Bytes, or by data Bytes, or by both or none. CS# must be driven high after the last bit of the command sequence has been completed. For the command of Read, Fast Read, Read Status Register or Release from Deep Power-Down, and Read Device ID, the shifted-in command sequence is followed by a data-out sequence. All read instruction can be completed after any bit of the data-out sequence is being shifted out, and then CS# must be driven high to return to deselected status.

For the command of Page Program, Sector Erase, Block Erase, Chip Erase, Write Status Register, Write Enable, Write Disable or Deep Power-Down command, CS# must be driven high exactly at a Byte boundary, otherwise the command is rejected, and is not executed. That is CS# must be driven high when the number of clock pulses after CS# being driven low is an exact multiple of eight. For Page Program, if at any time the input Byte is not a full Byte, nothing will happen and WEL will not be reset.

**Table 12 Commands (Standard/DTR Quad SPI)**

| Command name                                      | Code   | Standard SPI         |                    | Address Bytes | Data Bytes |
|---|--------|----------------------|--------------------|---------------|------------|
|   |        | Command-Address-Data | Dummy Clock Cycles |               |            |
| <b>Software Reset Operations</b>                  |        |                      |                    |               |            |
| Reset Enable                                      | 66h    | 1-0-0                | 0                  | 0             | 0          |
| Reset Memory                                      | 99h    | 1-0-0                | 0                  | 0             | 0          |
| <b>Read ID Operations</b>                         |        |                      |                    |               |            |
| Read ID   | 9E/9Fh | 1-0-(1)              | 0                  | 0             | 1 to ∞     |
| Read Serial Flash Discovery Parameter             | 5Ah    | 1-1-(1)              | 8                  | 3             | 1 to ∞     |
| Read Unique ID                                    | 4Bh    | 1-1-(1)              | 8                  | 3(4)          | 1 to ∞     |
| <b>Read Memory Operations</b>                     |        |                      |                    |               |            |
| Read  | 03h    | 1-1-(1)              | 0                  | 3(4)          | 1 to ∞     |
| Fast Read   | 0Bh    | 1-1-(1)              | 8                  | 3(4)          | 1 to ∞     |
| Quad Output Fast Read                             | 6Bh    | 1-1-(4)              | 8                  | 3(4)          | 1 to ∞     |
| Quad I/O Fast Read                                | EBh    | 1-4-(4)              | 6                  | 3(4)          | 1 to ∞     |
| DTR Quad I/O Fast Read                            | EDh    | 1-4d-(4d)            | 6                  | 3(4)          | 1 to ∞     |
| <b>Read Memory Operations with 4-Byte Address</b> |        |                      |                    |               |            |
| 4-Byte Read                                       | 13h    | 1-1-(1)              | 0                  | 4             | 1 to ∞     |
| 4-Byte Fast Read                                  | 0Ch    | 1-1-(1)              | 8                  | 4             | 1 to ∞     |
| 4-Byte Quad Output Fast Read                      | 6Ch    | 1-1-(4)              | 8                  | 4             | 1 to ∞     |
| 4-Byte Quad I/O Fast Read                         | ECh    | 1-4-(4)              | 6                  | 4             | 1 to ∞     |



|   |         |           |   |      |          |
|---|---------|-----------|---|------|----------|
| 4-Byte DTR Quad I/O<br>Fast Read              | EEh     | 1-4d-(4d) | 6 | 4    | 1 to ∞   |
| <b>Write Operations</b>                       |         |           |   |      |          |
| Write Enable                                  | 06h     | 1-0-0     | 0 | 0    | 0        |
| Write Disable                                 | 04h     | 1-0-0     | 0 | 0    | 0        |
| Volatile SR Write Enable                      | 50h     | 1-0-0     | 0 | 0    | 0        |
| <b>Read Register Operations</b>               |         |           |   |      |          |
| Read Status Register-1                        | 05h     | 1-0-(1)   | 0 | 0    | 1 to ∞   |
| Read Status Register-2                        | 35h     | 1-0-(1)   | 0 | 0    | 1 to ∞   |
| Read Nonvolatile<br>Configuration Register    | B5h     | 1-1-(1)   | 8 | 3(4) | 1        |
| Read Volatile<br>Configuration Register       | 85h     | 1-1-(1)   | 8 | 3(4) | 1        |
| Read Extended Address<br>Register             | C8h     | 1-0-(1)   | 0 | 0    | 1 to ∞   |
| <b>Write Register Operations</b>              |         |           |   |      |          |
| Write Status Register-1                       | 01h     | 1-0-1     | 0 | 0    | 1        |
| Write Status Register-2                       | 31h     | 1-0-1     | 0 | 0    | 1        |
| Write Nonvolatile<br>Configuration Register   | B1h     | 1-1-1     | 0 | 3(4) | 1        |
| Write Volatile Configuration<br>Register      | 81h     | 1-1-1     | 0 | 3(4) | 1        |
| Write Extended Address<br>Register            | C5h     | 1-0-1     | 0 | 0    | 1        |
| <b>Program Operations</b>                     |         |           |   |      |          |
| Page Program                                  | 02h     | 1-1-1     | 0 | 3(4) | 1 to 256 |
| Quad Input Fast Program                       | 32h     | 1-1-4     | 0 | 3(4) | 1 to 256 |
| Extended Quad Input Fast<br>Program           | C2h     | 1-4-4     | 0 | 3(4) | 1 to 256 |
| <b>Program Operations with 4-Byte Address</b> |         |           |   |      |          |
| 4-Byte Page Program                           | 12h     | 1-1-1     | 0 | 4    | 1 to 256 |
| 4-Byte Quad Input Fast<br>Program             | 34h     | 1-1-4     | 0 | 4    | 1 to 256 |
| 4-Byte Quad Input<br>Extended Fast Program    | 3Eh     | 1-4-4     | 0 | 4    | 1 to 256 |
| <b>Erase Operations</b>                       |         |           |   |      |          |
| 4KB Sector Erase                              | 20h     | 1-1-0     | 0 | 3(4) | 0        |
| 32KB Block Erase                              | 52h     | 1-1-0     | 0 | 3(4) | 0        |
| 64KB Block Erase                              | D8h     | 1-1-0     | 0 | 3(4) | 0        |
| Chip Erase                                    | C7h/60h | 1-0-0     | 0 | 0    | 0        |
| <b>Erase Operations with 4-Byte Address</b>   |         |           |   |      |          |
| 4-Byte 4KB Sector Erase                       | 21h     | 1-1-0     | 0 | 4    | 0        |



|   |     |         |   |      |          |
|---|-----|---------|---|------|----------|
| 4-Byte 32KB Block Erase                       | 5Ch | 1-1-0   | 0 | 4    | 0        |
| 4-Byte 64KB Block Erase                       | DCh | 1-1-0   | 0 | 4    | 0        |
| <b>Suspend/Resume Operations</b>              |     |         |   |      |          |
| Program/Erase Suspend                         | 75h | 1-0-0   | 0 | 0    | 0        |
| Program/Erase Resume                          | 7Ah | 1-0-0   | 0 | 0    | 0        |
| <b>One-Time Programmable (OTP) Operations</b> |     |         |   |      |          |
| Read OTP Array                                | 48h | 1-1-(1) | 8 | 3(4) | 1 to ∞   |
| Program OTP Array                             | 42h | 1-1-1   | 0 | 3(4) | 1 to 256 |
| Erase OTP Array                               | 44h | 1-1-0   | 0 | 3(4) | 0        |
| <b>QPI Mode Operation</b>                     |     |         |   |      |          |
| Enable QPI                                    | 38h | 1-0-0   | 0 | 0    | 0        |
| <b>4-Byte Address Mode Operations</b>         |     |         |   |      |          |
| Enter 4-Byte Address Mode                     | B7h | 1-0-0   | 0 | 0    | 0        |
| Exit 4-Byte Address Mode                      | E9h | 1-0-0   | 0 | 0    | 0        |
| <b>Deep Power-Down Operations</b>             |     |         |   |      |          |
| Enter Deep Power Down                         | B9h | 1-0-0   | 0 | 0    | 0        |
| Release From Deep Power Down                  | ABh | 1-0-0   | 0 | 0    | 0        |
| <b>Advanced Sector Protection Operations</b>  |     |         |   |      |          |
| Individual Block/Sector Lock                  | 36h | 1-1-0   | 0 | 3(4) | 0        |
| Individual Block/Sector Unlock                | 39h | 1-1-0   | 0 | 3(4) | 0        |
| Read Individual Block/Sector Lock             | 3Dh | 1-1-(1) | 0 | 3(4) | 1        |
| Global Block/Sector Lock                      | 7Eh | 1-0-0   | 0 | 0    | 0        |
| Global Block/Sector Unlock                    | 98h | 1-0-0   | 0 | 0    | 0        |

**Table 13 Commands (QPI)**

| Command name                          | Code   | Command-<br>Address-Data | Dummy Clock<br>Cycles | Address | Data   |
|---------------------------------------|--------|--------------------------|-----------------------|---------|--------|
|                                       |        |                          |                       | Bytes   | Bytes  |
| <b>Software Reset Operations</b>      |        |                          |                       |         |        |
| Reset Enable                          | 66h    | 4-0-0                    | 0                     | 0       | 0      |
| Reset Memory                          | 99h    | 4-0-0                    | 0                     | 0       | 0      |
| <b>Read ID Operations</b>             |        |                          |                       |         |        |
| Read ID                               | 9E/9Fh | 4-0-(4)                  | 0                     | 0       | 1 to ∞ |
| Read Unique ID                        | 4Bh    | 4-4-(4)                  | 8                     | 3(4)    | 1 to ∞ |
| Read Serial Flash Discovery Parameter | 5Ah    | 4-4-(4)                  | 8                     | 3       | 1 to ∞ |
| <b>Read Memory Operations</b>         |        |                          |                       |         |        |
| Fast Read                             | 0Bh    | 4-4-(4)                  | 6                     | 3(4)    | 1 to ∞ |



|   |     |           |   |      |          |
|---|-----|-----------|---|------|----------|
| Quad Output Fast Read                             | 6Bh | 4-4-(4)   | 6 | 3(4) | 1 to ∞   |
| Quad I/O Fast Read                                | EBh | 4-4-(4)   | 6 | 3(4) | 1 to ∞   |
| DTR Quad I/O Fast Read                            | EDh | 4-4d-(4d) | 6 | 3(4) | 1 to ∞   |
| <b>Read Memory Operations with 4-Byte Address</b> |     |           |   |      |          |
| 4-Byte Fast Read                                  | 0Ch | 4-4-(4)   | 6 | 4    | 1 to ∞   |
| 4-Byte Quad Output Fast Read                      | 6Ch | 4-4-(4)   | 6 | 4    | 1 to ∞   |
| 4-Byte Quad I/O Fast Read                         | ECh | 4-4-(4)   | 6 | 4    | 1 to ∞   |
| DTR Quad I/O Fast Read                            | EEh | 4-4d-(4d) | 6 | 4    | 1 to ∞   |
| <b>Write Operations</b>                           |     |           |   |      |          |
| Write Enable                                      | 06h | 4-0-0     | 0 | 0    | 0        |
| Write Disable                                     | 04h | 4-0-0     | 0 | 0    | 0        |
| Volatile SR Write Enable                          | 50h | 4-0-0     | 0 | 0    | 0        |
| <b>Read Register Operations</b>                   |     |           |   |      |          |
| Read Status Register-1                            | 05h | 4-0-(4)   | 0 | 0    | 1 to ∞   |
| Read Status Register-2                            | 35h | 4-0-(4)   | 0 | 0    | 1 to ∞   |
| Read Nonvolatile Configuration Register           | B5h | 4-4-(4)   | 8 | 3(4) | 1        |
| Read Volatile Configuration Register              | 85h | 4-4-(4)   | 8 | 3(4) | 1        |
| Read Extended Address Register                    | C8h | 4-0-(4)   | 0 | 0    | 1 to ∞   |
| <b>QPI Mode Operation</b>                         |     |           |   |      |          |
| Disable QPI                                       | FFh | 4-0-0     | 0 | 0    | 0        |
| <b>Write Register Operations</b>                  |     |           |   |      |          |
| Write Status Register-1                           | 01h | 4-0-4     | 0 | 0    | 1        |
| Write Status Register-2                           | 31h | 4-0-4     | 0 | 0    | 1        |
| Write Nonvolatile Configuration Register          | B1h | 4-4-4     | 0 | 3(4) | 1        |
| Write Volatile Configuration Register             | 81h | 4-4-4     | 0 | 3(4) | 1        |
| Write Extended Address Register                   | C5h | 4-0-4     | 0 | 0    | 1        |
| <b>Program Operations</b>                         |     |           |   |      |          |
| Page Program                                      | 02h | 4-4-4     | 0 | 3(4) | 1 to 256 |
| Quad Input Fast Program                           | 32h | 4-4-4     | 0 | 3(4) | 1 to 256 |
| Extended Quad Input Fast Program                  | C2h | 4-4-4     | 0 | 3(4) | 1 to 256 |
| <b>Program Operations with 4-Byte Address</b>     |     |           |   |      |          |
| 4-Byte Page Program                               | 12h | 4-4-4     | 0 | 4    | 1 to 256 |
| 4-Byte Quad Input Fast Program                    | 34h | 4-4-4     | 0 | 4    | 1 to 256 |
| 4-Byte Quad Input Extended Fast Program           | 3Eh | 4-4-4     | 0 | 4    | 1 to 256 |
| <b>Erase Operations</b>                           |     |           |   |      |          |
| 4KB Sector Erase                                  | 20h | 4-4-0     | 0 | 3(4) | 0        |
| 32KB Block Erase                                  | 52h | 4-4-0     | 0 | 3(4) | 0        |





|   |         |         |   |      |          |
|---|---------|---------|---|------|----------|
| 64KB Block Erase                              | D8h     | 4-4-0   | 0 | 3(4) | 0        |
| Chip Erase                                    | C7h/60h | 4-0-0   | 0 | 0    | 0        |
| <b>Erase Operations with 4-Byte Address</b>   |         |         |   |      |          |
| 4-Byte 4KB Sector Erase                       | 21h     | 4-4-0   | 0 | 4    | 0        |
| 4-Byte 32KB Block Erase                       | 5Ch     | 4-4-0   | 0 | 4    | 0        |
| 4-Byte 64KB Block Erase                       | DCh     | 4-4-0   | 0 | 4    | 0        |
| <b>Suspend/Resume Operations</b>              |         |         |   |      |          |
| Program/Erase Suspend                         | 75h     | 4-0-0   | 0 | 0    | 0        |
| Program/Erase Resume                          | 7Ah     | 4-0-0   | 0 | 0    | 0        |
| <b>One-Time Programmable (OTP) Operations</b> |         |         |   |      |          |
| Read OTP Array                                | 48h     | 4-4-(4) | 6 | 3(4) | 1 to ∞   |
| Program OTP Array                             | 42h     | 4-4-4   | 0 | 3(4) | 1 to 256 |
| Erase OTP Array                               | 44h     | 4-4-0   | 0 | 3(4) | 0        |
| <b>4-ByteAddress Mode Operations</b>          |         |         |   |      |          |
| Enter 4-Byte Address Mode                     | B7h     | 4-0-0   | 0 | 0    | 0        |
| Exit 4-Byte Address Mode                      | E9h     | 4-0-0   | 0 | 0    | 0        |
| <b>Deep Power-Down Operations</b>             |         |         |   |      |          |
| Enter Deep Power Down                         | B9h     | 4-0-0   | 0 | 0    | 0        |
| Release From Deep Power Down                  | ABh     | 4-0-0   | 0 | 0    | 0        |
| <b>Advanced Sector Protection Operations</b>  |         |         |   |      |          |
| Individual Block/Sector Lock                  | 36h     | 4-4-0   | 0 | 3(4) | 0        |
| Individual Block/Sector Unlock                | 39h     | 4-4-0   | 0 | 3(4) | 0        |
| Read Individual Block/Sector Lock             | 3Dh     | 4-4-(4) | 8 | 3(4) | 1        |
| Global Block/Sector Lock                      | 7Eh     | 4-0-0   | 0 | 0    | 0        |
| Global Block/Sector Unlock                    | 98h     | 4-0-0   | 0 | 0    | 0        |

**Table of ID Definitions**

**GD25R512ME**

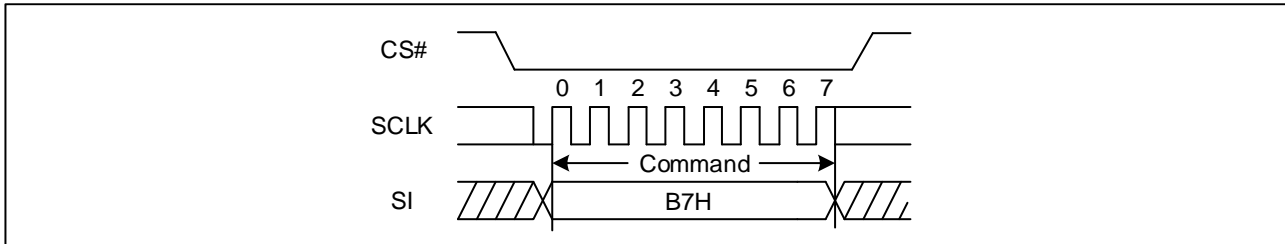
| Operation Code | M7-M0 | ID23-ID16 | ID15-ID8 | ID7-ID0 |
|----------------|-------|-----------|----------|---------|
| 9E/9FH         | C8    | 47        | 1A       | FF      |



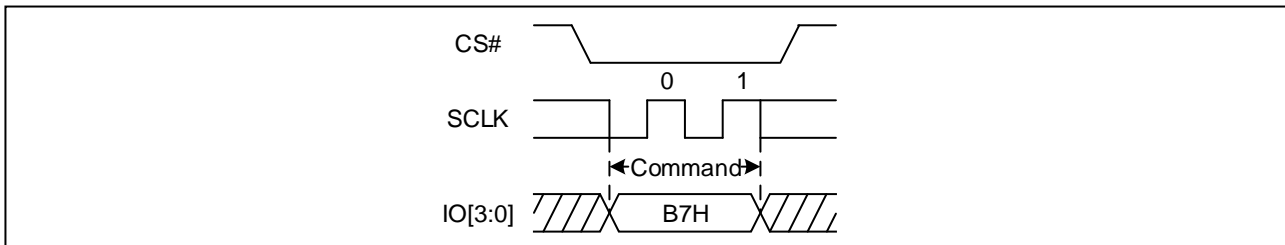
## 8.1 Enable 4-Byte Mode (B7H)

The Enable 4-Byte Mode command enables accessing the address length of 32-bit for the memory area of the higher density (larger than 128Mb). After sending the Enable 4-Byte Mode command, the ADS bit (S8) will be set to 1 to indicate the 4-Byte address mode has been enabled. Once the 4-Byte address mode is enabled, the address length becomes 32-bit.

**Figure 8 Enable 4-Byte Mode Sequence Diagram (SPI)**



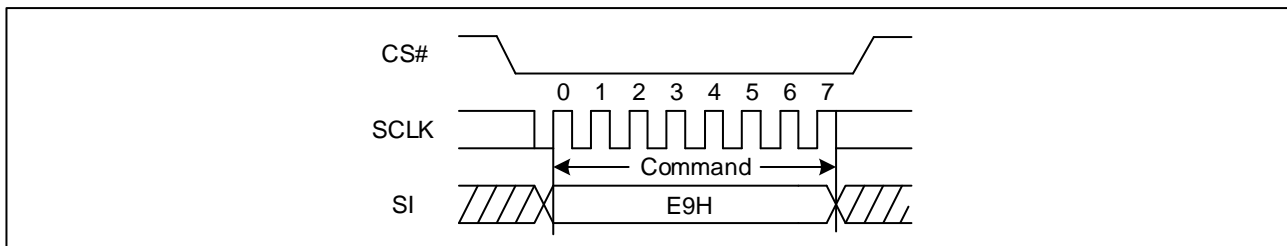
**Figure 9 Enable 4-Byte Mode Sequence Diagram (QPI)**



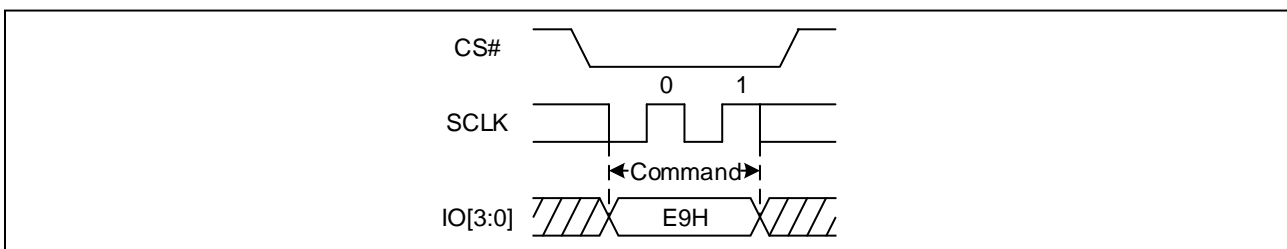
## 8.2 Disable 4-Byte Mode (E9H)

The Disable 4-Byte Mode command is executed to exit the 4-Byte address mode and enter the 3-Byte address mode. After sending the Disable 4-Byte Mode command, the ADS bit (S8) will be clear to be 0 to indicate the 4-Byte address mode has been disabled, and then the address length will return to 24-bit.

**Figure 10 Disable 4-Byte Mode Sequence Diagram (SPI)**



**Figure 11 Disable 4-Byte Mode Sequence Diagram (QPI)**

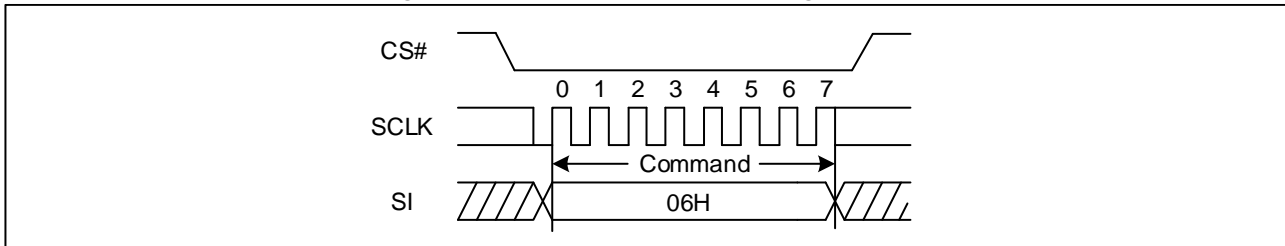




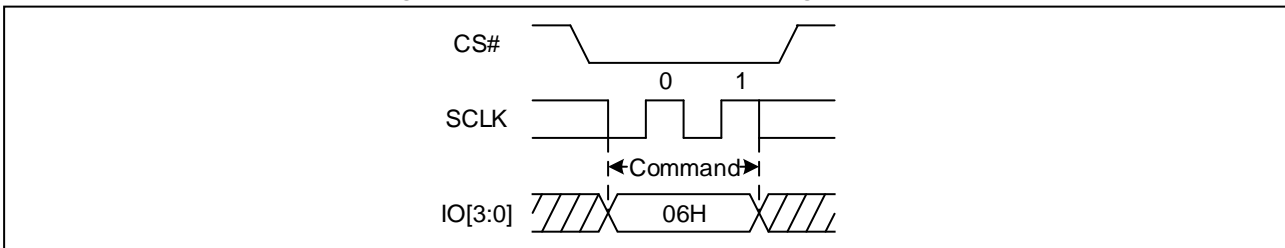
### 8.3 Write Enable (WREN) (06H)

The Write Enable (WREN) command is for setting the Write Enable Latch (WEL) bit. The Write Enable Latch (WEL) bit must be set prior to every Page Program (PP), Sector Erase (SE), Block Erase (BE), Chip Erase (CE), Write Status Register (WRSR), Write Extended Address Register (WEAR), Write Nonvolatile/Volatile configure register and Erase/Program Security Registers command. The Write Enable (WREN) command sequence: CS# goes low → sending the Write Enable command → CS# goes high.

**Figure 12 Write Enable Sequence Diagram (SPI)**



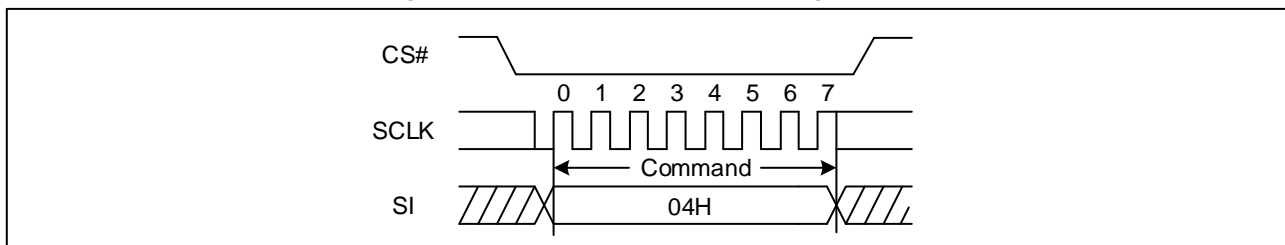
**Figure 13 Write Enable Sequence Diagram (QPI)**



### 8.4 Write Disable (WRDI) (04H)

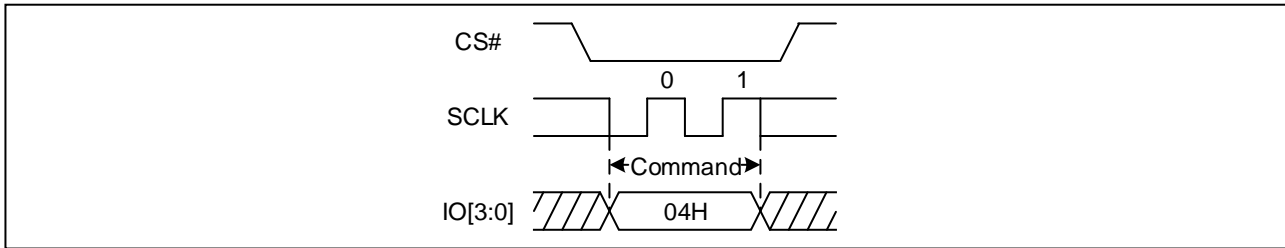
The Write Disable command is for resetting the Write Enable Latch (WEL) bit. The Write Disable command sequence: CS# goes low → Sending the Write Disable command → CS# goes high. The WEL bit is reset by following condition: Power-up and upon completion of the Write Status Register, Write Extended Address Register (WEAR), Write Nonvolatile/Volatile configure register, Page Program, Sector Erase, Block Erase, Chip Erase, Erase/Program Security Registers and Reset commands.

**Figure 14 Write Disable Sequence Diagram (SPI)**





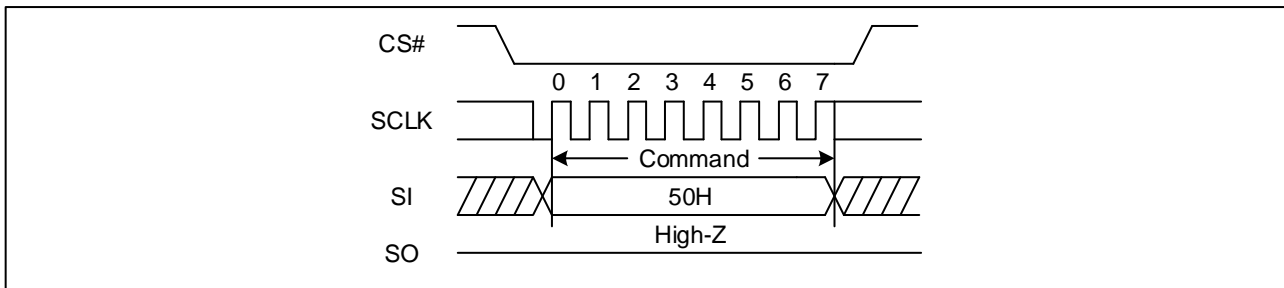
**Figure 15 Write Disable Sequence Diagram (QPI)**



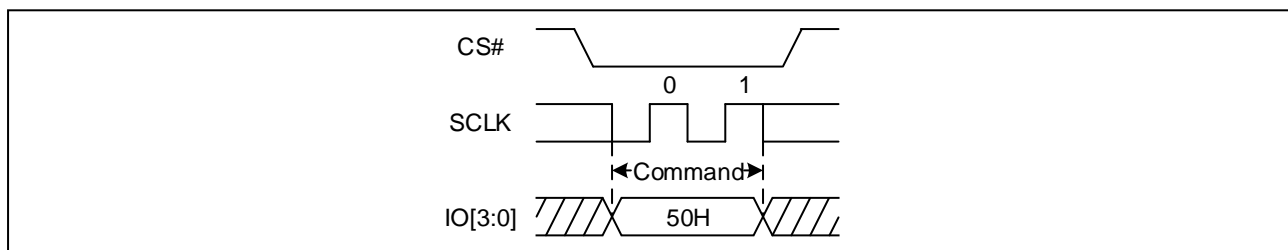
## 8.5 Write Enable for Volatile Status Register (50H)

The non-volatile Status Register bits can also be written to as volatile bits. This gives more flexibility to change the system configuration and memory protection schemes quickly without waiting for the typical non-volatile bit write cycles or affecting the endurance of the Status Register non-volatile bits. The Write Enable for Volatile Status Register command must be issued prior to a Write Status Register command, and any other commands cannot be inserted between them. Otherwise, Write Enable for Volatile Status Register will be cleared. The Write Enable for Volatile Status Register command will not set the Write Enable Latch bit, it is only valid for the Write Status Register command to change the volatile Status Register bit values.

**Figure 16 Write Enable for Volatile Status Register Sequence Diagram (SPI)**



**Figure 17 Write Enable for Volatile Status Register Sequence Diagram (QPI)**



## 8.6 Write Status Register (WRSR) (01H or 31H)

The Write Status Register (WRSR) command allows new values to be written to the Status Register. Before it can be accepted, a Write Enable (WREN) command must previously have been executed. After the Write Enable (WREN) command has been decoded and executed, the device sets the Write Enable Latch (WEL).

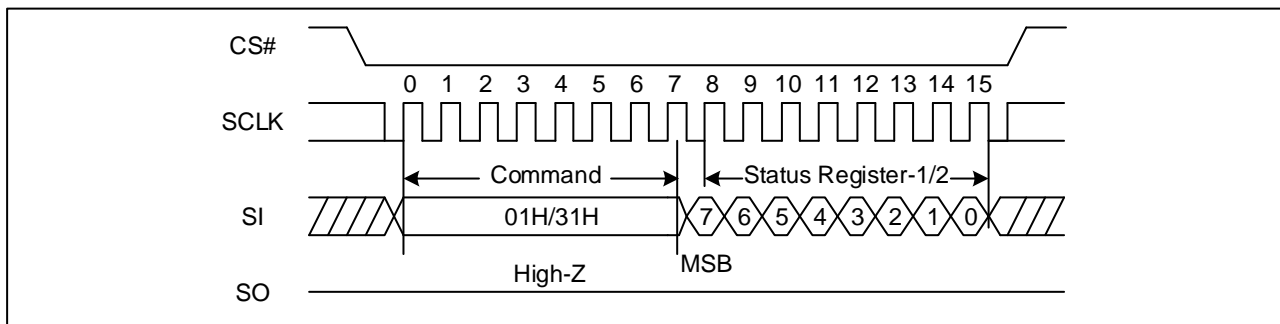
CS# must be driven high after the eighth of the data Byte has been latched in. Otherwise, the Write Status Register (WRSR) command is not executed. As soon as CS# is driven high, the self-timed Write Status Register cycle (whose duration is t<sub>W</sub>) is initiated. While the Write Status Register cycle is in progress, the Status Register may still be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Write Status Register cycle, and is 0 when it is completed. When the cycle is completed, the Write Enable Latch (WEL) is reset.

The Write Status Register (WRSR) command allows the user to change the values of the Block Protect (BP4, BP3, BP2, BP1, and BP0) bits, to define the size of the area that is to be treated as read-only. The Write Status Register (WRSR)

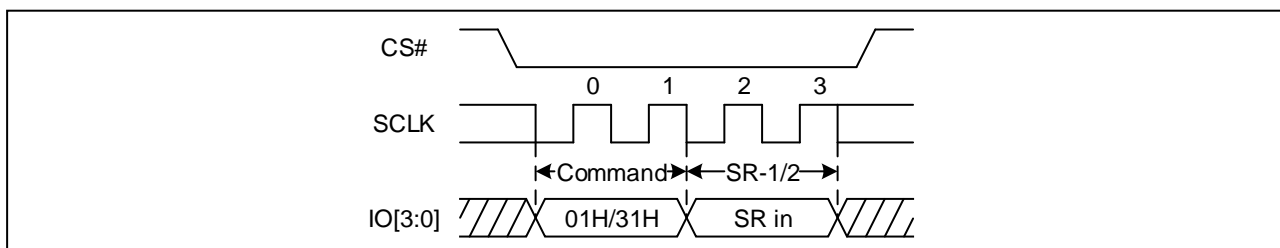


command also allows the user to set or reset the Status Register Protect (SRP0) bit in accordance with the Write Protect (WP#) signal. The Status Register Protect (SRP1 and SRP0) bits and Write Protect (WP#) signal allow the device to be put in the Hardware Protected Mode. The Write Status Register (WRSR) command is not executed once the Hardware Protected Mode is entered.

**Figure 18 Write Status Register Sequence Diagram (SPI)**



**Figure 19 Write Status Register Sequence Diagram (QPI)**



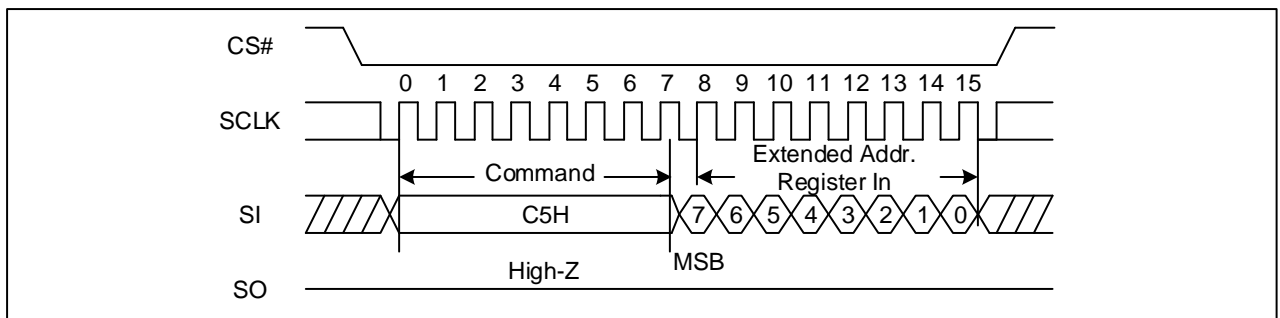
## 8.7 Write Extended Address Register (C5H)

The Extended Address Register is a volatile register that stores the 4th Byte address (A31-A24) when the device is operating in the 3-Byte Address Mode (ADS=0). To write the Extended Address Register bits, a Write Enable (06h) instruction must previously have been executed for the device to accept the Write Extended Address Register instruction (Status Register bit WEL must equal 1). Once write enabled, the instruction is entered by driving CS# low, sending the instruction code "C5H", and then writing the Extended Address Register data Byte.

Upon power up or the execution of a Software/Hardware Reset, the Extended Address Register bit values will be cleared to 0.

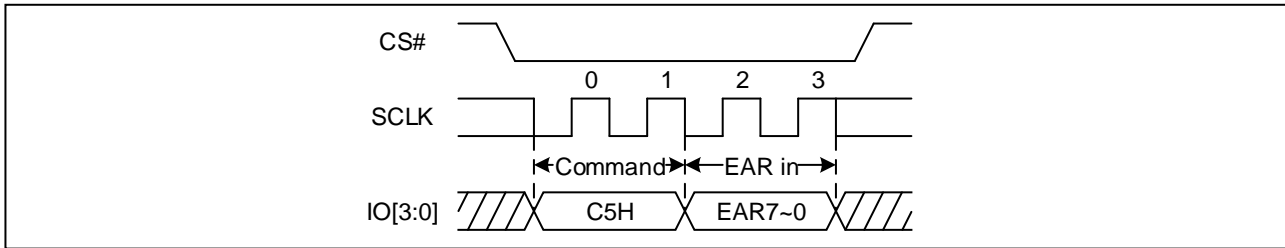
The Extended Address Bit is only effective when the device is in the 3-Byte Address Mode. When the device operates in the 4-Byte Address Mode (ADS=1), any command with address input of A31-A24 will replace the Extended Address Register values. It is recommended to check and update the Extended Address Register if necessary when the device is switched from 4-Byte to 3-Byte Address Mode.

**Figure 20 Write Extended Address Register Sequence Diagram (SPI)**





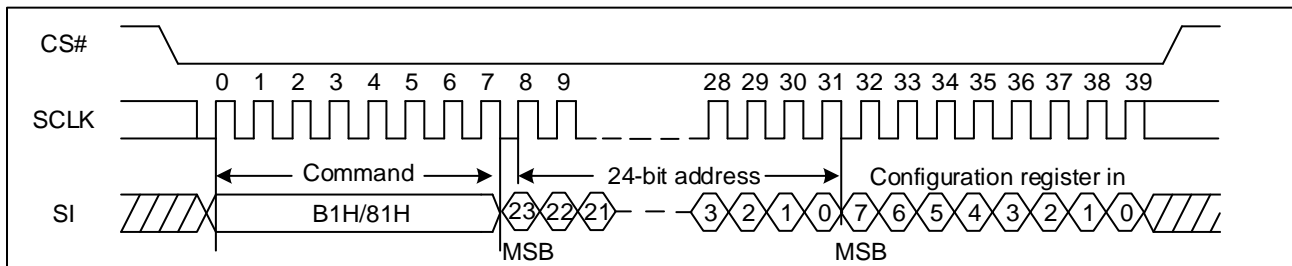
**Figure 21 Write Extended Address Register Sequence Diagram (QPI)**



## 8.8 Write Nonvolatile/Volatile Configuration Register (B1H/81H)

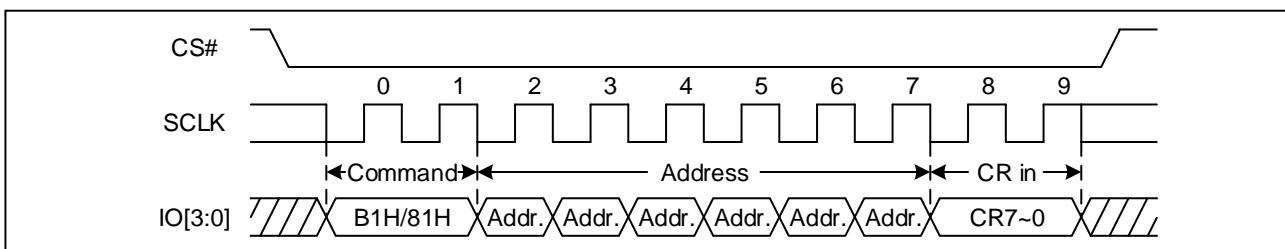
The Write Nonvolatile/Volatile Configuration Register command allows new values to be written to the Nonvolatile/Volatile Configuration Register. Before it can be accepted, a Write Enable (WREN) command must previously have been executed. After the Write Enable (WREN) command has been decoded and executed, the device sets the Write Enable Latch (WEL). CS# must be driven high after the data Byte has been latched in. If not, the Write Configuration Register command is not executed. As soon as CS# is driven high, the self-timed Write Configuration Register cycle (whose duration is  $t_W$  for B1H) is initiated. The Write In Progress (WIP) bit is 1 during the self-timed Write Configuration Register cycle, and is 0 when it is completed. When the cycle is completed, the Write Enable Latch (WEL) is reset.

**Figure 22 Write Nonvolatile/Volatile Configuration Register Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

**Figure 23 Write Nonvolatile/Volatile Configuration Register Sequence Diagram (QPI)**



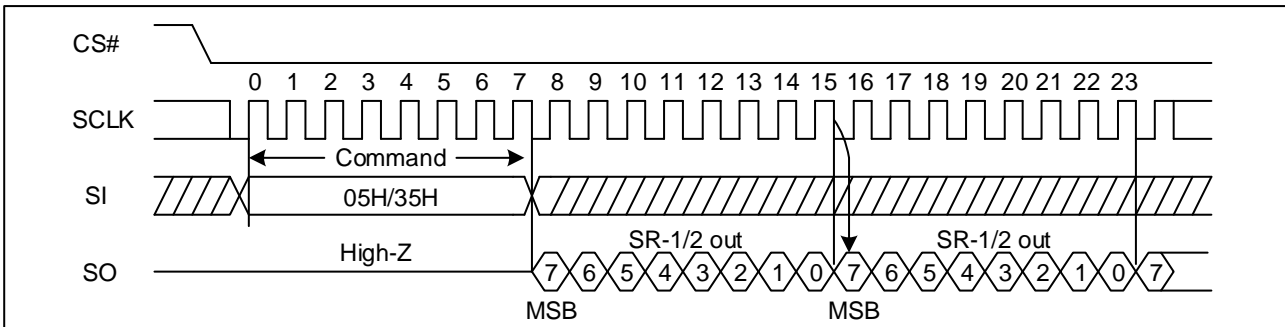
Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

## 8.9 Read Status Register (05H or 35H)

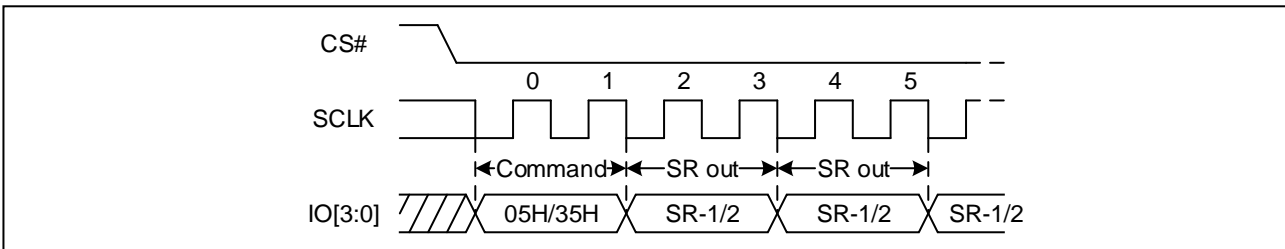
The Read Status Register command is for reading the Status Register. The Status Register may be read at any time, even while a Program, Erase or Write Status Register cycle is in progress. When one of these cycles is in progress, it is recommended to check the Write in Progress (WIP) bit before sending a new command to the device. It is also possible to read the Status Register continuously. For command code "05H"/"35H", the SO will output Status Register bits S7~S0/S15~S8.



**Figure 24 Read Status Register Sequence Diagram (SPI)**



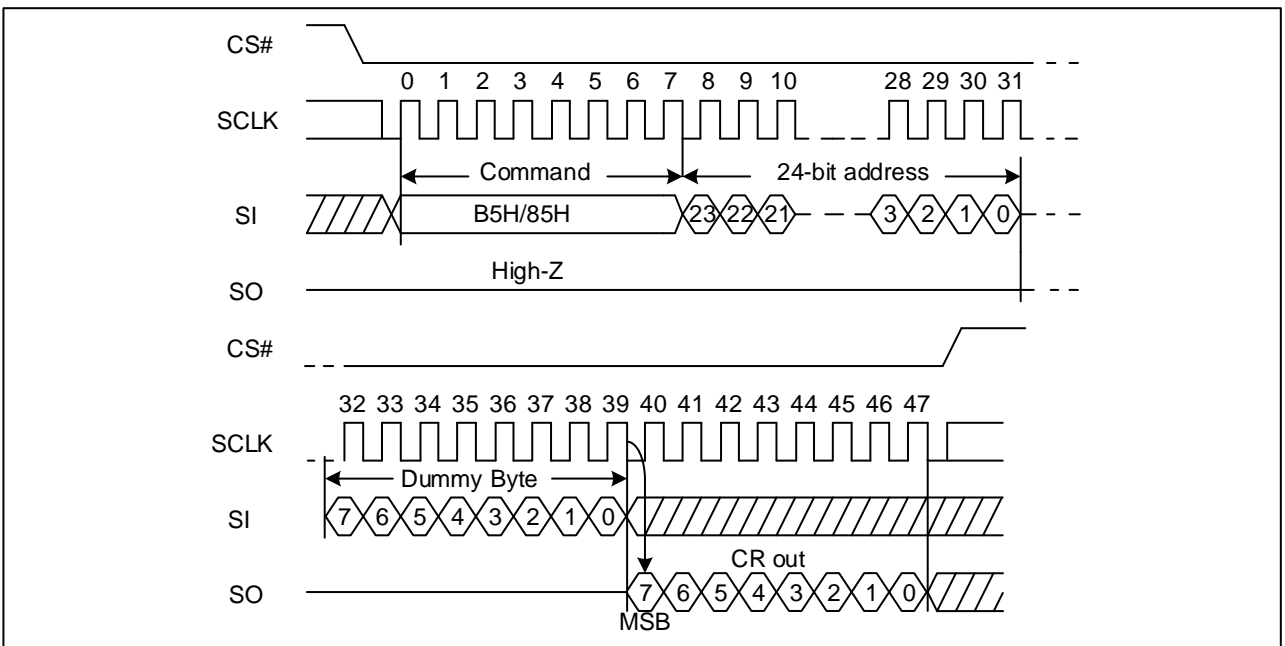
**Figure 25 Read Status Register Sequence Diagram (QPI)**



### 8.10 Read Nonvolatile/Volatile Configuration Register (B5H/85H)

The Read Nonvolatile/Volatile Configuration Register command is for reading the Nonvolatile/Volatile Configuration Registers. It is followed by a 3-Byte address (A23-A0) or a 4-Byte address (A31-A0) and a dummy Byte, and each bit is latched-in on the rising edge of SCLK. Then the Configuration Register, at that address, is shifted out on SO, and each bit is shifted out, at a Max frequency  $f_c$ , on the falling edge of SCLK. Read Nonvolatile/Volatile Configuration Register command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.

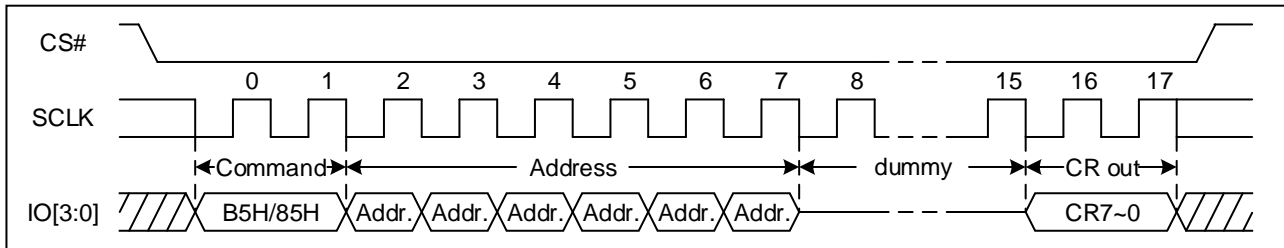
**Figure 26 Read Configuration Registers Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.



**Figure 27 Read Configuration Registers Sequence (QPI)**



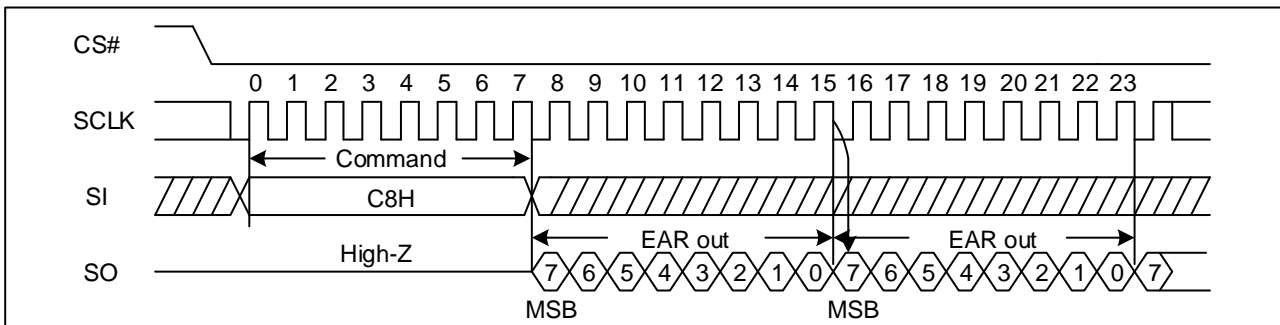
Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

### 8.11 Read Extended Address Register (C8H)

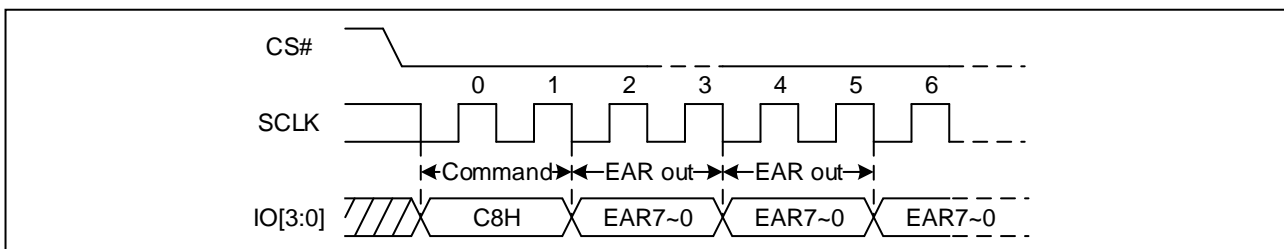
The Read Extended Address Register instruction is entered by driving CS# low and shifting the instruction code “C8H” into the SI pin on the rising edge of SCLK. The Extended Address Register bits are then shifted out on the SO pin at the falling edge of SCLK with most significant bit (MSB) first.

When the device is in the 4-Byte Address Mode, the value of the address bits is ignored.

**Figure 28 Read Extended Address Register Sequence Diagram (SPI)**



**Figure 29 Read Extended Address Register Sequence Diagram (QPI)**



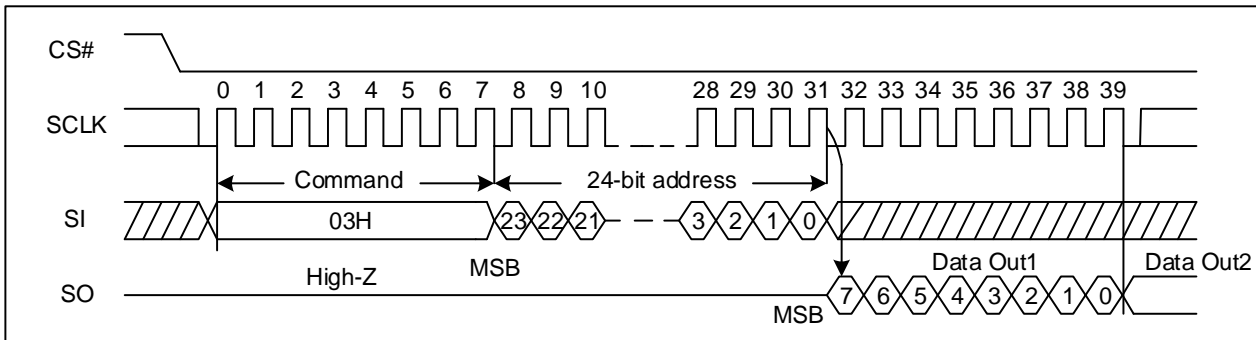
### 8.12 Read Data Bytes (03H/13H)

The Read Data Bytes (READ) command is followed by a 3-Byte address (A23-A0) or a 4-Byte address (A31-A0), and each bit is latched-in on the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, and each bit is shifted out, at a Max frequency fR, on the falling edge of SCLK. The first Byte addressed can be at any location. The address is automatically incremented to the next higher address after each Byte of data is shifted out. The whole memory can, therefore, be read with a single Read Data Bytes (READ) command. Any Read Data Bytes (READ) command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.





**Figure 30 Read Data Bytes Sequence Diagram**

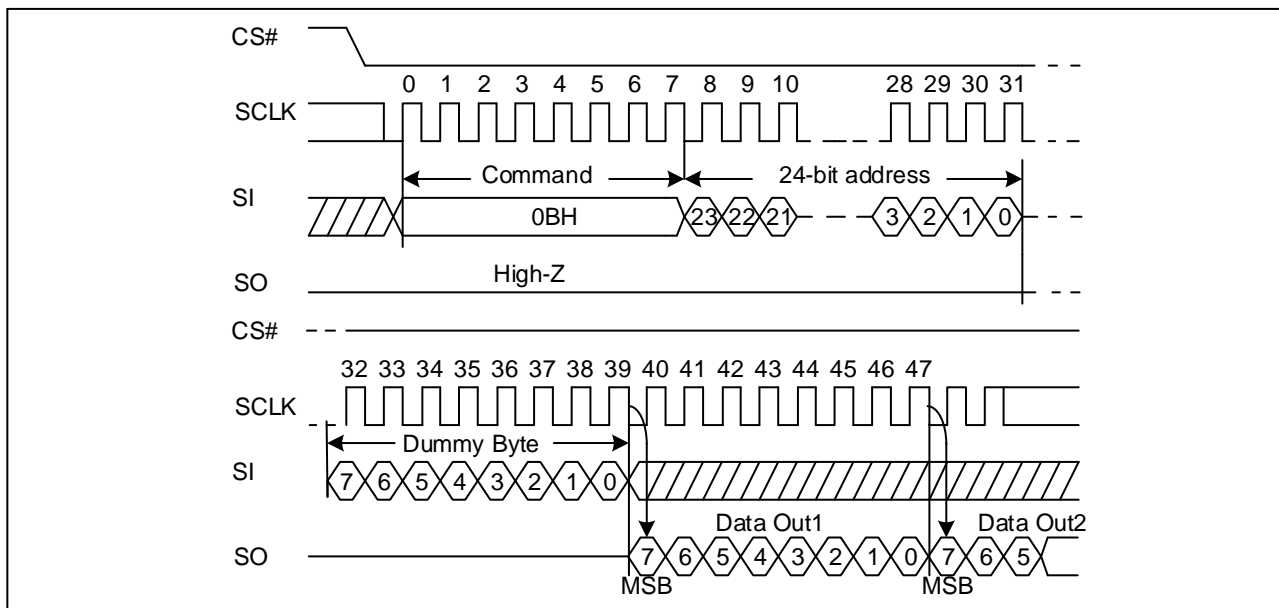


Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

### 8.13 Read Data Bytes at Higher Speed (0BH/0CH)

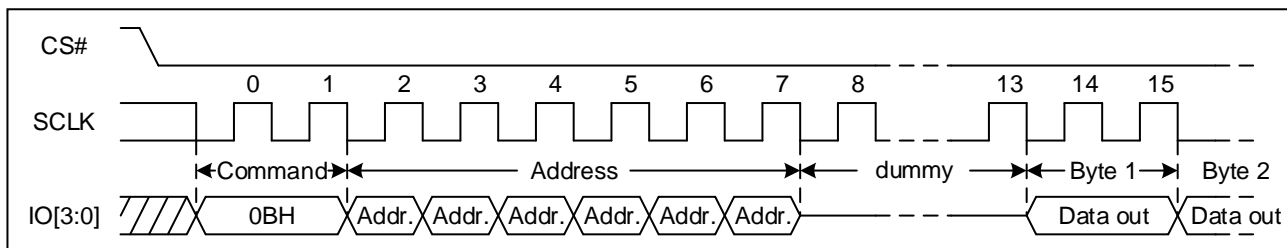
The Read Data Bytes at Higher Speed (Fast Read) command is for quickly reading data out. It is followed by a 3-Byte address (A23-A0) or a 4-Byte address (A31-A0) and dummy clocks, and each bit is latched-in on the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, and each bit is shifted out, at a Max frequency  $f_c$ , on the falling edge of SCLK. The first Byte addressed can be at any location. The address is automatically incremented to the next higher address after each Byte of data is shifted out.

**Figure 31 Read Data Bytes at Higher Speed Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

**Figure 32 Read Data Bytes at Higher Speed Sequence Diagram (QPI)**



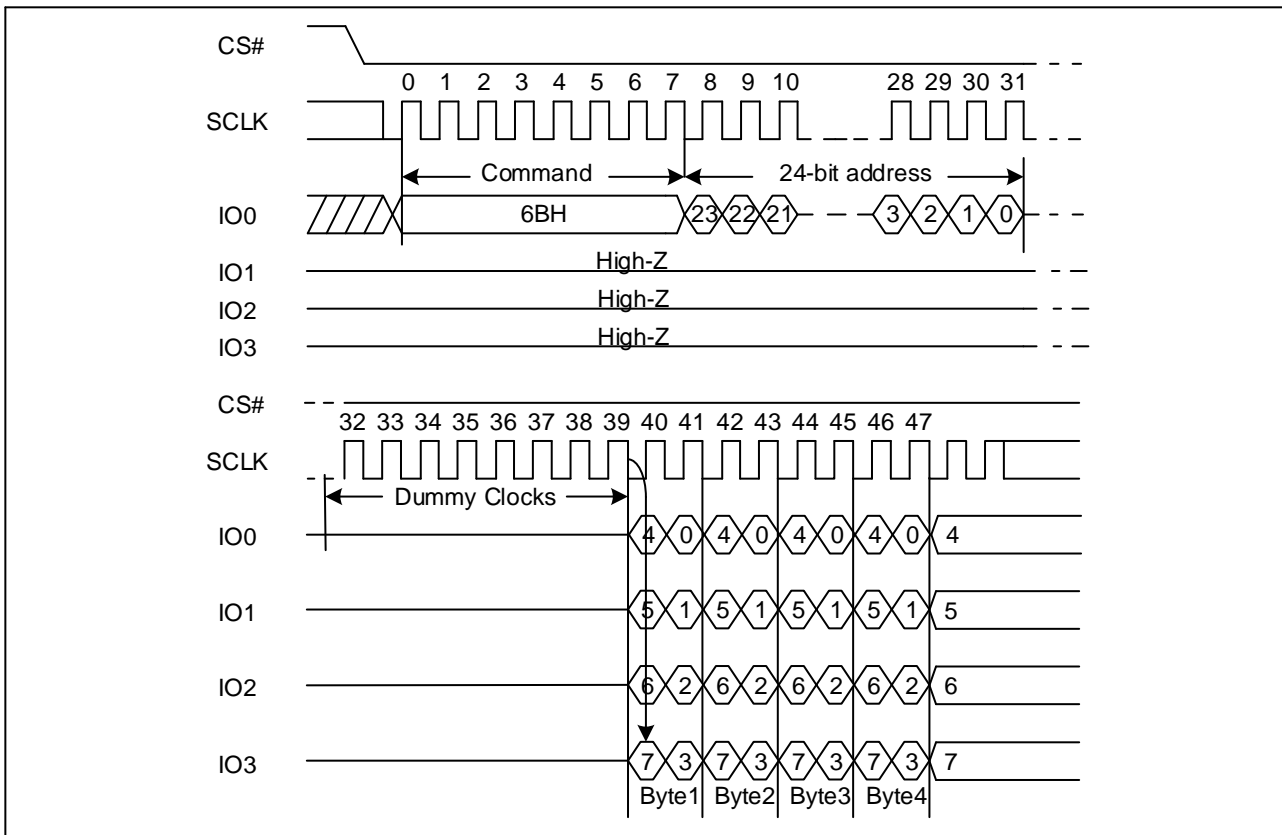
Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.



### 8.14 Quad Output Fast Read (6BH/6CH)

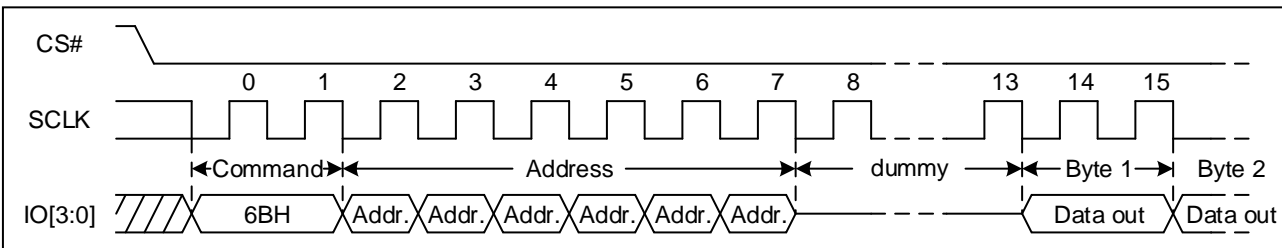
The Quad Output Fast Read command is followed by 3-Byte address (A23-A0) or a 4-Byte address (A31-A0) and dummy clocks, and each bit is latched in on the rising edge of SCLK, then the memory contents are shifted out 4-bit per clock cycle from IO3, IO2, IO1 and IO0. The first Byte addressed can be at any location. The address is automatically incremented to the next higher address after each Byte of data is shifted out.

**Figure 33 Quad Output Fast Read Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

**Figure 34 Quad Output Fast Read Sequence Diagram (QPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

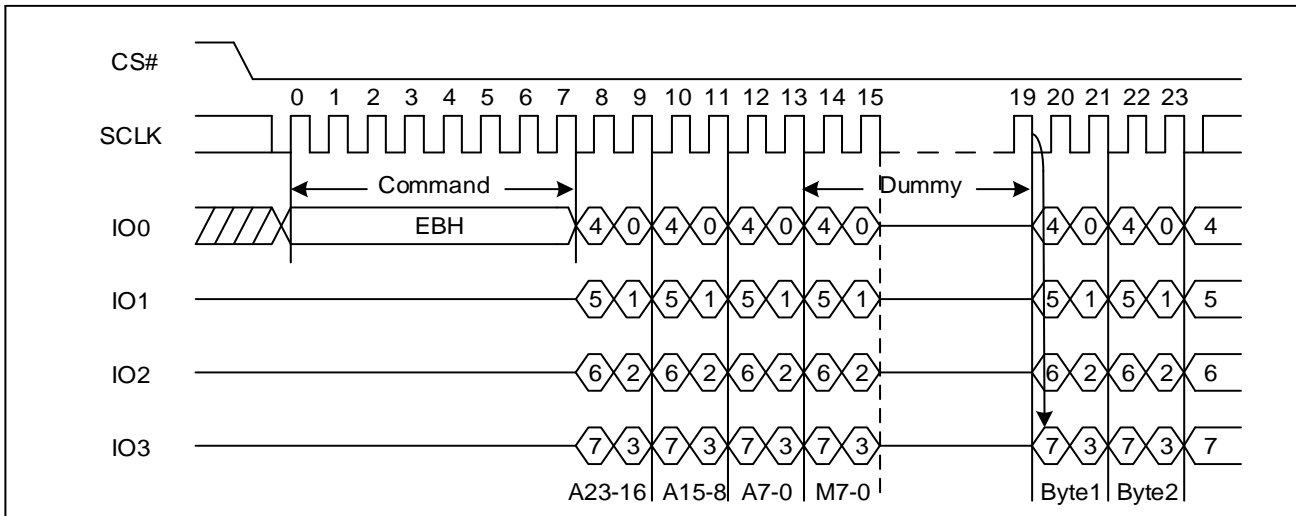
### 8.15 Quad I/O Fast Read (EBH/ECH)

The Quad I/O Fast Read command is similar to the Quad Output Fast Read command but with the capability to input the 3-Byte address (A23-0) or a 4-Byte address (A31-A0) and a “Continuous Read Mode” Byte and dummy clocks. 4-bit per clock is transferred by IO0, IO1, IO2, IO3, and each bit is latched in on the rising edge of SCLK, then the memory contents are shifted out 4-bit per clock cycle from IO0, IO1, IO2, IO3. The first Byte addressed can be at any location. The address is automatically incremented to the next higher address after each Byte of data is shifted out.



"Continuous Read Mode" bits must NOT be set as (M5-4) = (1, 0)

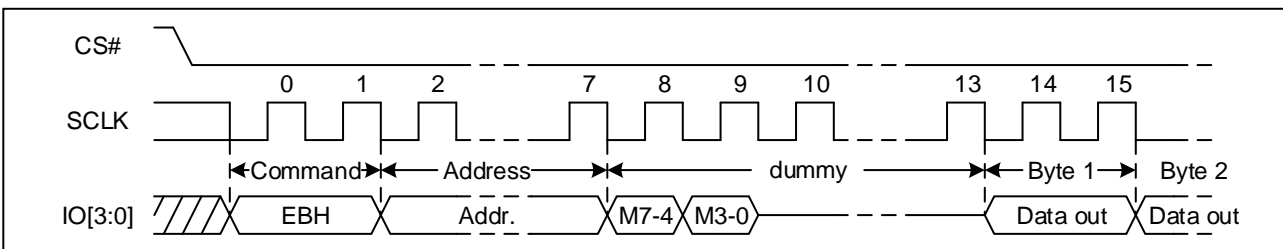
**Figure 35 Quad I/O Fast Read Sequence Diagram (SPI, M5-4# (1, 0))**



Note:

1. The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.
2. M5-4 must **not** be set as (1, 0).

**Figure 36 Quad I/O Fast Read Sequence Diagram (QPI, M5-4# (1, 0))**



Note:

1. The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.
2. M5-4 must **not** be set as (1, 0).

### Quad I/O Fast Read with "16/32/64-Byte Wrap Around"

The Quad I/O Fast Read command can be used to access a specific portion within a page by issuing Wrap configuration register Byte prior to EBH/ECH. The data being accessed can be limited to either a 16/32/64-Byte section of a 256-Byte page. The output data starts at the initial address specified in the command, once it reaches the ending boundary of the 16/32/64-Byte section, the output will wrap around the beginning boundary automatically until CS# is pulled high to terminate the command.

The Burst with Wrap feature allows applications that use cache to quickly fetch a critical address and then fill the cache afterwards within a fixed length (16/32/64-Byte) of data without issuing multiple read commands.

## 8.16 Quad I/O DTR Read (EDH/EEH)

The Quad I/O DTR Read instruction enables Double Transfer Rate throughput on quad I/O of Serial Flash in read mode. The address (interleave on 4 I/O pins) is latched on both rising and falling edge of SCLK, and data (interleave on 4 I/O pins) shift out on both rising and falling edge of SCLK. The 8-bit address can be latched-in at one clock, and 8-bit data can be read out at one clock, which means four bits at rising edge of clock, the other four bits at falling edge of clock. The first

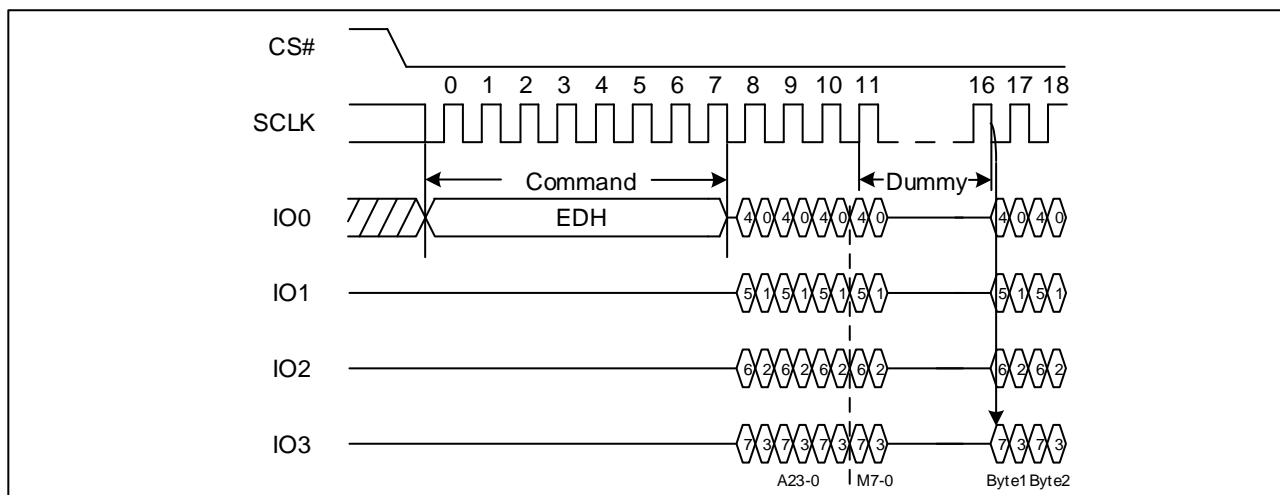


address Byte can be at any location. The address is automatically increased to the next higher address after each Byte data is shifted out, so the whole memory can be read out at a single Quad I/O DTR Read command. The address counter rolls over to 0 when the highest address has been reached.

While Program/Erase/Write Status Register cycle is in progress, Quad I/O DTR Read command is rejected without any impact on the Program/Erase/Write Status Register current cycle.

**"Continuous Read Mode" bits must NOT be set as (M5-4) = (1, 0)**

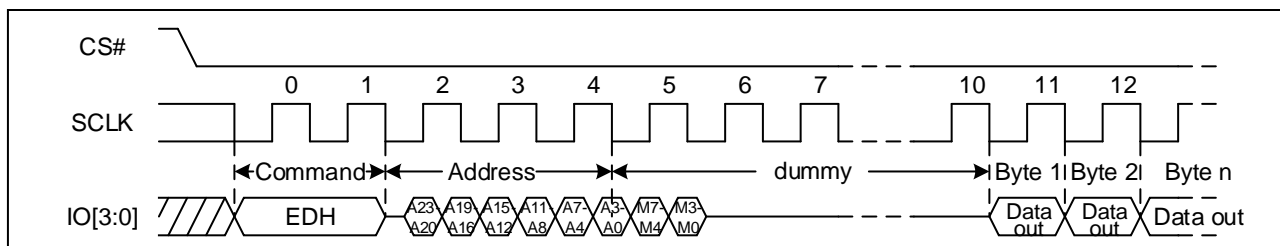
**Figure 37. DTR Quad I/O Fast Read Sequence Diagram (SPI, M5-4 ≠ (1, 0))**



Note:

1. The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.
2. M5-4 must **not** be set as (1, 0).

**Figure 38. DTR Quad I/O Fast Read Sequence Diagram (QPI, M5-4 ≠ (1, 0))**



Note:

1. The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.
2. M5-4 must **not** be set as (1, 0).

### Quad I/O DTR Fast Read with “16/32/64-Byte Wrap Around”

The Quad I/O DTR Fast Read command can be used to access a specific portion within a page by issuing Wrap configuration register Byte prior to EDH/EEH. The data being accessed can be limited to either a 16/32/64-Byte section of a 256-Byte page. The output data starts at the initial address specified in the command, once it reaches the ending boundary of the 16/32/64-Byte section, the output will wrap around the beginning boundary automatically until CS# is pulled high to terminate the command.

The Burst with Wrap feature allows applications that use cache to quickly fetch a critical address and then fill the cache afterwards within a fixed length (16/32/64-Byte) of data without issuing multiple read commands.



## 8.17 Page Program (PP) (02H/12H)

The Page Program (PP) command is for programming the memory. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Page Program command.

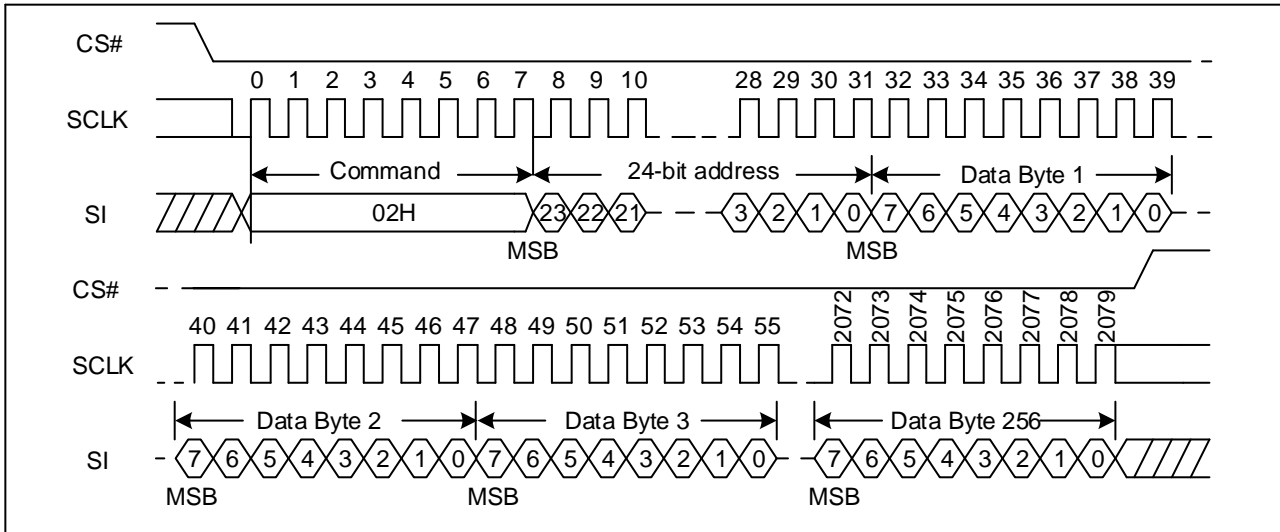
The Page Program (PP) command is entered by driving CS# Low, followed by the command code, three or four address Bytes and at least one data Byte on SI. If the 8 least significant address bits (A7-A0) are not all zero, all transmitted data that goes beyond the end of the current page are programmed from the start address of the same page (from the address whose 8 least significant bits (A7-A0) are all zero). CS# must be driven low for the entire duration of the sequence. The Page Program command sequence: CS# goes low → sending Page Program command → 3-Byte address or 4-Byte address on SI → at least 1 Byte data on SI → CS# goes high. If more than 256 Bytes are sent to the device, previously latched data are discarded and the last 256 data Bytes are guaranteed to be programmed correctly within the same page. If less than 256 data Bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other Bytes of the same page. CS# must be driven high after the eighth bit of the last data Byte has been latched in; otherwise the Page Program (PP) command is not executed.

As soon as CS# is driven high, the self-timed Page Program cycle (whose duration is  $t_{PP}$ ) is initiated. While the Page Program cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Page Program cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

A Page Program (PP) command applied to a page which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) is not executed.

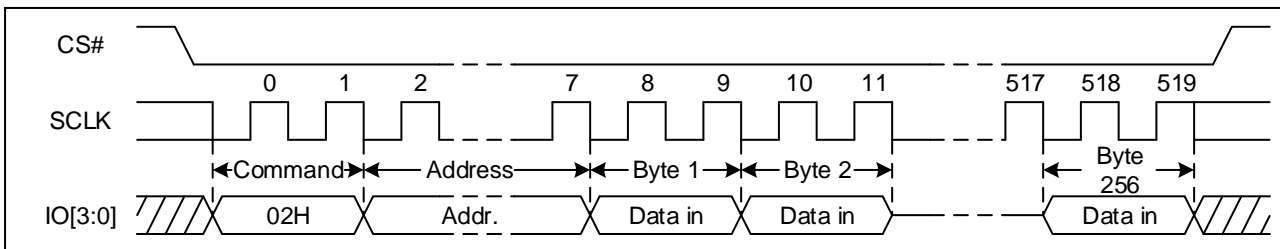


**Figure 39 Page Program Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

**Figure 40 Page Program Sequence Diagram (QPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

## 8.18 Quad Page Program (32H/34H)

The Quad Page Program command is for programming the memory using four pins: IO0, IO1, IO2, and IO3. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Page Program command. The quad Page Program command is entered by driving CS# Low, followed by the command code (32H/34H), three or four address Bytes and at least one data Byte on IO pins.

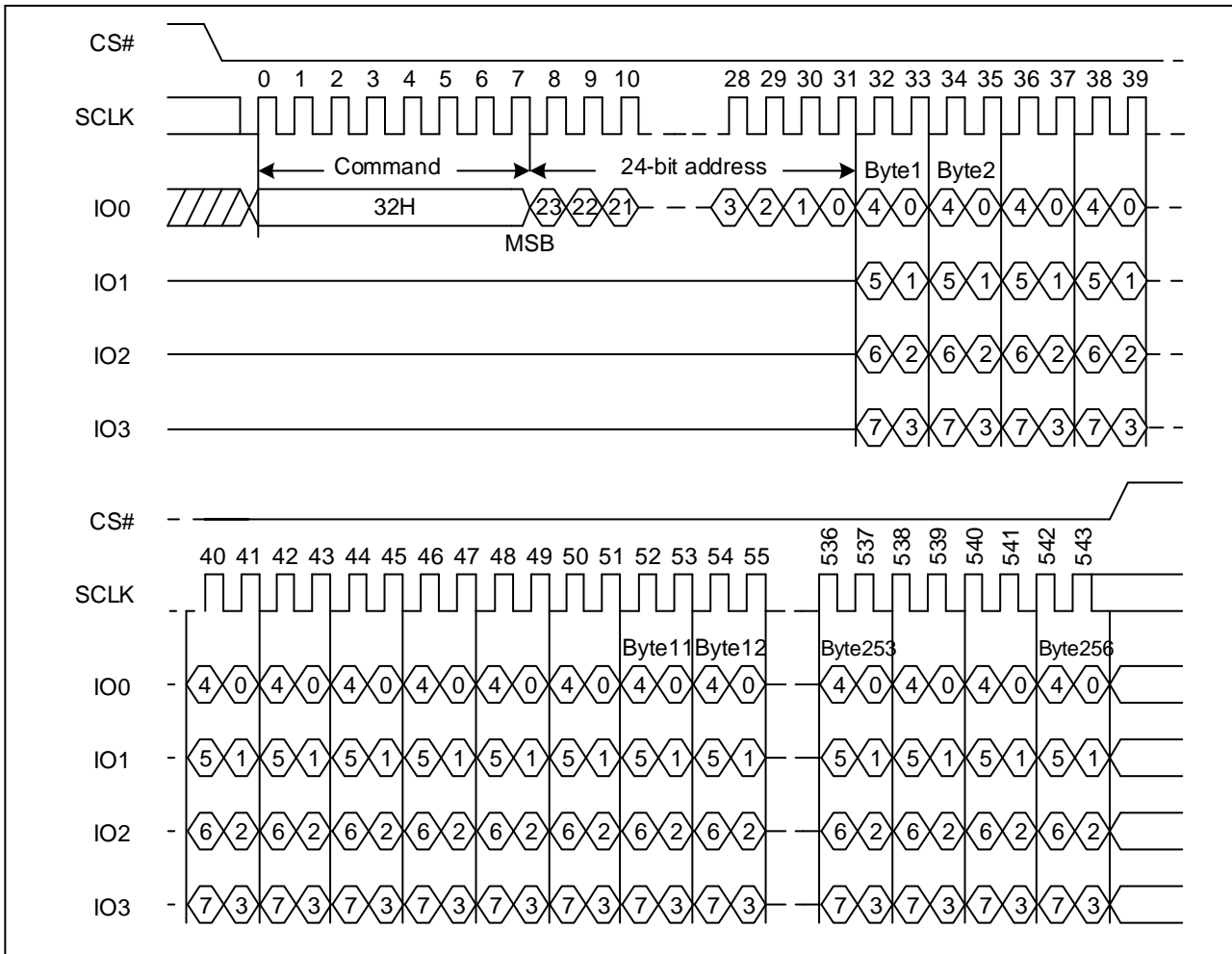
If more than 256 Bytes are sent to the device, previously latched data are discarded and the last 256 data Bytes are guaranteed to be programmed correctly within the same page. If less than 256 data Bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other Bytes of the same page. CS# must be driven high after the eighth bit of the last data Byte has been latched in; otherwise the Quad Page Program (PP) command is not executed.

As soon as CS# is driven high, the self-timed Quad Page Program cycle (whose duration is  $t_{PP}$ ) is initiated. While the Quad Page Program cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Quad Page Program cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

A Quad Page Program command applied to a page which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) is not executed.

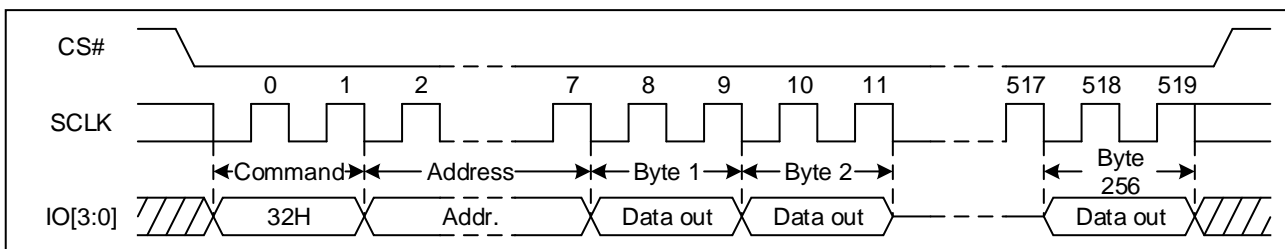


**Figure 41 Quad Page Program Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

**Figure 42 Quad Page Program Sequence Diagram (QPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

### 8.19 Extend Quad Page Program (C2H/3EH)

The Extend Quad Page Program command is for programming the memory using four pins: IO0, IO1, IO2, and IO3. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Page Program command. The extend quad Page Program command is entered by driving CS# Low, followed by the command code (C2H/3EH), three or four address Bytes and at least one data Byte on IO pins.

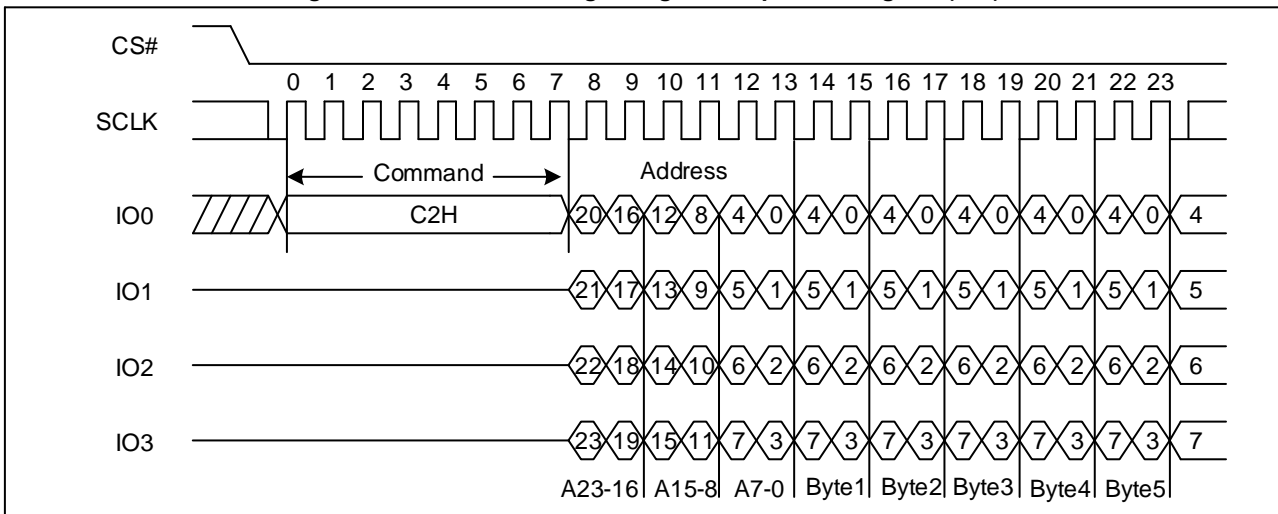
If more than 256 Bytes are sent to the device, previously latched data are discarded and the last 256 data Bytes are guaranteed to be programmed correctly within the same page. If less than 256 data Bytes are sent to device, they are



correctly programmed at the requested addresses without having any effects on the other Bytes of the same page. CS# must be driven high after the eighth bit of the last data Byte has been latched in; otherwise the Extend Quad Page Program (EPP) command is not executed.

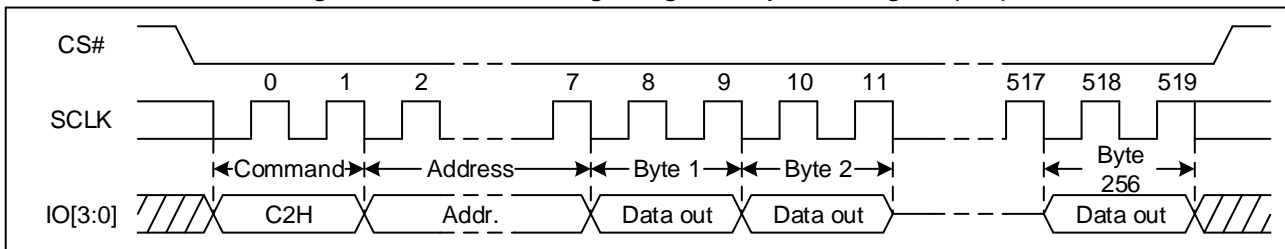
As soon as CS# is driven high, the self-timed Extend Quad Page Program cycle (whose duration is  $t_{PP}$ ) is initiated. While the Extend Quad Page Program cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Extend Quad Page Program cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. An Extend Quad Page Program command applied to a page which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) is not executed.

**Figure 43 Extend Quad Page Program Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

**Figure 44 Extend Quad Page Program Sequence Diagram (QPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

## 8.20 Sector Erase (SE) (20H/21H)

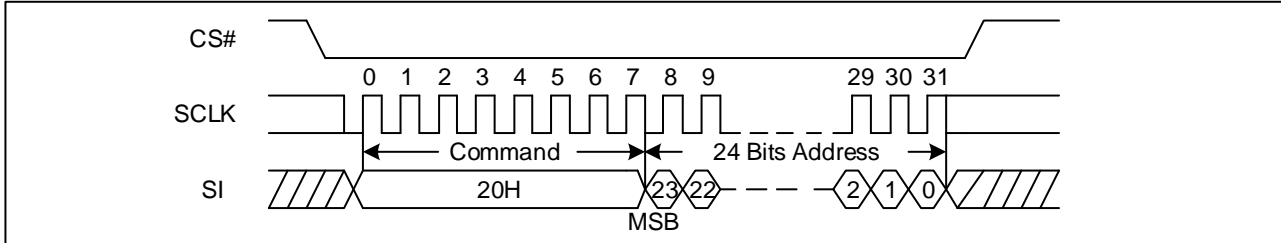
The Sector Erase (SE) command is erased the all data of the chosen sector. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The Sector Erase (SE) command is entered by driving CS# low, followed by the command code, and 3- Byte address or 4-Byte address on SI. Any address inside the sector is a valid address for the Sector Erase (SE) command. CS# must be driven low for the entire duration of the sequence. The Sector Erase command sequence: CS# goes low → sending Sector Erase command → 3-Byte address or 4-Byte address on SI → CS# goes high. CS# must be driven high after the eighth bit of the last address Byte has been latched in; otherwise the Sector Erase (SE) command is not executed. As soon as CS# is driven high, the self-timed Sector Erase cycle (whose duration is  $t_{SE}$ ) is initiated. While the Sector Erase cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Sector Erase





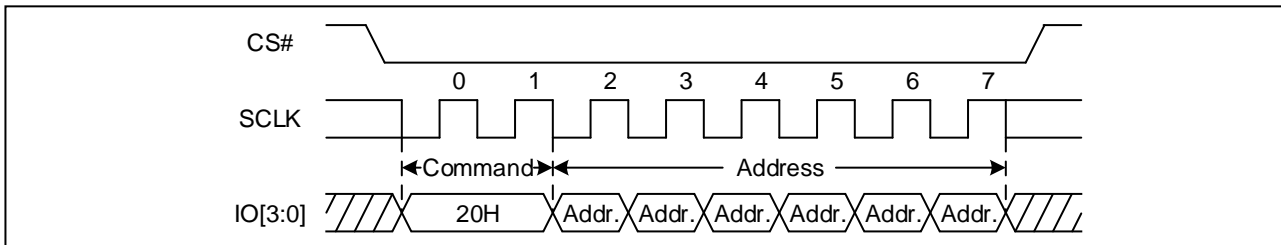
cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A Sector Erase (SE) command applied to a sector which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) bits is not executed.

**Figure 45 Sector Erase Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

**Figure 46 Sector Erase Sequence Diagram (QPI)**

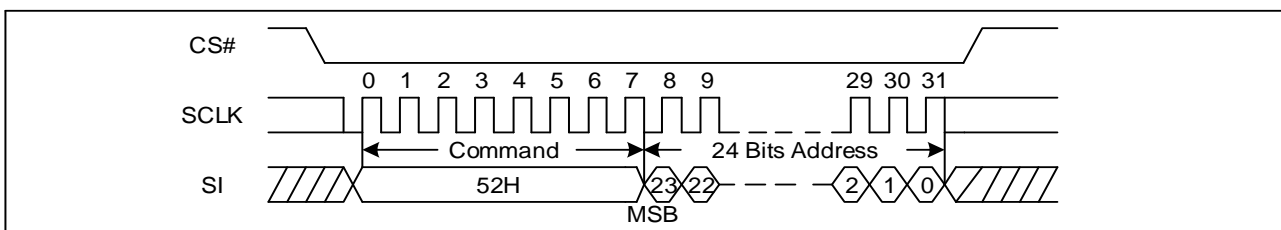


Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

## 8.21 32KB Block Erase (BE32) (52H/5CH)

The 32KB Block Erase command is erased the all data of the chosen block. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The 32KB Block Erase (BE) command is entered by driving CS# low, followed by the command code, and 3-Byte address or 4-Byte address on SI. Any address inside the block is a valid address for the 32KB Block Erase command. CS# must be driven low for the entire duration of the sequence. The 32KB Block Erase command sequence: CS# goes low → sending 32KB Block Erase command → 3-Byte address or 4-Byte address on SI → CS# goes high. CS# must be driven high after the eighth bit of the last address Byte has been latched in; otherwise the 32KB Block Erase command is not executed. As soon as CS# is driven high, the self-timed Block Erase cycle (whose duration is  $t_{BE1}$ ) is initiated. While the Block Erase cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Block Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A 32KB Block Erase command applied to a block which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) bits is not executed.

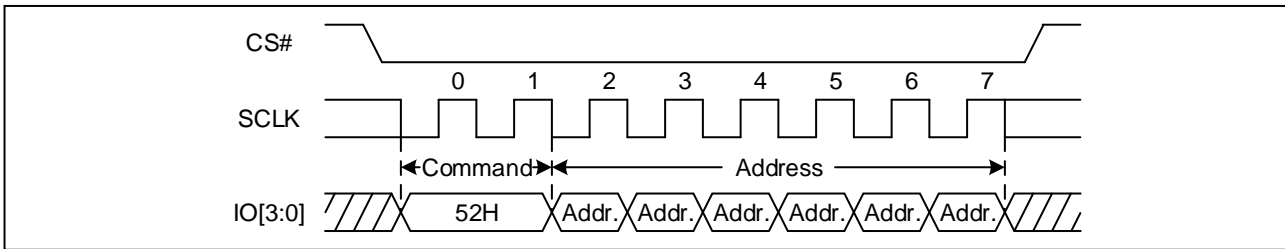
**Figure 47 32KB Block Erase Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.



**Figure 48 32KB Block Erase Sequence Diagram (QPI)**



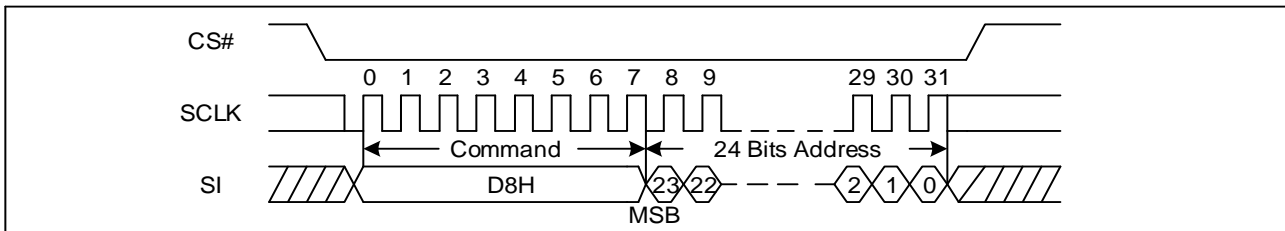
Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

## 8.22 64KB Block Erase (BE64) (D8H/DCH)

The 64KB Block Erase command is erased the all data of the chosen block. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The 64KB Block Erase command is entered by driving CS# low, followed by the command code, and 3-Byte address or 4-Byte address on SI. Any address inside the block is a valid address for the 64KB Block Erase command. CS# must be driven low for the entire duration of the sequence.

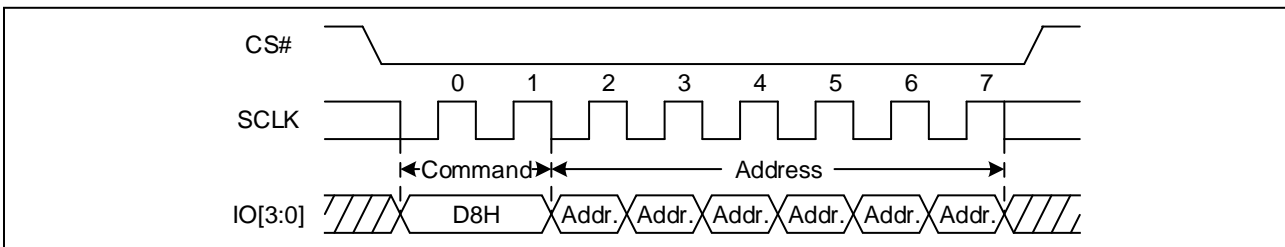
The 64KB Block Erase command sequence: CS# goes low → sending 64KB Block Erase command → 3-Byte address or 4-Byte address on SI → CS# goes high. CS# must be driven high after the eighth bit of the last address Byte has been latched in; otherwise the 64KB Block Erase command is not executed. As soon as CS# is driven high, the self-timed Block Erase cycle (whose duration is  $t_{BE2}$ ) is initiated. While the Block Erase cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Block Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A 64KB Block Erase command applied to a block which is protected by the Block Protect (BP4, BP3, BP2, BP1, and BP0) bits is not executed.

**Figure 49 64KB Block Erase Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

**Figure 50 64KB Block Erase Sequence Diagram (QPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

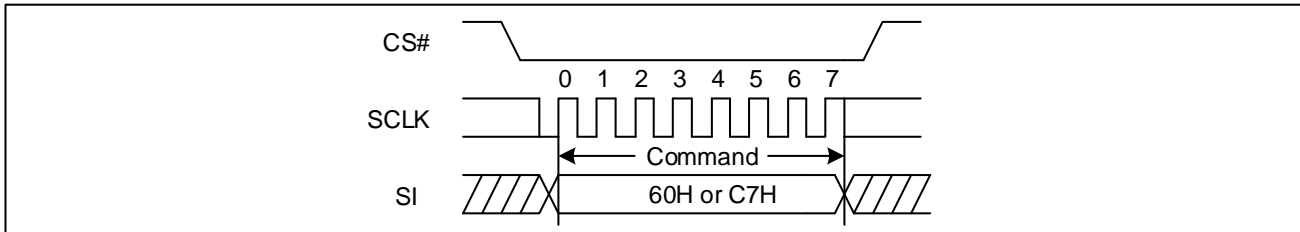
## 8.23 Chip Erase (CE) (60/C7H)

The Chip Erase (CE) command is erased the all data of the chip. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The Chip Erase (CE) command is entered by driving CS# Low, followed by the command code on Serial Data Input (SI). CS# must be driven Low for the entire duration of the sequence.

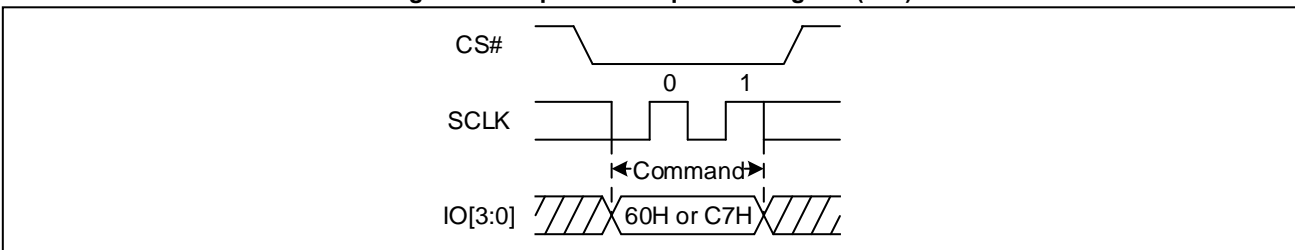


The Chip Erase command sequence: CS# goes low → sending Chip Erase command → CS# goes high. CS# must be driven high after the eighth bit of the command code has been latched in; otherwise the Chip Erase command is not executed. As soon as CS# is driven high, the self-timed Chip Erase cycle (whose duration is  $t_{CE}$ ) is initiated. While the Chip Erase cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Chip Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. The Chip Erase (CE) command is executed if the Block Protect (BP2, BP1, and BP0) bits are 0. The Chip Erase (CE) command is ignored if one or more sectors are protected.

**Figure 51 Chip Erase Sequence Diagram (SPI)**



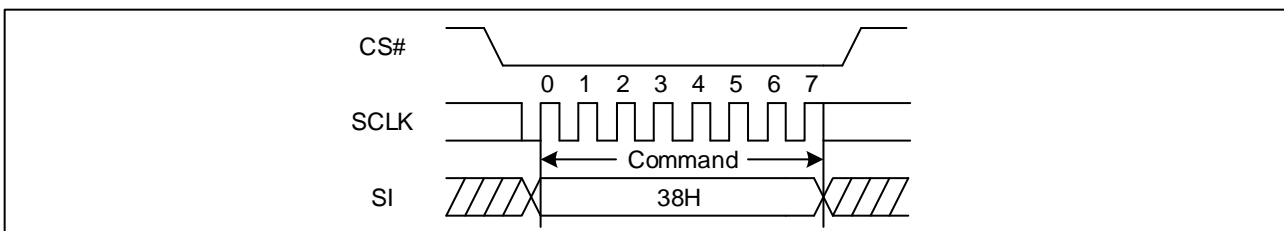
**Figure 52 Chip Erase Sequence Diagram (QPI)**



## 8.24 Enable QPI (38H)

The device support both Standard/Quad SPI and QPI mode. The “Enable QPI (38H)” command can switch the device from SPI mode to QPI mode. In order to switch the device to QPI mode, “Enable QPI (38H)” command must be issued. When the device is switched from SPI mode to QPI mode, the existing Write Enable Latch and Program/Erase Suspend status, and the Wrap Length setting will remain unchanged.

**Figure 53 Enable QPI mode command Sequence Diagram**

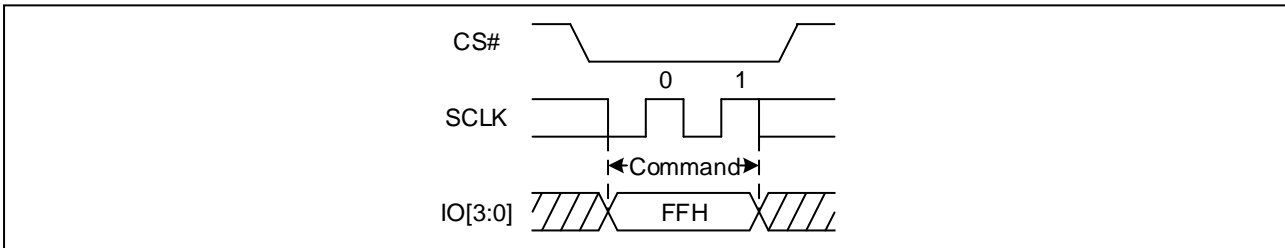


## 8.25 Disable QPI (FFH)

To exit the QPI mode and return to Standard/Quad SPI mode, the “Disable QPI (FFH)” command must be issued. When the device is switched from QPI mode to SPI mode, the existing Write Enable Latch and Program/Erase Suspend status, and the Wrap Length setting will remain unchanged.



**Figure 54 Disable QPI mode command Sequence Diagram**

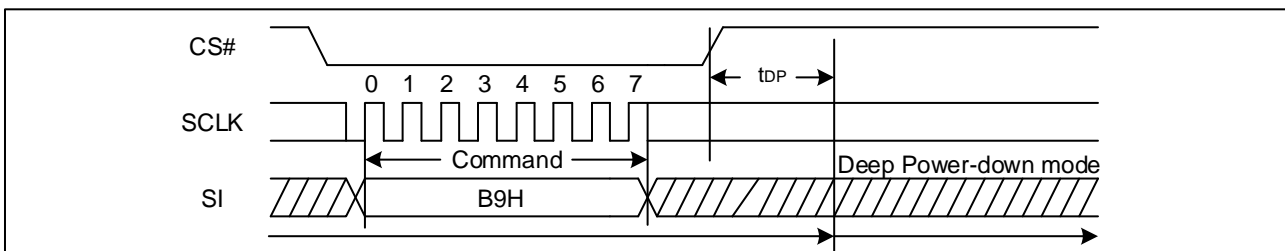


### 8.26 Deep Power-Down (DP) (B9H)

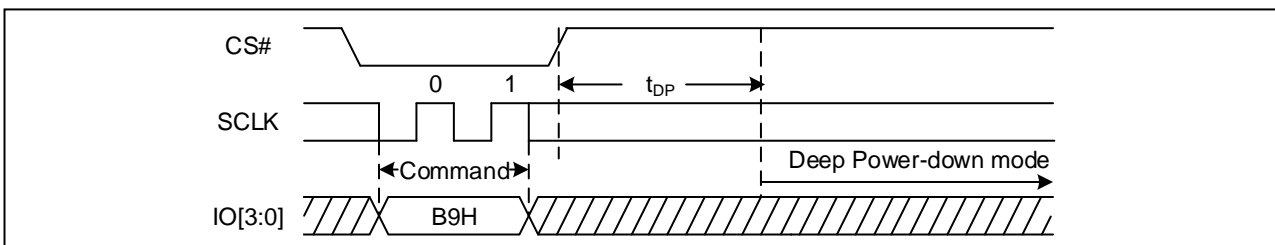
Executing the Deep Power-Down (DP) command is the only way to put the device in the lowest consumption mode (the Deep Power-Down Mode). It can also be used as an extra software protection mechanism, while the device is not in active use, since in this mode, the device ignores all Write, Program and Erase commands. Driving CS# high deselects the device, and puts the device in the Standby Mode (if there is no internal cycle currently in progress). But this mode is not the Deep Power-Down Mode. The Deep Power-Down Mode can only be entered by executing the Deep Power-Down (DP) command. Once the device has entered the Deep Power-Down Mode, all commands are ignored except the Release from Deep Power-Down (ABH) or Enable Reset (66H) and Reset (99H) commands. These commands can release the device from this mode. The Release from Deep Power-Down command releases the device from deep power down mode.

The Deep Power-Down Mode automatically stops at Power-Down, and the device is in the Standby Mode after Power-Up. The Deep Power-Down command sequence: CS# goes low → sending Deep Power-Down command → CS# goes high. CS# must be driven high after the eighth bit of the command code has been latched in; otherwise the Deep Power-Down (DP) command is not executed. As soon as CS# is driven high, it requires a delay of  $t_{DP}$  before the supply current is reduced to  $I_{CC2}$  and the Deep Power-Down Mode is entered. Any Deep Power-Down (DP) command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.

**Figure 55 Deep Power-Down Sequence Diagram (SPI)**



**Figure 56 Deep Power-Down Sequence Diagram (QPI)**



### 8.27 Release from Deep Power-Down (ABH)

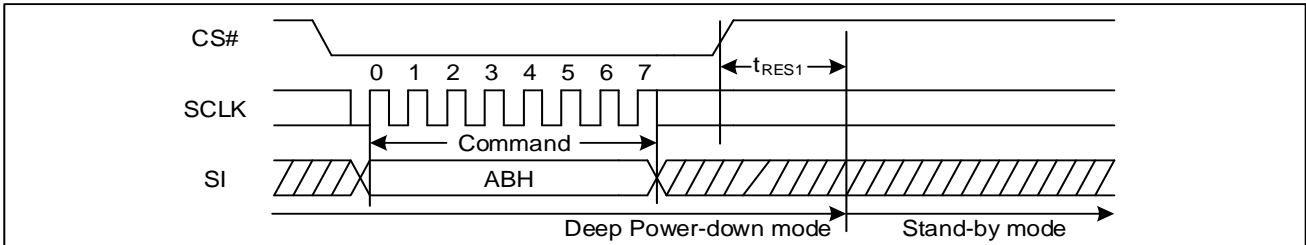
To release the device from the Power-Down state, the command is issued by driving the CS# pin low, shifting the instruction code "ABH" and driving CS# high. Release from Power-Down will take the time duration of  $t_{RES1}$  (See AC Characteristics) before the device will resume normal operation and other command are accepted. The CS# pin must



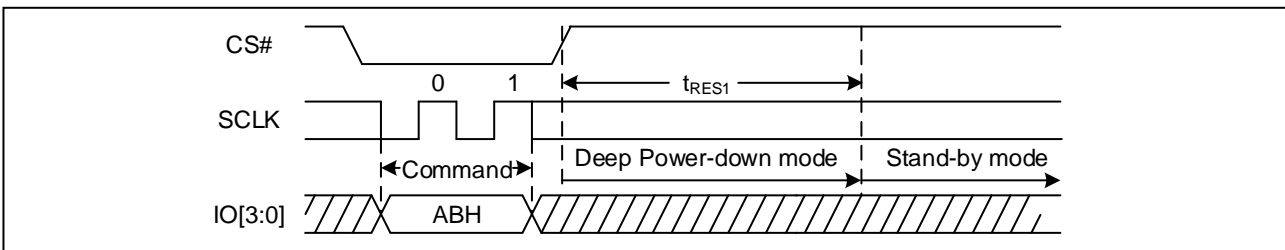
remain high during the  $t_{RES1}$  time duration.

When used to release the device from the Power-Down state, the command is the same as previously described, After this time duration the device will resume normal operation and other command will be accepted. If the Release from Power-Down command is issued while an Erase, Program or Write cycle is in process (when WIP equal 1) the command is ignored and will not have any effects on the current cycle.

**Figure 57 Release Power-Down Sequence Diagram (SPI)**



**Figure 58 Release Power-Down Sequence Diagram (QPI)**

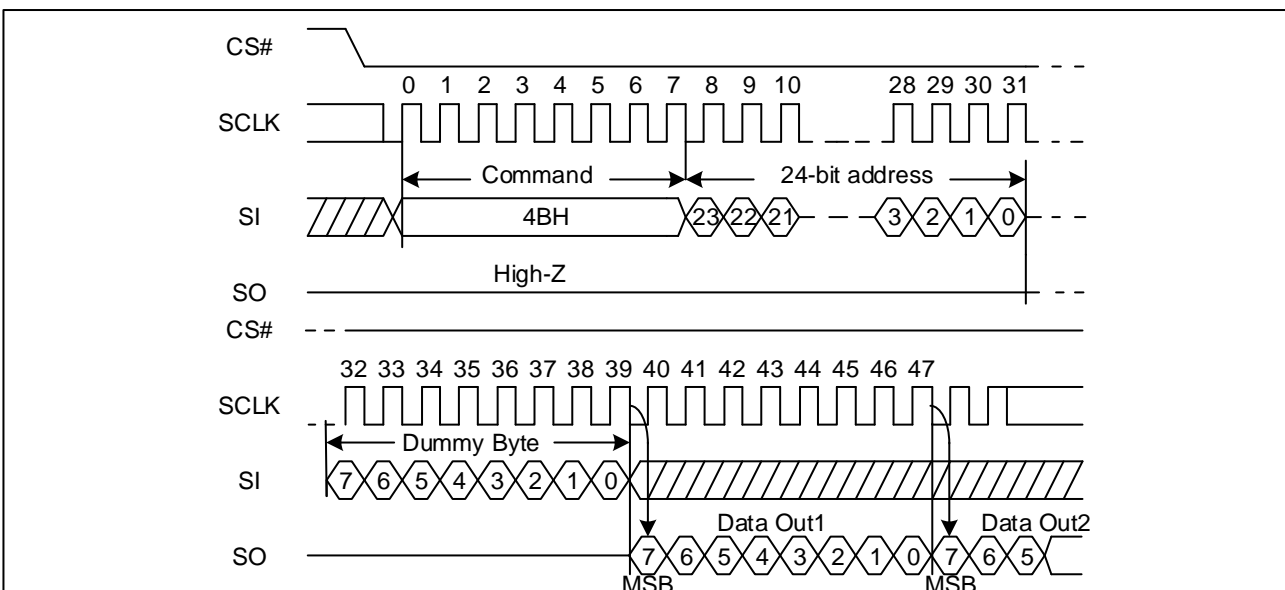


## 8.28 Read Unique ID (4BH)

The Read Unique ID command accesses a factory-set read-only 128bit number that is unique to each device. The Unique ID can be used in conjunction with user software methods to help prevent copying or cloning of a system.

The Read Unique ID command sequence: CS# goes low → sending Read Unique ID command → 3-Byte (000000H) or 4-Byte (00000000H) Address → 1 Byte Dummy → 128bit Unique ID Out → CS# goes high.

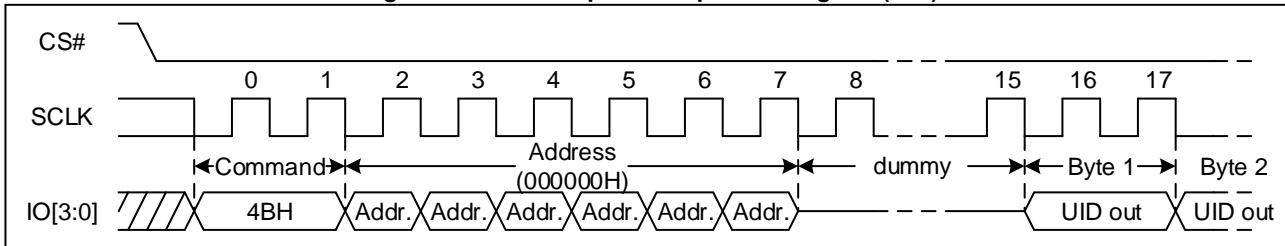
**Figure 59 Read Unique ID Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.



**Figure 60 Read Unique ID Sequence Diagram (QPI)**



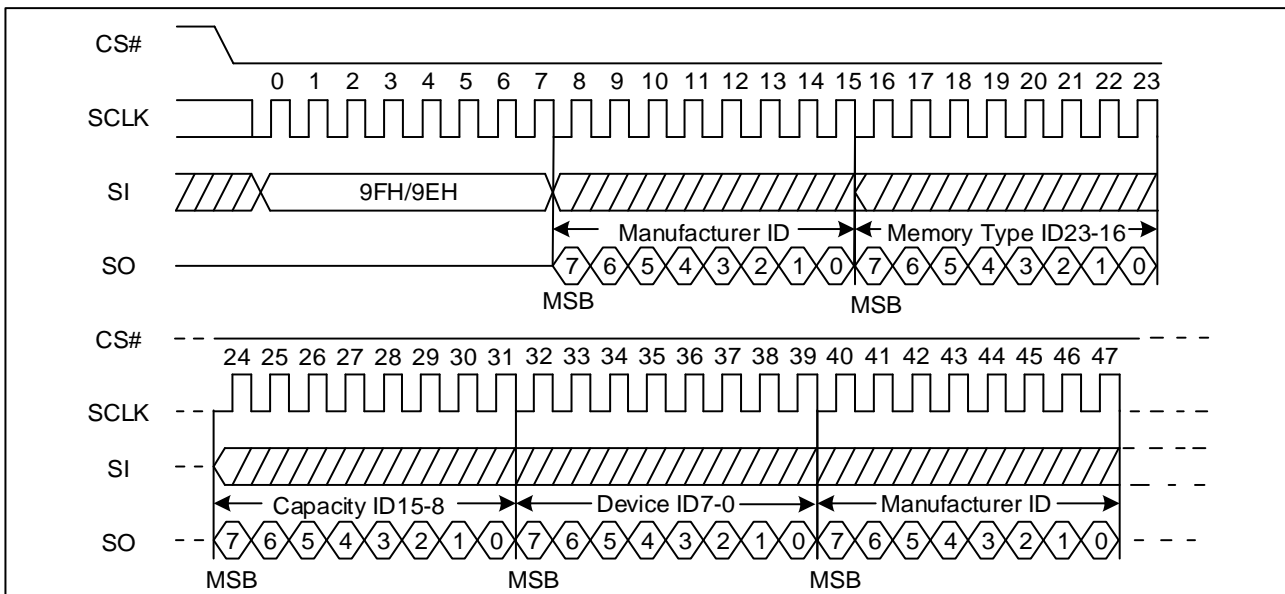
Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

### 8.29 Read Identification (RDID) (9FH/9EH)

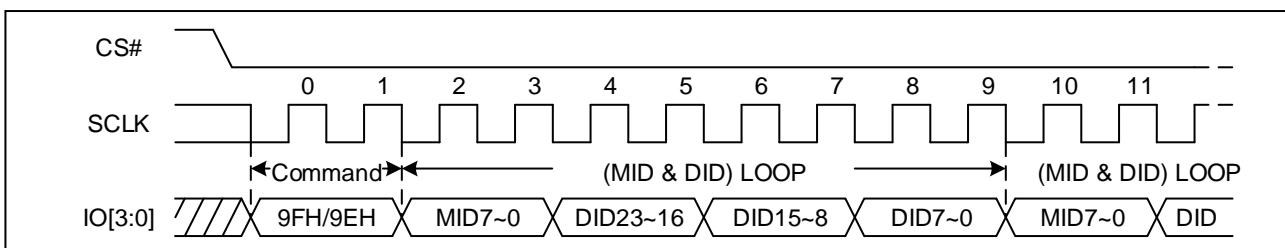
The Read Identification (RDID) command allows the 8-bit manufacturer identification to be read, followed by three Bytes of device identification. The device identification indicates the memory type in the first Byte, and the memory capacity of the device in the second Byte. The Read Identification (RDID) command while an Erase or Program cycle is in progress, is not decoded, and has no effect on the cycle that is in progress. The Read Identification (RDID) command should not be issued while the device is in Deep Power-Down Mode.

The device is first selected by driving CS# low. Then, the 8-bit command code for the command is shifted in. This is followed by the 32-bit device identification, stored in the memory. Each bit is shifted out on the falling edge of Serial Clock. The Read Identification (RDID) command is terminated by driving CS# high at any time during data output. When CS# is driven high, the device is in the Standby Mode. Once in the Standby Mode, the device waits to be selected, so that it can receive, decode and execute commands.

**Figure 61 Read Identification ID Sequence Diagram (SPI)**



**Figure 62 Read Identification ID Sequence Diagram (QPI)**

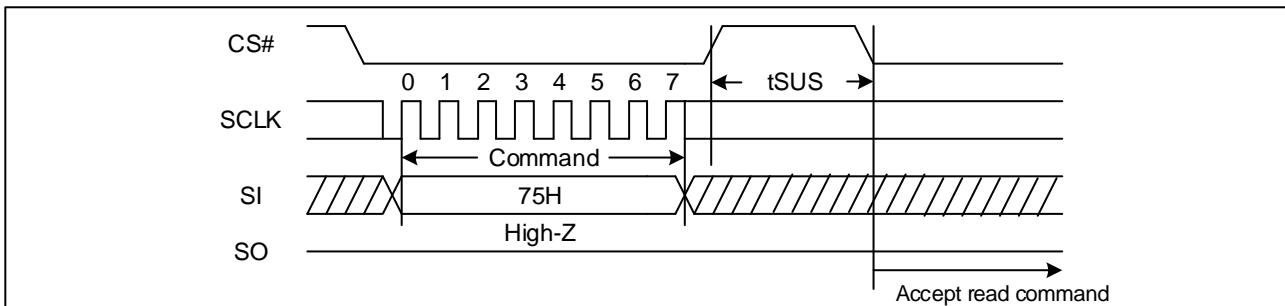




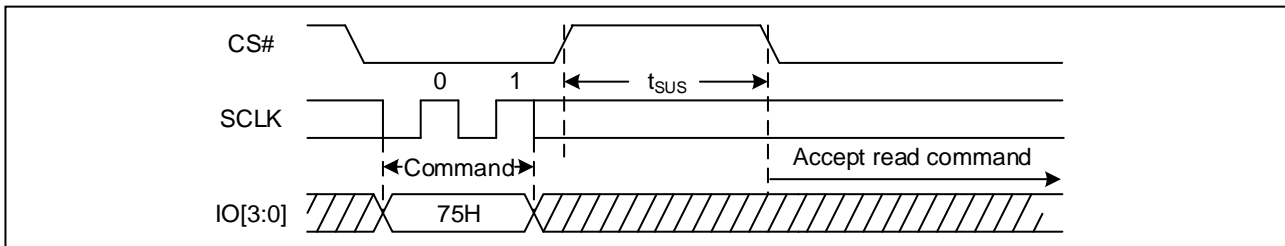
### 8.30 Program/Erase Suspend (PES) (75H)

The Program/Erase Suspend command “75H”, allows the system to interrupt a page program or sector/block erase operation and then read data from any other sector or block. The Write Register command (01H, B1H) and Erase/Program Security Registers command (44H, 42H) and Erase commands (20H/21H, 52H/5CH, D8H/DCH, C7H, 60H) and Page Program command (02H/12H, 32H/34H, C2H/3EH) are not allowed during Program suspend. The Write Register command (01H, B1H) and Erase Security Registers command (44H) and Erase commands (20H/21H, 52H/5CH, D8H/DCH, C7H, 60H) are not allowed during Erase suspend. Program/Erase Suspend is valid only during the page program or sector/block erase operation. A maximum of time of “tsus” (See AC Characteristics) is required to suspend the program/erase operation. The Program/Erase Suspend command will be accepted by the device only if the SUS2/SUS1 bit in the Status Register equal to 0 and WIP bit equal to 1 while a Page Program or a Sector or Block Erase operation is on-going. If the SUS2/SUS1 bit equal to 1 or WIP bit equal to 0, the Suspend command will be ignored by the device. The WIP bit will be cleared from 1 to 0 within “tsus” and the SUS2/SUS1 bit will be set from 0 to 1 immediately after Program/Erase Suspend. A power-off during the suspend period will reset the device and release the suspend state.

**Figure 63 Program/Erase Suspend Sequence Diagram (SPI)**



**Figure 64 Program/Erase Suspend Sequence Diagram (QPI)**

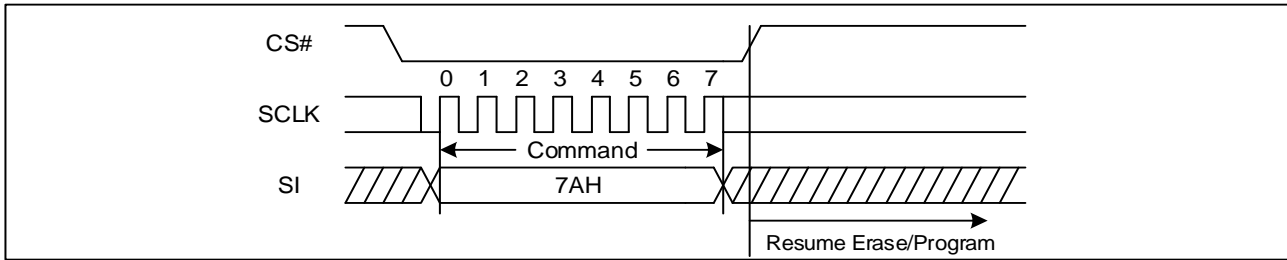


### 8.31 Program/Erase Resume (PER) (7AH)

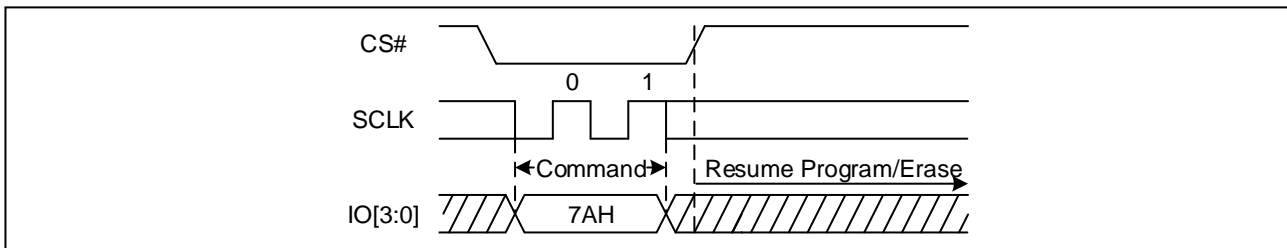
The Program/Erase Resume command must be written to resume the program or sector/block erase operation after a Program/Erase Suspend command. The Program/Erase Resume command will be accepted by the device only if the SUS2/SUS1 bit equal to 1 and the WIP bit equal to 0. After issued the SUS2/SUS1 bit in the status register will be cleared from 1 to 0 immediately, the WIP bit will be set from 0 to 1 within 200ns and the Sector or Block will complete the erase operation or the page will complete the program operation. The Program/Erase Resume command will be ignored unless a Program/Erase Suspend is active.



**Figure 65 Program/Erase Resume Sequence Diagram**



**Figure 66 Program/Erase Resume Sequence Diagram (QPI)**



### 8.32 Erase Security Registers (44H)

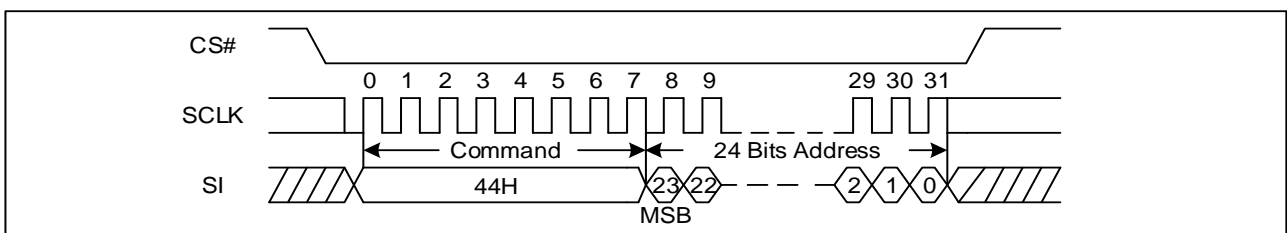
The GD25R512ME provides 4K-Byte Security Registers which can be erased and programmed individually. These registers may be used by the system manufacturers to store security and other important information separately from the main memory array.

The Erase Security Registers command is similar to Sector/Block Erase command. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit.

The Erase Security Registers command sequence: CS# goes low → sending Erase Security Registers command → CS# goes high. CS# must be driven high after the eighth bit of the last address Byte has been latched in; otherwise the Erase Security Registers command is not executed. As soon as CS# is driven high, the self-timed Erase Security Registers cycle (whose duration is  $t_{SE}$ ) is initiated. While the Erase Security Registers cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Erase Security Registers cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. The Security Registers Lock Bit in the Status Register can be used to OTP protect the security registers. Once the bit is set to 1, the Security Registers will be permanently locked; the Erase Security Registers command will be ignored.

| Address           | A23-16 | A15-12  | A11-0      |
|-------------------|--------|---------|------------|
| Security Register | 00H    | 0 0 0 0 | Don't care |

**Figure 67 Erase Security Registers command Sequence Diagram (SPI)**

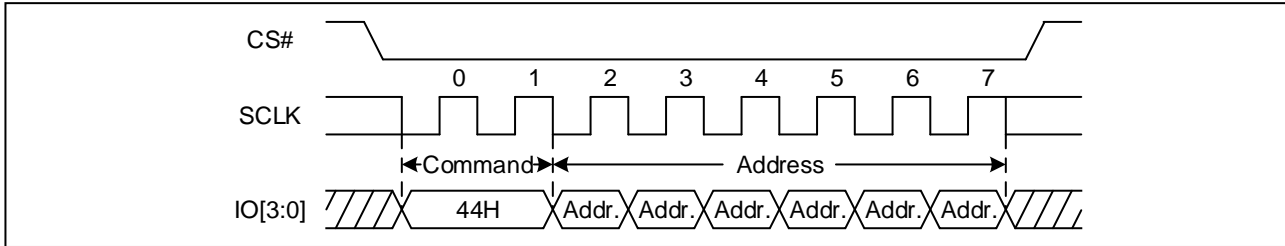


Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.





**Figure 68 Erase Security Registers command Sequence Diagram (QPI)**



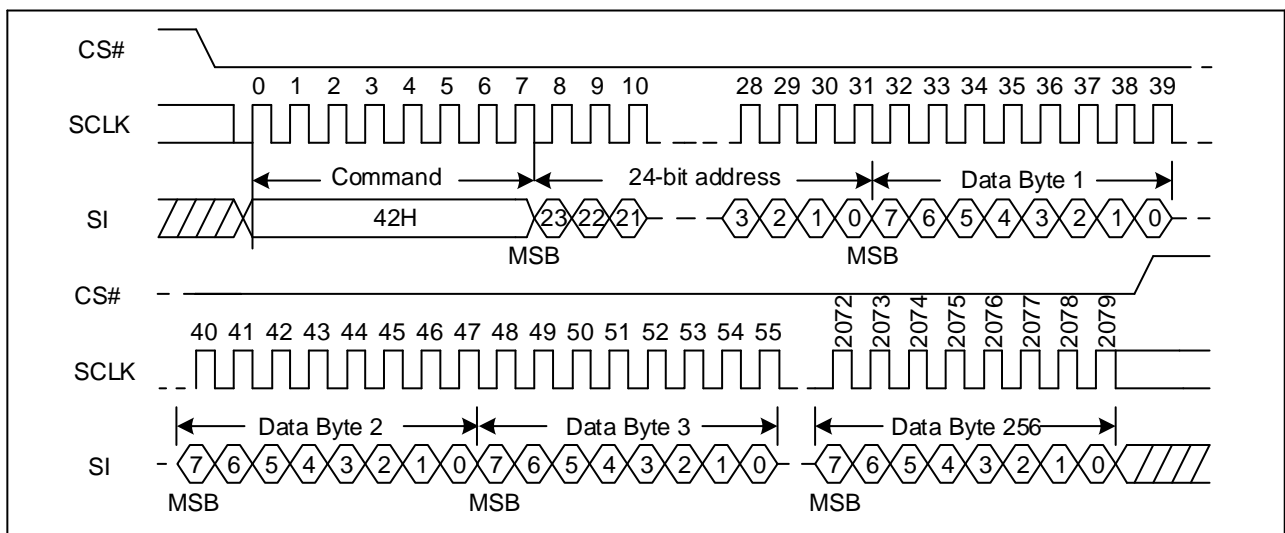
Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

### 8.33 Program Security Registers (42H)

The Program Security Registers command is similar to the Page Program command. The security register contains 16 pages content. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Program Security Registers command. The Program Security Registers command is entered by driving CS# Low, followed by the command code (42H), three address Bytes and at least one data Byte on SI. As soon as CS# is driven high, the self-timed Program Security Registers cycle (whose duration is tPP) is initiated. While the Program Security Registers cycle is in progress, the Status Register may be read to check the value of the Write in Progress (WIP) bit. The Write in Progress (WIP) bit is 1 during the self-timed Program Security Registers cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. If the Security Registers Lock Bit is set to 1, the Security Registers will be permanently locked. Program Security Registers command will be ignored.

| Address           | A23-16 | A15-12  | A11-8        | A7-0         |
|-------------------|--------|---------|--------------|--------------|
| Security Register | 00H    | 0 0 0 0 | Page Address | Byte Address |

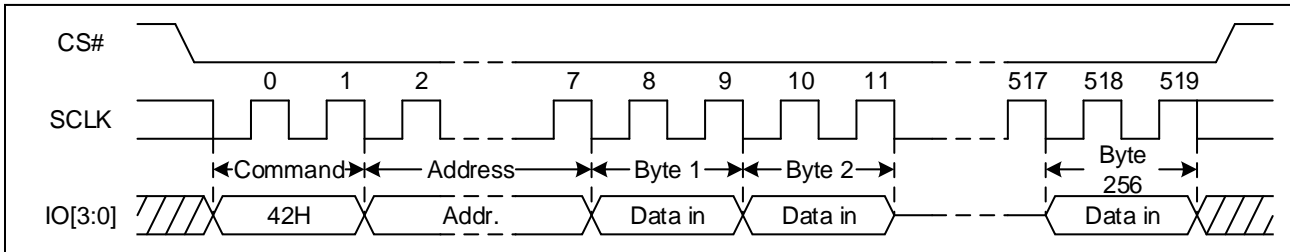
**Figure 69 Program Security Registers command Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.



Figure 70 Program Security Registers command Sequence Diagram (QPI)



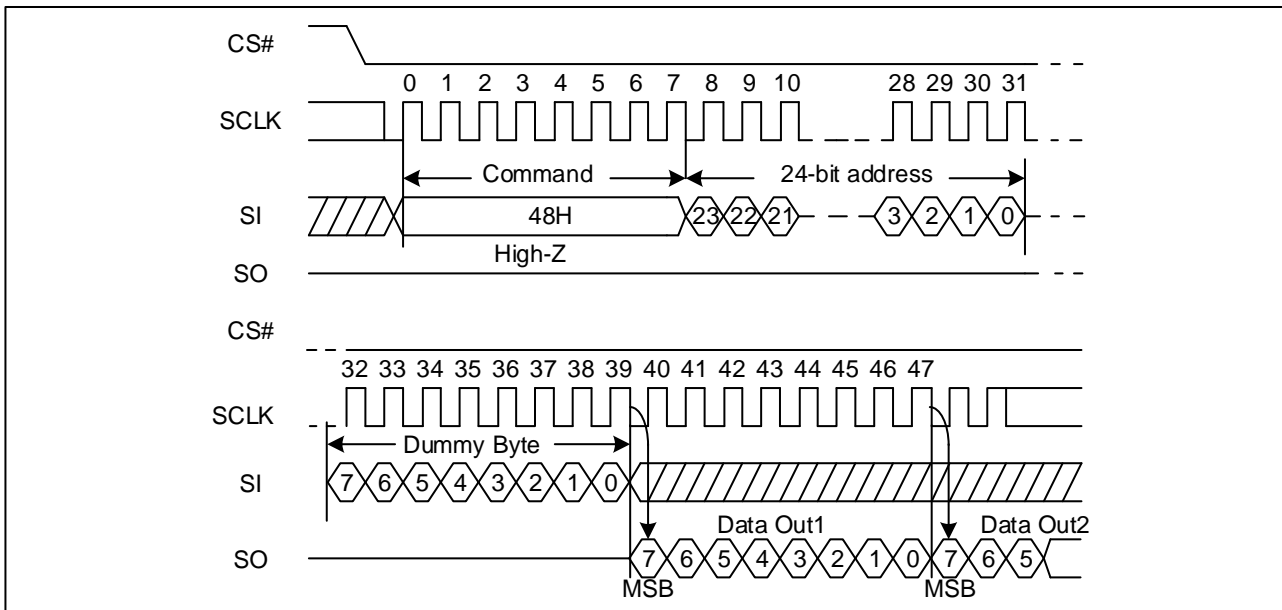
Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

### 8.34 Read Security Registers (48H)

The Read Security Registers command is similar to Fast Read command. The command is followed by a 3-Byte or 4-Byte address (A23-A0 or A31-A0) and a dummy Byte, and each bit is latched-in on the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, and each bit is shifted out, at a Max frequency  $f_c$ , on the falling edge of SCLK. The first Byte addressed can be at any location. The address is automatically incremented to the next higher address after each Byte of data is shifted out. Once the A11-A0 address reaches the last Byte of the register (Byte FFFH), it will reset to 000H, the command is completed by driving CS# high.

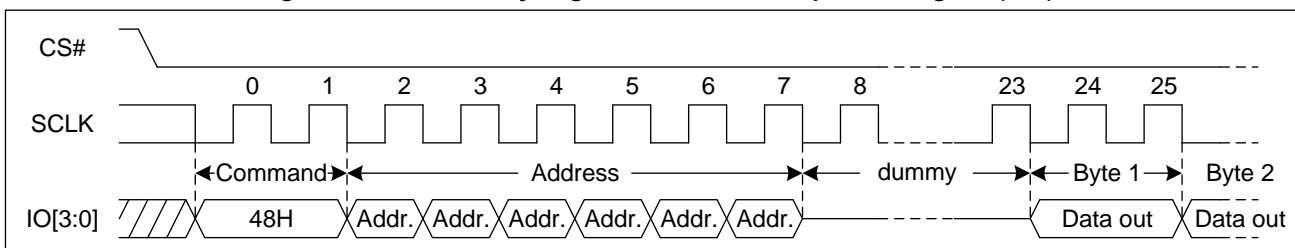
| Address           | A23-16 | A15-12 | A11-8        | A7-0         |
|-------------------|--------|--------|--------------|--------------|
| Security Register | 00H    | 0 0 0  | Page Address | Byte Address |

Figure 71 Read Security Registers command Sequence Diagram (SPI)



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

Figure 72 Read Security Registers command Sequence Diagram (QPI)



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.



### 8.35 Individual Block/Sector Lock (36H)/Unlock (39H)/Read (3DH)

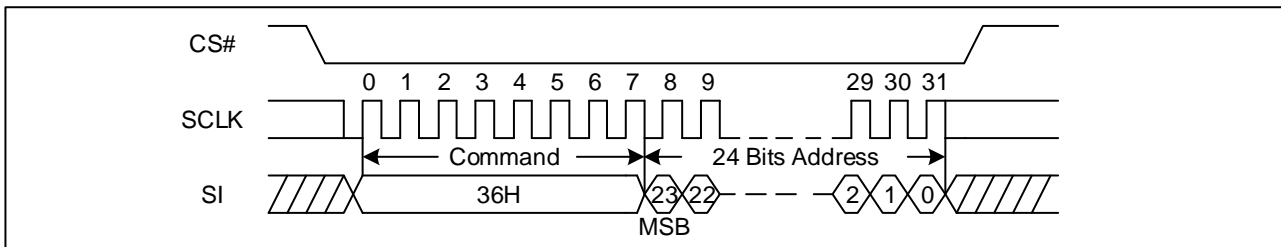
The individual block/sector lock provides an alternative way to protect the memory array from adverse Erase/Program. In order to use the Individual Block/Sector Locks, the WPS bit in Configuration Register bit 2 at address 04h must be set to 0. If WPS=1, the write protection will be determined by the combination of BP (4:0) bits in the Status Register.

The individual Block/Sector Lock command (36H) sequence: CS# goes low → SI: Sending individual Block/Sector Lock command → SI: Sending 3-Byte or 4-Byte individual Block/Sector Lock Address → CS# goes high.

The individual Block/Sector Unlock command (39H) sequence: CS# goes low → SI: Sending individual Block/Sector Unlock command → SI: Sending 3-Byte or 4-Byte individual Block/Sector Lock Address → CS# goes high.

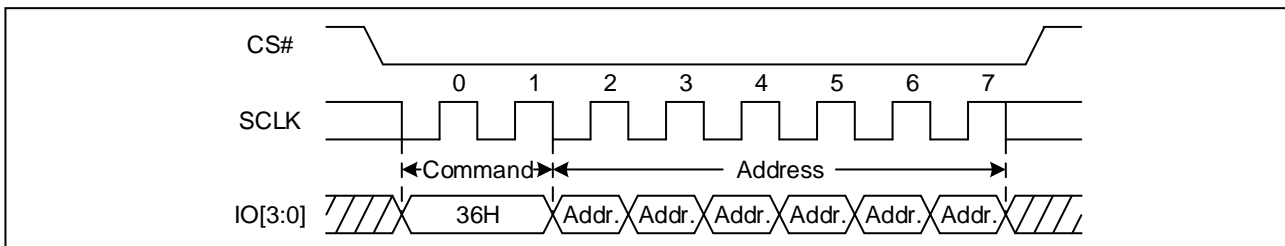
The Read individual Block/Sector lock command (3DH) sequence: CS# goes low → SI: Sending Read individual Block/Sector Lock command → SI: Sending 3-Byte or 4-Byte individual Block/Sector Lock Address → SO: The Block/Sector Lock Bit will out → CS# goes high. If the least significant bit (LSB) is 1, the corresponding block/sector is locked, if the LSB is 0, the corresponding block/sector is unlocked, Erase/Program operation can be performed.

**Figure 73 Individual Block/Sector Lock command Sequence Diagram (SPI)**



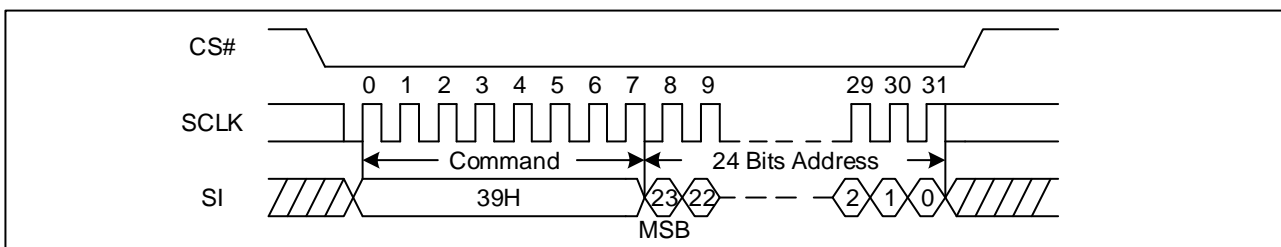
Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

**Figure 74 Individual Block/Sector Lock command Sequence Diagram (QPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

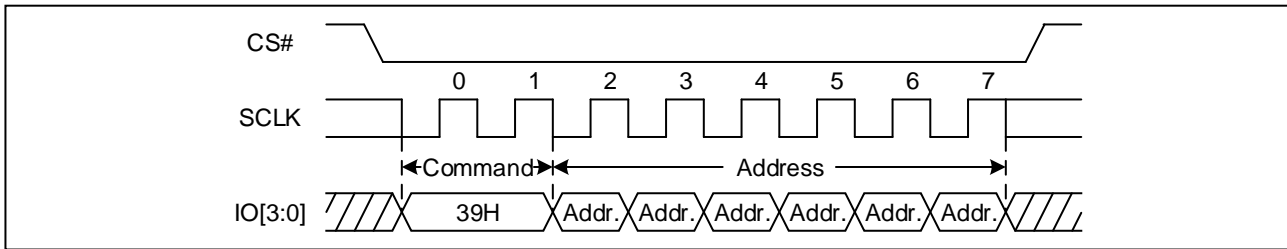
**Figure 75 Individual Block/Sector Unlock command Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

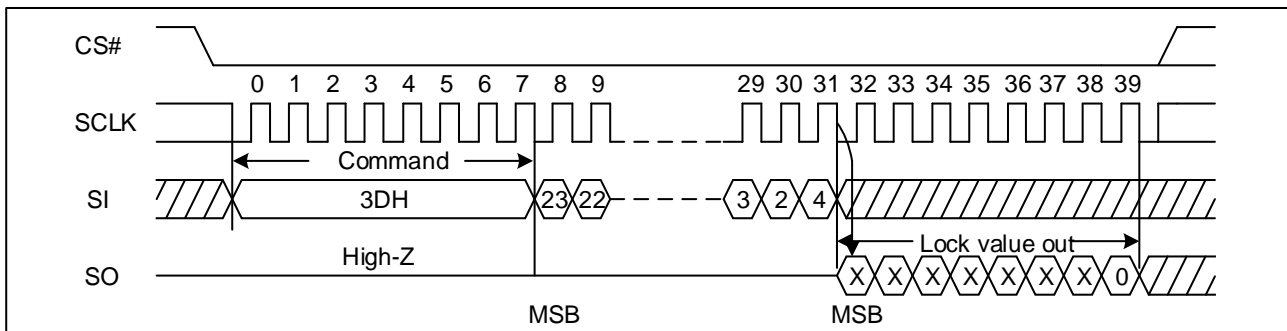


**Figure 76 Individual Block/Sector Unlock command Sequence Diagram (QPI)**



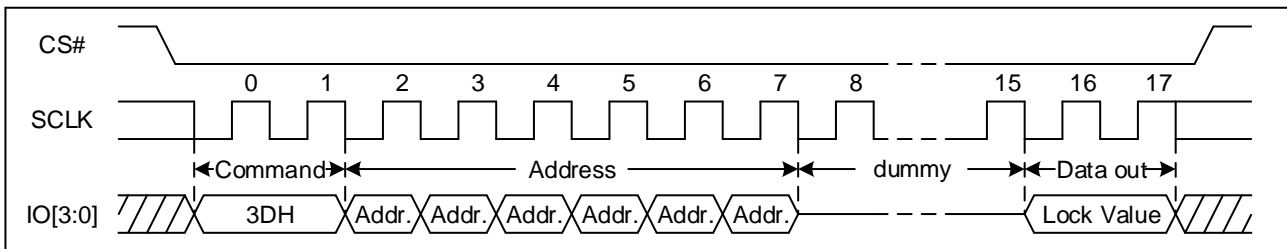
Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

**Figure 77 Read Individual Block/Sector lock command Sequence Diagram (SPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

**Figure 78 Read Individual Block/Sector lock command Sequence Diagram (QPI)**



Note: The device default is in 24-bit address mode. For 4-Byte mode, the address length becomes 32-bit.

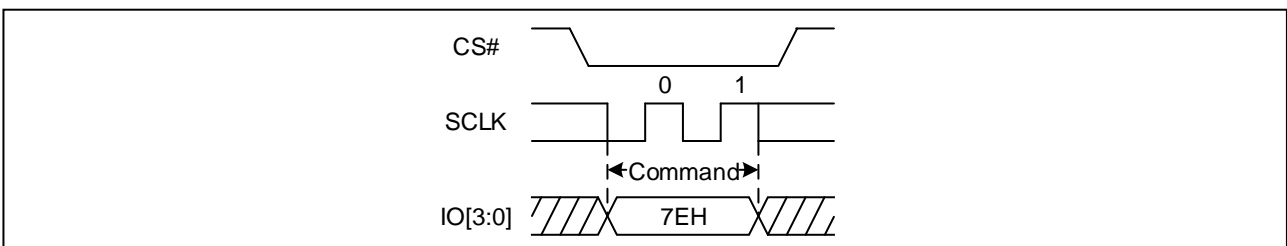
### 8.36 Global Block/Sector Lock (7EH) or Unlock (98H)

All Block/Sector Lock bits can be set to 1 by the Global Block/Sector Lock command, or can set to 0 by the Global Block/Sector Unlock command.

The Global Block/Sector Lock command (7EH) sequence: CS# goes low →SI: Sending Global Block/Sector Lock command→ CS# goes high.

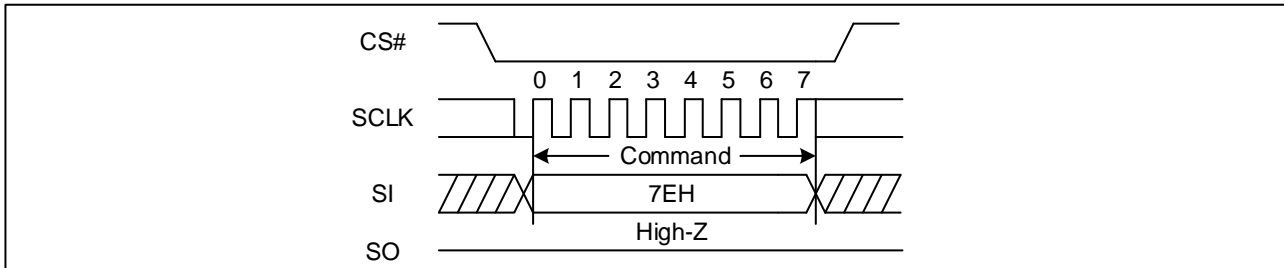
The Global Block/Sector Unlock command (98H) sequence: CS# goes low →SI: Sending Global Block/Sector Unlock command→ CS# goes high.

**Figure 79 Global Block/Sector Lock Sequence Diagram (SPI)**

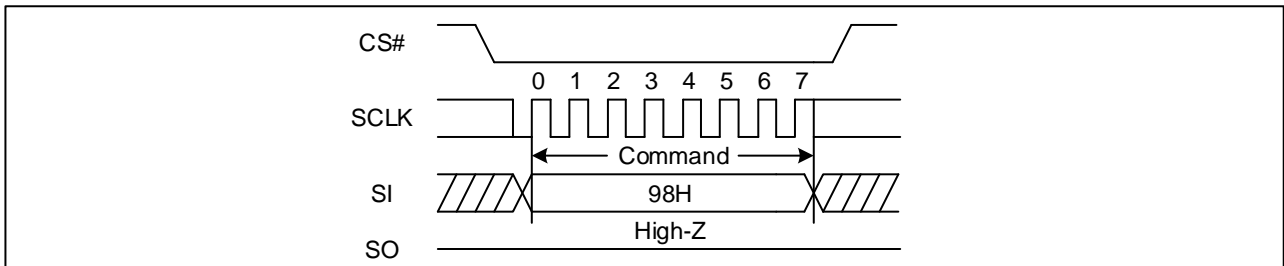




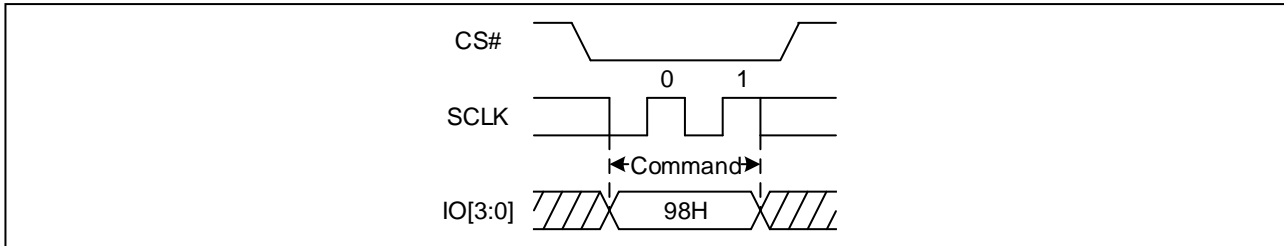
**Figure 80 Global Block/Sector Lock Sequence Diagram (QPI)**



**Figure 81 Global Block/Sector Unlock Sequence Diagram (SPI)**



**Figure 82 Global Block/Sector Unlock Sequence Diagram (QPI)**



### 8.37 Enable Reset (66H) and Reset (99H)

If the Reset command is accepted, any on-going internal operation (except in Continuous Read Mode) will be terminated and the device will return to its default power-on state and lose all the current volatile settings, such as Volatile Status Register bits, Write Enable Latch status (WEL), Program/Erase Suspend status, Read Parameter setting (P7-P0), Deep Power Down Mode, Continuous Read Mode bit setting (M7-M0).

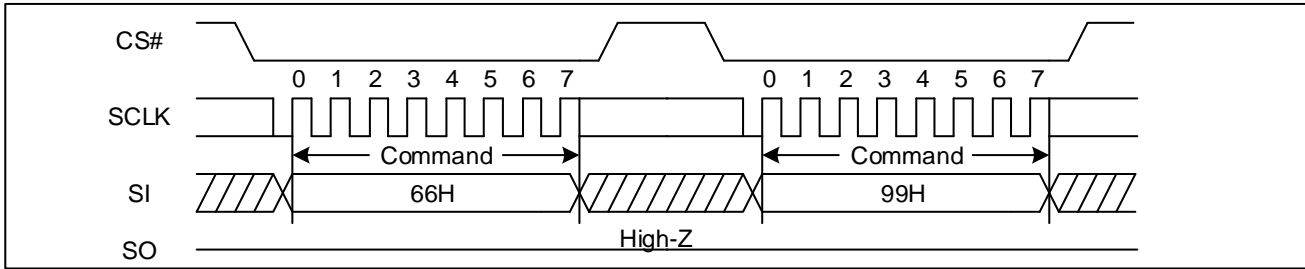
When Flash is in QPI Mode or Continuous Read Mode (XIP), 66H&99H cannot reset Flash to power-on state. Therefore, it is recommended to send the following sequence to reset Flash in these modes:

1. 8CLK with IO<3:0>= all "H" or all "L": ensure Flash quit XIP mode
2. QPI format 66H/99H: ensure Flash in QPI mode can be reset
3. SPI format 66H/99H: ensure Flash in SPI mode can be reset

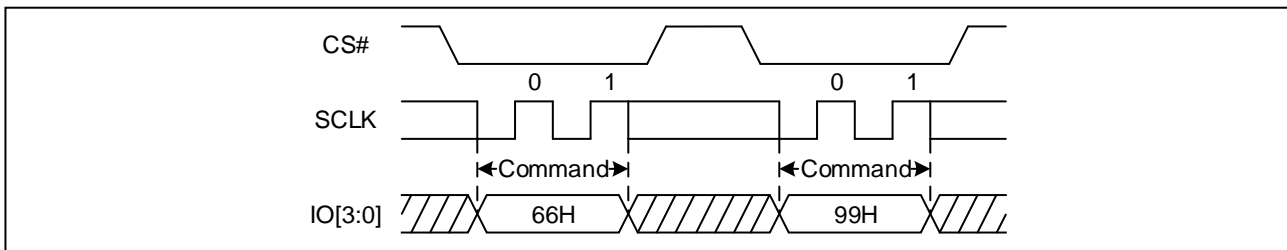
The "Enable Reset (66H)" and the "Reset (99H)" commands can be issued in either SPI or QPI mode. The "Reset (99H)" command sequence as follow: CS# goes low → Sending Enable Reset command → CS# goes high → CS# goes low → Sending Reset command → CS# goes high. Once the Reset command is accepted by the device, the device will take approximately tRST / tRST\_E to reset. During this period, no command will be accepted. Data corruption may happen if there is an on-going or suspended internal Erase or Program operation when Reset command sequence is accepted by the device. It is recommended to check the WIP bit and the SUS2/SUS1 bits in Status Register before issuing the Reset command sequence.



**Figure 83 Enable Reset and Reset command Sequence Diagram (SPI)**



**Figure 84 Enable Reset and Reset command Sequence Diagram (QPI)**



### 8.38 Read Serial Flash Discoverable Parameter (5AH)

The Serial Flash Discoverable Parameter (SFDP) standard provides a consistent method of describing the functional and feature capabilities of serial flash devices in a standard set of internal parameter tables. These parameter tables can be interrogated by host system software to enable adjustments needed to accommodate divergent features from multiple vendors. The concept is similar to the one found in the Introduction of JEDEC Standard, JESD68 on CFI. SFDP is a standard of JEDEC Standard No.216B.

**Figure 85 Read Serial Flash Discoverable Parameter command Sequence Diagram (SPI)**

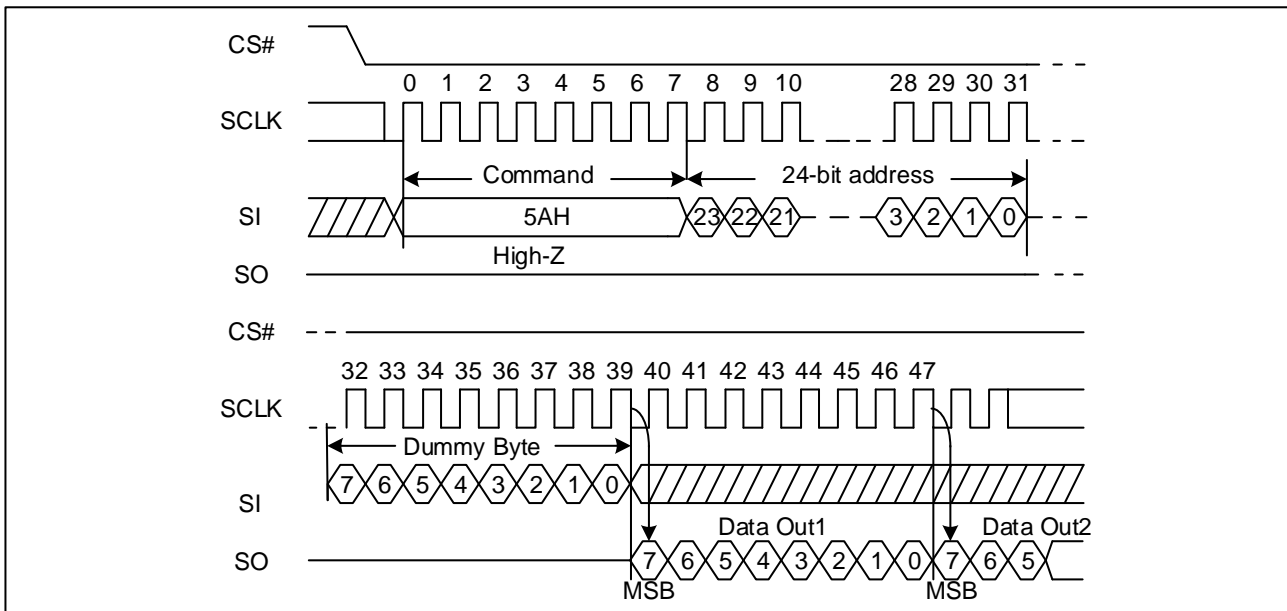




Figure 86 Read Serial Flash Discoverable Parameter command Sequence Diagram (QPI)

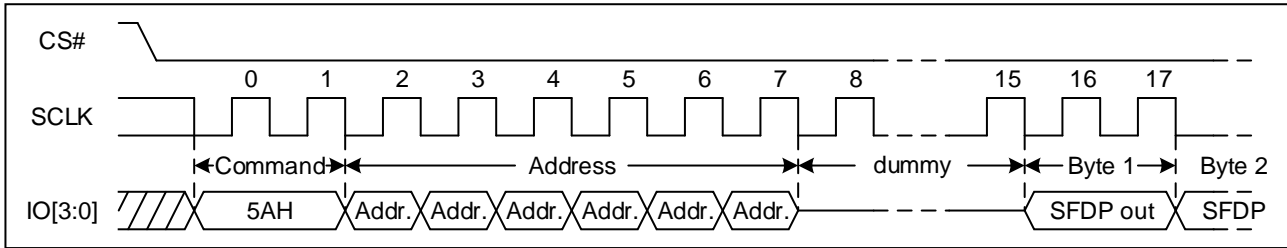


Table 14 Signature and Parameter Identification Data Values (Please contact GigaDevice for details)



## 9 RPMC COMMANDS DESCRIPTION

**Table 15. Replay Protected Monotonic Counter (RPMC) Commands**

| Function                                | Opcode<br>Phase 8<br>bits | Payload Phase Max 512 Bits   |   | Comment   |
|---|---------------------------|------------------------------|---|---|
|   |                           | Byte#                        | Field Description   |   |
| Command: Write<br>Root Key Register     | OP1                       | 1<br>2<br>3<br>4-35<br>36-63 | CmdType[7:0] = 00H<br>CounterAddr[7:0] = 8 Bits<br>Reserved[7:0] = 8 Bits<br>RootKey[255:0] = 256 Bits<br>TruncatedSign[223:0] = 224 Bits | OP1 + Payload phase driven by host controller. Root Key Register is written only once.  |
| Command: Update<br>HMAC Key Register    | OP1                       | 1<br>2<br>3<br>4-7<br>8-39   | CmdType[7:0]= 01H<br>CounterAddr[7:0]= 8 Bits<br>Reserved[7:0] = 8 Bits<br>KeyData[31:0] = 32 Bits,<br>Signature[255:0] = 256 Bits        | OP1 + Payload phase is Issued by host controller on every power up to initialize HMAC Key Register.   |
| Command: Increment<br>Monotonic Counter | OP1                       | 1<br>2<br>3<br>4-7<br>8-39   | CmdType[7:0] = 02H<br>CounterAddr[7:0] = 8 Bits<br>Reserved[7:0] = 8 Bits<br>CounterData[31:0] = 32 Bits,<br>Signature[255:0] = 256 Bits  | OP1 + Payload Phase is Issued by host controller during runtime to increment the counter.   |
| Command: Request<br>Monotonic Counter   | OP1                       | 1<br>2<br>3<br>4-15<br>16-47 | CmdType[7:0] = 03H<br>CounterAddr[7:0] = 8 Bits<br>Reserved[7:0] = 8 Bits Tag<br>[95:0] = 96 Bits<br>Signature[255:0] = 256 Bits          | OP1 + Payload Phase is Issued by host controller during runtime to request counter data   |
| Command: Read<br>Data                   | OP2                       | 2<br>3-14<br>15-18<br>19-50  | ExtendedStatus[7:0] = 8 Bits<br>Tag[95:0] = 96 Bits<br>CounterData[31:0] = 32 Bits<br>Signature[255:0] = 256 Bits                         | OP2 is issued by Host Controller generally after an OP1. SPI Flash device responds with the Payload phase to return Extended Status and counter data. |

All individual fields are Byte wide fields. For a multi-byte field, Most Significant Byte is issued first; Least Significant Byte is issued last. Within a Byte, Most Significant Bit is issued first; Least Significant Bit is issued last. CmdType is always the first byte issued after OP1 commands. OP2 delay is the same as Fast Read Command delay which is 8 dummy bits.

**Table 16. OP1 and OP2 are defined for 1-1-1 mode.**

| Byte #      | 0   | 1                 | 2                       | 3                             | 4 | 5 | 6 | ... | .. | .. |
|-------------|-----|-------------------|-------------------------|-------------------------------|---|---|---|-----|----|----|
| <b>Name</b> | OP1 | CmdType           | Counter<br>Address      | As defined in the table above |   |   |   |     |    |    |
| <b>Name</b> | OP2 | 8 Dummy<br>clocks | Extended<br>Status[7:0] | As defined in the table above |   |   |   |     |    |    |

After an OP1 command is received, the SPI Flash will indicate status busy indication using either the status register or extended status register as defined below.





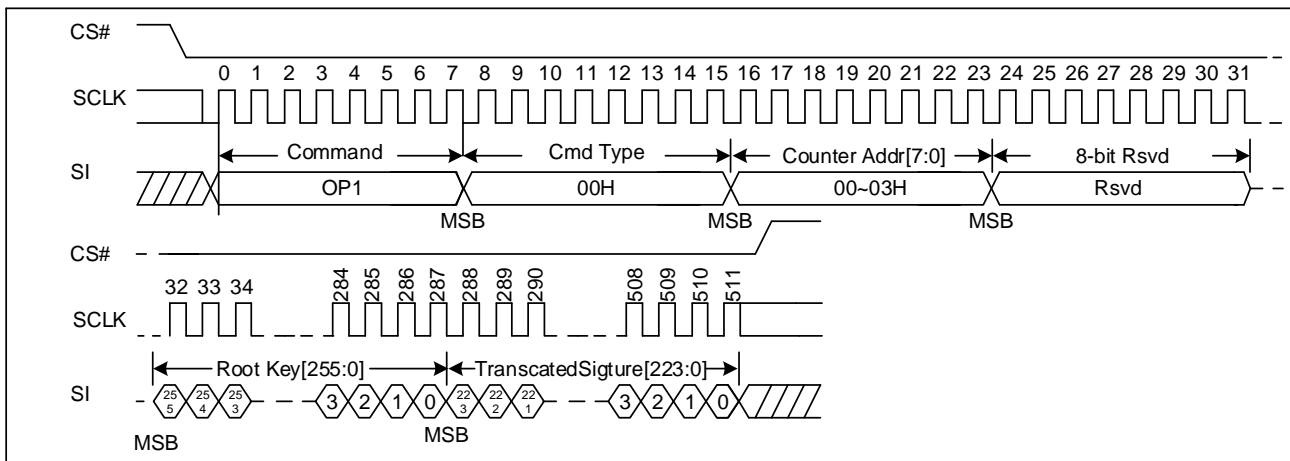
**Table 17. Extended Status Register Definition**

| Extended Status[7:0] | Applicable CmdType(s) | Description   |
|----------------------|-----------------------|---|
| 00000000             | -                     | Power On State (OP2 issued directly after power-up).  |
| 10000000             | 00,01,02,03           | This status is set on successful completion (no errors) of OP1 command.   |
| 0xxxxx1              | 00,01,02,03,04-0FF    | This bit is set to 1, when device is busy executing OP1 command. It is reset to 0 when OP1 command execution is done.   |
| 0xxxxx1x             | 00,01                 | This bit is set only when the correct payload size is received. When cmdtype = 0, this error bit must be set on Root Key Register Overwrite or Counter Address out of range or Truncated Signature mis-match error.<br>For cmdtype = 01 this bit is set when the corresponding monotonic counter is uninitialized |
| 0xxxx1xx             | 00,01,02,03           | This bit is set on Signature Mismatch, Counter Address out of range when correct payload size is received; or Cmdtype is out of range; or incorrect payload size is received.   |
| 0xxx1xxx             | 02,03                 | This bit is set on HMAC Key Register or monotonic counter uninitialized on previous OP1 command when correct payload size is received   |
| 0xx1xxxx             | 02                    | This bit is set on Counter Data Mismatch on previous increment when correct payload size is received  |
| 0x1xxxxx             | -                     | Fatal Error. It is set when no valid counter is found after initialization.   |
| Current value        |                       | Extended status register will not be updated until first 8 bits of OP1 is received. The correct error type is reflected for any OP1 operation that exceeds a minimum of 16 clocks with active chip-select.  |

## 9.1 Command: Write Root Key Register

This command is used to initialize the Root Key Register corresponding to the received Counter Address with the received Root Key. It is suggested to be used in an OEM manufacturing environment when the SPI Flash Controller and SPI Flash are powered together for the first time.

**Figure 87. Write Root Key Register Sequence Diagram**



Truncated signature field is the same as least significant 224 bits of HMAC-SHA-256 based signature computed based on



received input parameters:

- HMAC message[31:0] = (OpCode[7:0], CmdType[7:0], CounterAddr[7:0], Reserved[7:0])
- HMAC Key[255:0] = Root\_Key[255:0]

If Root Key != 256'HFF..FF then this command can be executed one time. If the received transaction is error free SPI Flash device successfully executes the command and posts "successful completion" extended status.

Root Key Register Write with root key is = 256'HFF...FF can be used as a temporary key.

If the received transaction has errors the SPI Flash does not execute the transaction and posts the corresponding error in extended status.

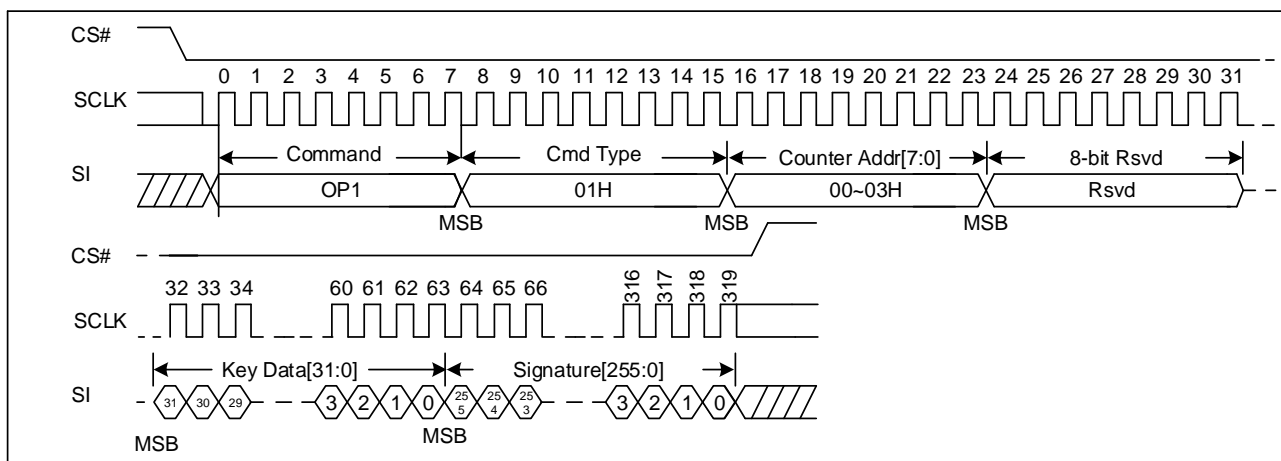
**Table 18. Expected Extended Status [7:0] results**

| Extended Status[7:0] | Applicable CmdType(s) | Description  |
|----------------------|-----------------------|--|
| 10000000             | 00                    | Successful completion  |
| 0xxxxx1              | 00                    | If Busy_Polling_Method bit in SFDP table is zero, then this bit must be set to 1, when device is busy executing command. It is reset to 0 when OP1 command execution is done. If Busy_Polling_Method bit in SFDP table is one, then this bit is ignored by the controller. |
| 0xxxx1x              | 00                    | This bit is only set when correct payload size is received. It is set on Root Key Register Overwrite or Counter Address is out of range or when there is a truncated signature mismatch error  |
| 0xxxx1xx             | 00                    | This bit is set when incorrect payload size is received.   |

## 9.2 Command: Update HMAC Key Register

This command is used by the SPI Flash Controller to update the HMAC-Key register corresponding to the received Counter Address with a new HMAC key calculated based on received input. This command must be issued on every power cycle event on the interface. The HMAC key storage is volatile.

**Figure 88. Update HMAC Key Register Sequence Diagram**



Signature matches the HMAC-SHA-256 based signature computed based on received input parameters. This command performs two HMAC-SHA-256 operations.

- HMAC-SHA-256 Operation 1 Output = HMAC\_Storage[255:0]
  - HMAC Message[31:0] = KeyData[31:0]
  - HMAC Key[255:0] = Root\_Key\_Register[CounterAddr][255:0]



- HMAC-SHA-256 Operation 2 Output = HMAC-SHA-256 based signature[255:0]
  - HMAC message[63:0] = (OpCode[7:0], CmdType[7:0].CounterAddr[7:0].Reserved[7:0], KeyData[31:0])
  - HMAC Key[255:0] = HMAC\_Storage[255:0]

If the received transaction is error free SPI Flash device successfully executes the command and posts “successful completion” extended status.

If the received transaction has errors the SPI Flash does not execute the transaction and posts the corresponding error in extended status.

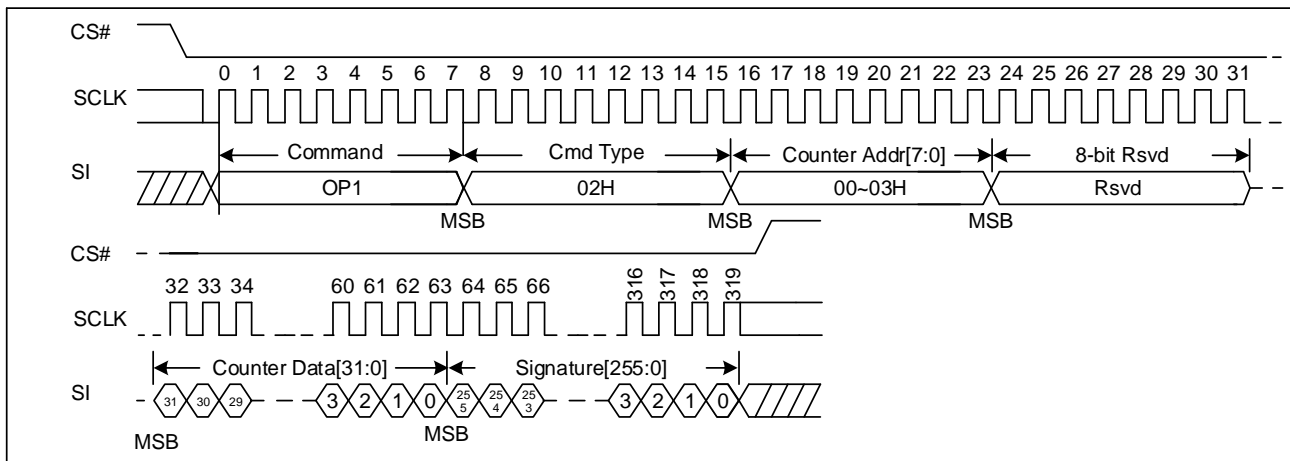
**Table 19. Expected Extended Status [7:0] results**

| Extended Status[7:0] | Applicable CmdType(s) | Description   |
|----------------------|-----------------------|---|
| 10000000             | 01                    | This status is set on successful completion (no errors) of OP1 command.   |
| 0xxxxxx1             | 01                    | This bit is set to 1, when device is busy executing OP1 command. It is reset to 0 when OP1 command execution is done.                             |
| 0xxxxx1x             | 01                    | This bit is set only when the correct payload size is received. This bit is set when the corresponding monotonic counter is uninitialized         |
| 0xxxx1xx             | 01                    | This bit is set on Signature Mismatch, Counter Address out of range when correct payload size is received; or incorrect payload size is received. |

### 9.3 Command: Increment Monotonic Counter

This command is used by the SPI Flash Controller to increment the Monotonic counter by 1 inside the SPI Flash Device.

**Figure 89. Increment Monotonic Counter Sequence Diagram**



The requested Signature matches the HMAC-SHA-256 based signature computed based on received input parameters.

The received Counter Data matches the current value of the counter read from the SPI Flash.

- HMAC Message[63:0] = (OpCode[7:0], CmdType[7:0]. CounterAddr[7:0]. Reserved[7:0], CounterData[31:0])
- HMAC Key[255:0] = HMAC\_Key\_Register [Counter\_Address][255:0]

If the received transaction is error free SPI Flash device successfully executes the command and posts “successful completion” extended status. If the received transaction has errors the SPI Flash does not execute the transaction and posts the corresponding error in extended status.



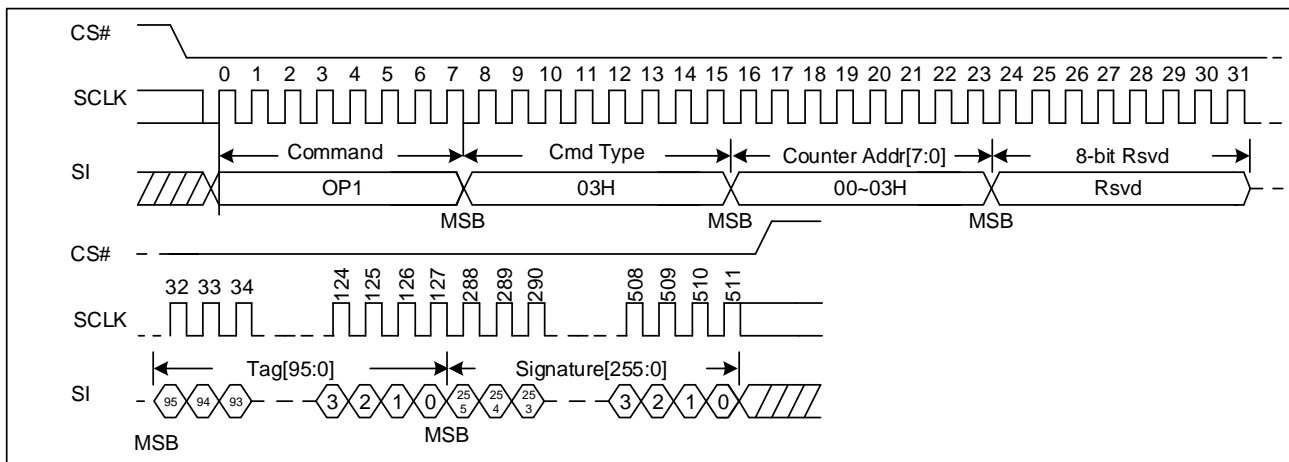
**Table 20. Expected Extended Status [7:0] results**

| Extended Status[7:0] | Applicable CmdType(s) | Description  |
|----------------------|-----------------------|--|
| 10000000             | 02                    | This status is set on successful completion (no errors) of OP1 command.  |
| 0xxxxxx1             | 02                    | This bit is set to 1, when device is busy executing OP1 command. It is reset to 0 when OP1 command execution is done.  |
| 0xxxx1xx             | 02                    | This bit is set on Signature Mismatch, Counter Address out of range when correct payload size is received; or incorrect payload size is received.  |
| 0xxx1xxx             | 02                    | This bit is set only when the correct payload size is received. This bit must be set on HMAC Key Register or Monotonic Counter is uninitialized on previous OP1 command.                         |
| 0xx1xxxx             | 02                    | This bit is set only when the correct payload size is received. The bit must be set when the received counter data filed does not match the actual counter value read from the SPI Flash device. |

## 9.4 Command: Request Monotonic Counter

This command is used by the SPI Flash Controller to request the Monotonic counter value inside the SPI Flash Device.

**Figure 90. Request Monotonic Counter Sequence Diagram**



The requested Signature matches the HMAC-SHA-256 based signature computed based on received input parameters.

- HMAC Message[127:0] = (OpCode[7:0], CmdType[7:0], CounterAddr[7:0], Reserved[7:0], Tag[95:0])
- HMAC Key[255:0] = HMAC\_Key\_Register[Counter\_Address][255:0]

If the received transaction is error free SPI Flash device successfully executes the command and posts “successful completion” extended status. If the received transaction has errors the SPI Flash does not execute the transaction and posts the corresponding error in extended status.



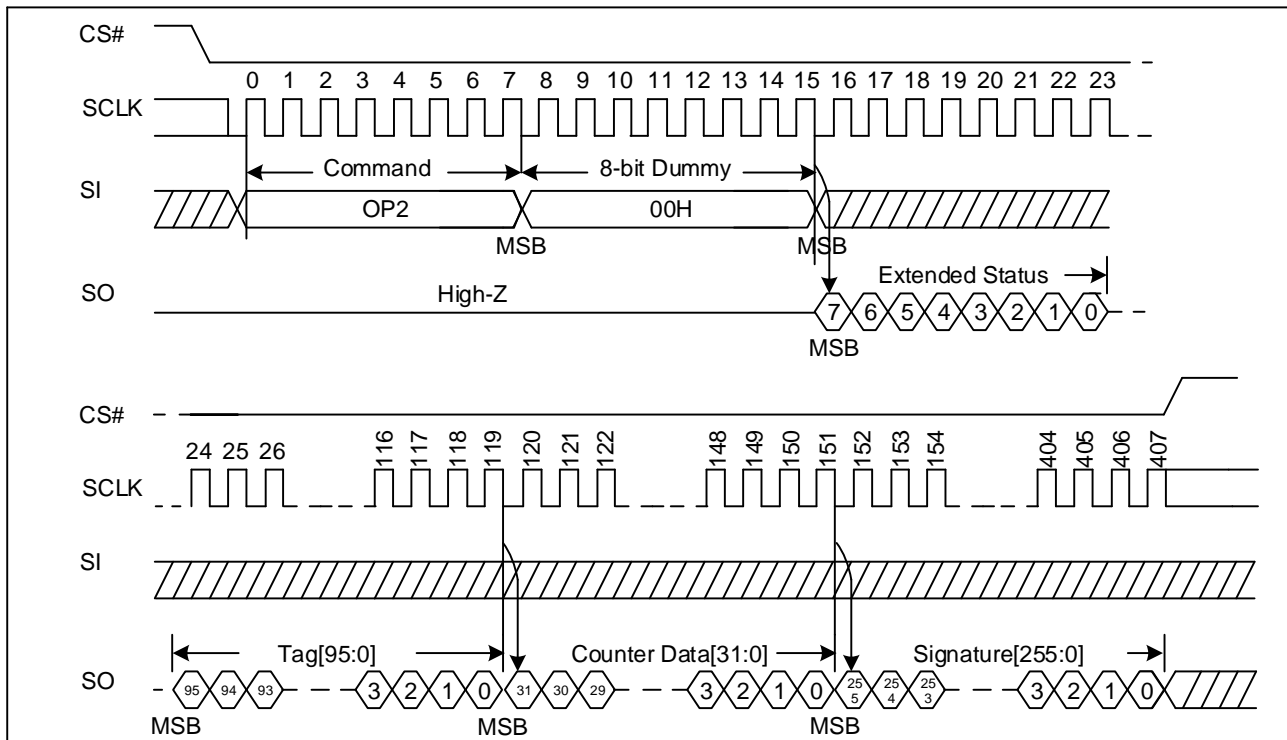
**Table 21. Expected Extended Status [7:0] results**

| Extended Status[7:0] | Applicable CmdType(s) | Description   |
|----------------------|-----------------------|---|
| 10000000             | 03                    | This status is set on successful completion (no errors) of OP1 command.   |
| 0xxxxxx1             | 03                    | This bit is set to 1, when device is busy executing OP1 command. It is reset to 0 when OP1 command execution is done.   |
| 0xxxx1xx             | 03                    | This bit is set on Signature Mismatch, Counter Address out of range when correct payload size is received; or Cmdtype is out of range; or incorrect payload size is received. |
| 0xxx1xxx             | 03                    | This bit is set only when the correct payload size is received. This bit must be set on HMAC Key Register or Monotonic Counter is uninitialized on previous OP1 command.      |

### 9.5 Command: Read Data

This command is used by the SPI Flash Controller to read extended status from any previously issued OP1 command. In addition if previous OP1 command is Request Monotonic Counter and if SPI Flash returns successful completion extended status then it returns valid values in the Tag, Counter Data and Signature field. Otherwise the values returned in Tag, Counter and Signature field are invalid. The controller may abort the read prematurely prior to completely reading the entire payload. This may occur when the controller wants to simply read the extended status or when it observes an error being returned in the extended status field. The controller may also continue reading past the defined payload size of 49 bytes. Since this is an error condition, the SPI Flash may return any data past the defined payload size. The controller must ignore the data.

**Figure 91. Read Data Sequence Diagram**





If previous OP1 command is Request Monotonic Counter and if SPI Flash returns successful completion extended status then it returns valid values in the Tag, Counter Data and Signature field. It calculates HMAC-SHA-256 signatures based on following parameters.

- HMAC Message[127:0] = Tag [95:0], Counter\_Data\_Read[31:0]
- HMAC Key[255:0] = HMAC\_Key\_Register[Counter\_Address][255:0]

**Table 22. Extended Status Register Definition**

| Extended Status[7:0] | Applicable CmdType(s) | Description  |
|----------------------|-----------------------|--|
| 00000000             | -                     | Power On State (OP2 issued directly after power-up).   |
| 10000000             | 00, 01, 02, 03        | This status is set on successful completion (no errors) of OP1 command.  |
| 0xxxxx1              | 00, 01, 02, 03        | This bit is set to 1, when device is busy executing OP1 command. It is reset to 0 when OP1 command execution is done.  |
| 0xxxx1x              | 00, 01                | This bit is set only when the correct payload size is received. When cmdtype = 0, this error bit must be set on Root Key Register Overwrite or Counter Address out of range or Truncated Signature mis-match error.<br><br>For remaining cmdtype = 1 this bit is set when the corresponding monotonic counter is uninitialized |
| 0xxx1xx              | 01, 02, 03            | This bit is set on Signature Mismatch, Counter Address out of range when correct payload size is received; or Cmdtype is out of range; or incorrect payload size is received.  |
| 0xxx1xxx             | 02, 03                | This bit is set on HMAC Key Register or Monotonic Counter uninitialized on previous OP1 command when correct payload size is received  |
| 0xx1xxxx             | 02                    | This bit is set on Counter Data Mismatch on previous increment when correct payload size is received   |
| 0x1xxxxx             | -                     | Fatal Error. It is set when no valid counter is found after initialization.  |
| Current value        | -                     | Extended status register will not be updated until first 8 bits of OP1 is received. The correct error type is reflected for any OP1 operation that exceeds a minimum of 16 clocks with active chip-select.   |

## 9.6 Operations Allowed/Disallowed During RPMC Operation

In the deep power down state OP1, OP2 commands are ignored until the part comes out of deep power down state.

WREN state does not affect the OP1 command execution inside the SPI Flash.

Suspend operation can be used to execute high-priority reads from the flash device while a long-latency operation is underway. However, OP1 is not recommended when the flash device is in WIP or suspended state.

In the table below, OP1 state is defined as the time starting with a transaction with OP1 op-code sent to the device and ending when the device clears the extended status busy bit. During OP1 state if a suspend transaction is received, the SPI Flash will ignore the suspend command and continue with the execution of the current OP1 command as described in the table below.

P/E state is defined as the time starting with a transaction with write or erase op-code sent to the device and ending when the device clears



the status busy bit. P/E Suspended State starts when the device sets the program suspend status done bit after receiving a program suspend op-code. During P/E State and P/E Suspended State, OP1 is also allowed but not recommended

The table below shows all operation support in each state.

**Table 23. RPMC Operation**

| Operation                    | OP1 state   | P/E state  | P/E Suspended State   |
|------------------------------|---|--|---|
| Suspend                      | Ignored   | Yes-> P/E Suspended State(not chip erase or write status operation)<br>No ->remain P/E state ( chip erase or write status operation) | No  |
| Resume                       | Ignored   | No   | Yes -> P/E state  |
| All reads except Read status | Yes   | No   | Yes   |
| All writes/erases            | Yes   | No   | No  |
| OP1                          | No  | Yes but not recommended  | Yes but not recommended   |
| Write status                 | Yes   | No   | No  |
| OP2                          | Yes->OP1 busy state (when extended status busy is 1)<br>->OP1 done state (when extended status busy is 0) | Yes. Will indicate the status associated with the OP1 operation.   | Yes. Will indicate the status associated with the OP1 operation                                       |
| Read status                  | Yes. Will indicate the busy state associated with the subsequent transaction issued to the SPI Flash.     | Yes. Will indicate the busy state associated with the subsequent transaction issued to the SPI Flash.                                | Yes. Will indicate the busy state associated with the subsequent transaction issued to the SPI Flash. |



## 10 ELECTRICAL CHARACTERISTICS

### 10.1 Power-On Timing

Figure 92 Power-on Timing

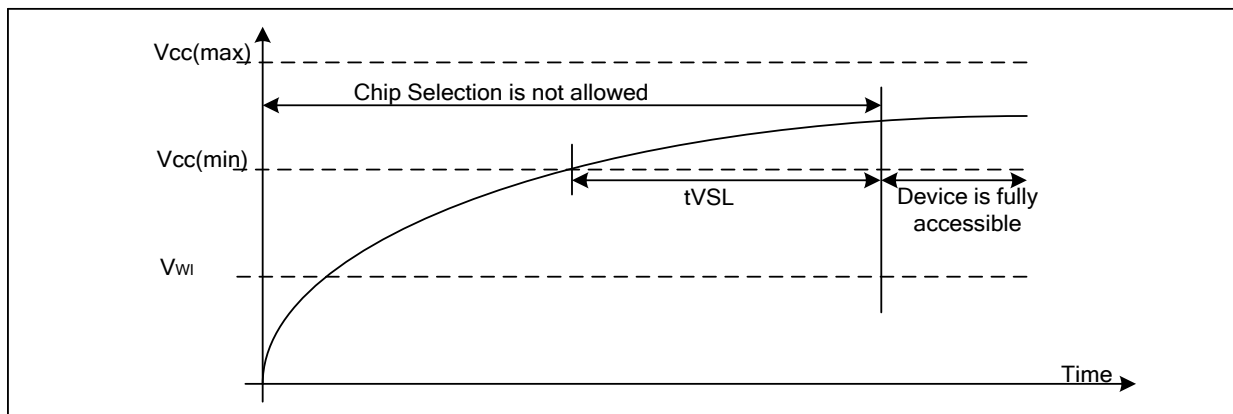


Table 24 Power-Up Timing and Write Inhibit Threshold

| Symbol | Parameter                      | Min. | Max. | Unit |
|--------|--------------------------------|------|------|------|
| tVSL   | VCC (min.) to device operation | 1.8  |      | ms   |
| VWI    | Write Inhibit Voltage          | 1.5  | 2.5  | V    |

### 10.2 Initial Delivery State

The device is delivered with the memory array erased: all bits are set to 1 (each Byte contains FFH). The Status Register contains 00H (all Status Register bits are 0).

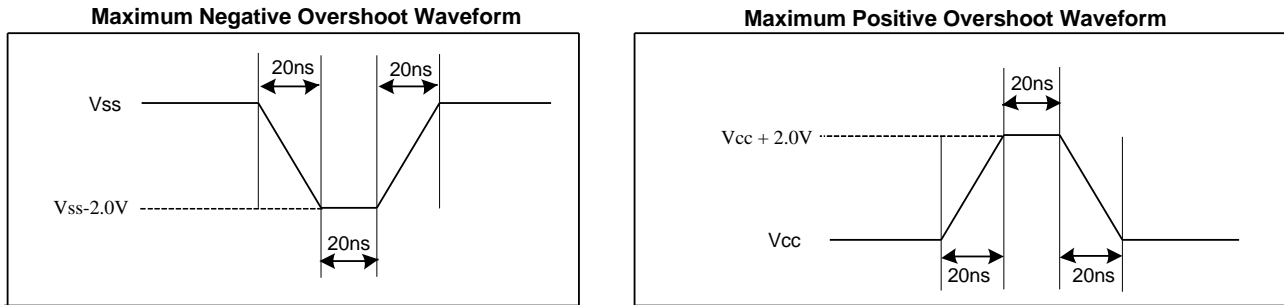
### 10.3 Absolute Maximum Ratings

| Parameter  | Value           | Unit |
|--|-----------------|------|
| Ambient Operating Temperature (T <sub>A</sub> )  | -40 to 85       | °C   |
| Storage Temperature                              | -65 to 150      | °C   |
| Transient Input/Output Voltage (note: overshoot) | -2.0 to VCC+2.0 | V    |
| Applied Input/Output Voltage                     | -0.6 to VCC+0.4 | V    |
| VCC  | -0.6 to 4.2     | V    |





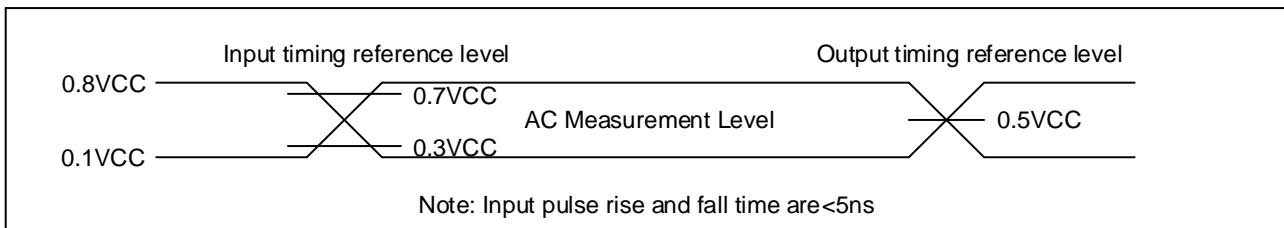
Figure 93. Input Test Waveform and Measurement Level



### 10.4 Capacitance Measurement Conditions

| Symbol   | Parameter                                      | Min              | Typ. | Max | Unit | Conditions        |
|----------|--|------------------|------|-----|------|-------------------|
| CIN/COUT | Input/Output Capacitance<br>(IO pins: IO[3:0]) |                  |      | 22  | pF   | VIN=0V<br>VOUT=0V |
| CIN      | Input Capacitance (except IO pins)             |                  |      | 18  | pF   | VIN=0V            |
| COUT     | Output Capacitance (except IO pins)            |                  |      | 18  | pF   | VOUT=0V           |
| CL       | Load Capacitance                               | 30               |      |     | pF   |                   |
|          | Input Rise And Fall time                       |                  |      | 5   | ns   |                   |
|          | Input Pulse Voltage                            | 0.1VCC to 0.8VCC |      |     | V    |                   |
|          | Input Timing Reference Voltage                 | 0.3VCC to 0.7VCC |      |     | V    |                   |
|          | Output Timing Reference Voltage                | 0.5VCC           |      |     | V    |                   |

Figure 94. Absolute Maximum Ratings Diagram





## 10.5 DC Characteristics

( $T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$ ,  $V_{CC} = 2.7 \sim 3.6\text{V}$ )

| Symbol    | Parameter                | Test Condition                                      | Min.    | Typ. | Max.    | Unit.         |
|-----------|--------------------------|---|---------|------|---------|---------------|
| $I_{LI}$  | Input Leakage Current    |   |         |      | $\pm 4$ | $\mu\text{A}$ |
| $I_{LO}$  | Output Leakage Current   |   |         |      | $\pm 4$ | $\mu\text{A}$ |
| $I_{CC1}$ | Standby Current          | CS#=VCC,<br>VIN=VCC or VSS                          |         | 17   | 70      | $\mu\text{A}$ |
| $I_{CC2}$ | Deep Power-Down Current  | CS#=VCC,<br>VIN=VCC or VSS                          |         | 3    | 35      | $\mu\text{A}$ |
| $I_{CC3}$ | Operating Current (Read) | CLK=0.1VCC / 0.9VCC<br>at 104MHz,<br>Q=Open(x4 I/O) |         | 17   | 30      | mA            |
|           |                          | CLK=0.1VCC / 0.9VCC<br>at 60MHz,<br>Q=Open(x4 I/O)  |         | 13   | 25      | mA            |
| $I_{CC4}$ | Operating Current (PP)   | CS#=VCC   |         | 15   | 30      | mA            |
| $I_{CC5}$ | Operating Current (WRSR) | CS#=VCC   |         | 15   | 30      | mA            |
| $I_{CC6}$ | Operating Current (SE)   | CS#=VCC   |         | 15   | 30      | mA            |
| $I_{CC7}$ | Operating Current (BE)   | CS#=VCC   |         | 15   | 30      | mA            |
| $I_{CC8}$ | Operating Current (CE)   | CS#=VCC   |         | 15   | 30      | mA            |
| $V_{IL}$  | Input Low Voltage        |   | -0.5    |      | 0.3VCC  | V             |
| $V_{IH}$  | Input High Voltage       |   | 0.7VCC  |      | VCC+0.4 | V             |
| $V_{OL}$  | Output Low Voltage       | $I_{OL} = 100\mu\text{A}$                           |         |      | 0.2     | V             |
| $V_{OH}$  | Output High Voltage      | $I_{OH} = -100\mu\text{A}$                          | VCC-0.2 |      |         | V             |

Note:

1. Typical value at  $T_A = 25^{\circ}\text{C}$ ,  $V_{CC} = 3.3\text{V}$ .
2. Value guaranteed by design and/or characterization, not 100% tested in production.



## 10.6 AC Characteristics

( $T_A = -40^{\circ}\text{C} \sim 85^{\circ}\text{C}$ ,  $V_{CC} = 2.7 \sim 3.6\text{V}$ )

| Symbol                   | Parameter  | Min.                    | Typ. | Max. | Unit.         |
|--------------------------|--|-------------------------|------|------|---------------|
| $f_{C1}$                 | Serial Clock Frequency for all instructions except 03H, 13H, EEH, EDH                          |                         |      | 104  | MHz           |
| $f_{C2}$                 | Serial Clock Frequency for DTR Quad I/O Fast Read (EEH, EDH) instructions                      |                         |      | 60   | MHz           |
| $f_R$                    | Serial Clock Frequency For: Read (03H, 13H)  |                         |      | 60   | MHz           |
| $t_{CLH}$                | Serial Clock High Time   | 45%<br>( $1/f_{Cmax}$ ) |      |      | ns            |
| $t_{CLL}$                | Serial Clock Low Time  | 45%<br>( $1/f_{Cmax}$ ) |      |      | ns            |
| $t_{CLCH}$<br>$t_{CHCL}$ | Serial Clock Rise Time (Slew Rate)   | 0.6                     |      |      | V/ns          |
| $t_{SLCH}$               | CS# Active Setup Time  | 4                       |      |      | ns            |
| $t_{CHSH}$               | CS# Active Hold Time   | 4                       |      |      | ns            |
| $t_{CLSH}$               | CS# Active Hold Time (DTR)   | 4                       |      |      | ns            |
| $t_{SHCH}$               | CS# Not Active Setup Time  | 5                       |      |      | ns            |
| $t_{CHSL}$               | CS# Not Active Hold Time   | 5                       |      |      | ns            |
| $t_{SHSL}$               | CS# High Time (Read)   | 20                      |      |      | ns            |
|                          | CS# High Time (Write)  | 40                      |      |      | ns            |
| $t_{SHQZ}$               | Output Disable Time  |                         |      | 8    | ns            |
| $t_{CLQX}$<br>$t_{CHQX}$ | Output Hold Time   | 1.8                     |      |      | ns            |
| $t_{DVCH}$               | Data In Setup Time (STR)   | 2                       |      |      | ns            |
| $t_{DVCH}$<br>$t_{DVCL}$ | Data In Setup Time (DTR)   | 1                       |      |      | ns            |
| $t_{CHDX}$               | Data In Hold Time (STR)  | 2                       |      |      | ns            |
| $t_{CHDX}$<br>$t_{CLDX}$ | Data In Hold Time (DTR)  | 1                       |      |      | ns            |
| $t_{CLQV}$<br>$t_{CHQV}$ | Clock Low To Output Valid ( $V_{CC} = 2.7 \sim 3.6\text{V}$ , loading=30pF)                    |                         |      | 8    | ns            |
|                          | Clock Low To Output Valid ( $V_{CC} = 2.7 \sim 3.6\text{V}$ , loading=10pF)                    |                         |      | 7    | ns            |
|                          | Clock Low To Output Valid ( $V_{CC} = 3.0 \sim 3.6\text{V}$ , loading=30pF, CR<3> = xxxx xx00) |                         |      | 7    | ns            |
|                          | Clock Low To Output Valid ( $V_{CC} = 3.0 \sim 3.6\text{V}$ , loading=10pF, CR<3> = xxxx xx00) |                         |      | 6    | ns            |
| $t_{WHSL}$               | Write Protect Setup Time Before CS# Low  | 20                      |      |      | ns            |
| $t_{SHWL}$               | Write Protect Hold Time After CS# High   | 100                     |      |      | ns            |
| $t_{DP}$                 | CS# High To Deep Power-Down Mode   |                         |      | 3    | $\mu\text{s}$ |



|              |  |     |      |     |         |
|--------------|--|-----|------|-----|---------|
| $t_{RES1}$   | CS# High To Standby Mode Without Electronic Signature Read                               |     |      | 30  | $\mu s$ |
| $t_{SUS}$    | CS# High To Next Command After Suspend   |     |      | 20  | $\mu s$ |
| $t_{RS}$     | Latency Between Resume And Next Suspend  | 100 |      |     | $\mu s$ |
| $t_{RST}$    | CS# High To Next Command After Reset (Except From Erase)                                 |     |      | 40  | $\mu s$ |
| $t_{RST\_E}$ | CS# High To Next Command After Reset (From Erase)  |     |      | 25  | ms      |
| $t_W$        | Write Status Register Cycle Time<br>Write Non-Volatile Configuration Register Cycle Time |     | 5    | 30  | ms      |
| $t_{BP1}$    | Byte Program Time (First Byte)   |     | 30   | 50  | $\mu s$ |
| $t_{BP2}$    | Additional Byte Program Time (After First Byte)  |     | 2.5  | 12  | $\mu s$ |
| $t_{PP}$     | Page Programming Time  |     | 0.15 | 1.0 | ms      |
| $t_{SE}$     | Sector Erase Time  |     | 30   | 400 | ms      |
| $t_{BE1}$    | Block Erase Time (32K Bytes)   |     | 0.15 | 1.5 | s       |
| $t_{BE2}$    | Block Erase Time (64K Bytes)   |     | 0.22 | 2   | s       |
| $t_{CE}$     | Chip Erase Time (GD25R512ME)   |     | 150  | 300 | s       |
| $t_{WRKR}$   | Write Root Key Register  |     | 0.17 | 2   | ms      |
| $t_{UHKR}$   | Update HMAC Key Register   |     | 100  | 150 | $\mu s$ |
| $t_{IMC}$    | Increment Monotonic Counter  |     | 0.08 | 250 | ms      |
| $t_{RMC}$    | Request Monotonic Counter  |     | 0.1  | 1   | ms      |

**Note:**

1. Typical value at  $T_A = 25^\circ C$ .
2. Value guaranteed by design and/or characterization, not 100% tested in production.
3. Time of CS# High To Next Command After Reset from 01H/B1H command would be  $t_W + t_{RST}$

**Figure 95. Serial Input Timing**

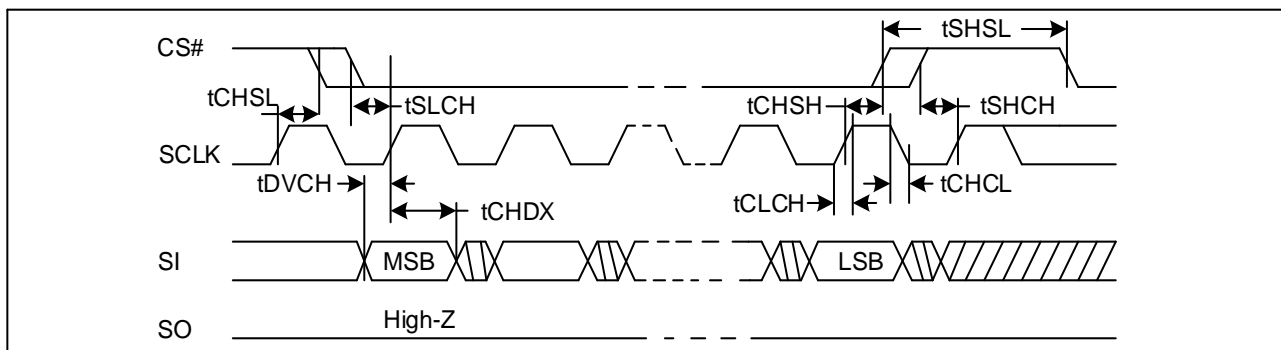




Figure 96. Output Timing

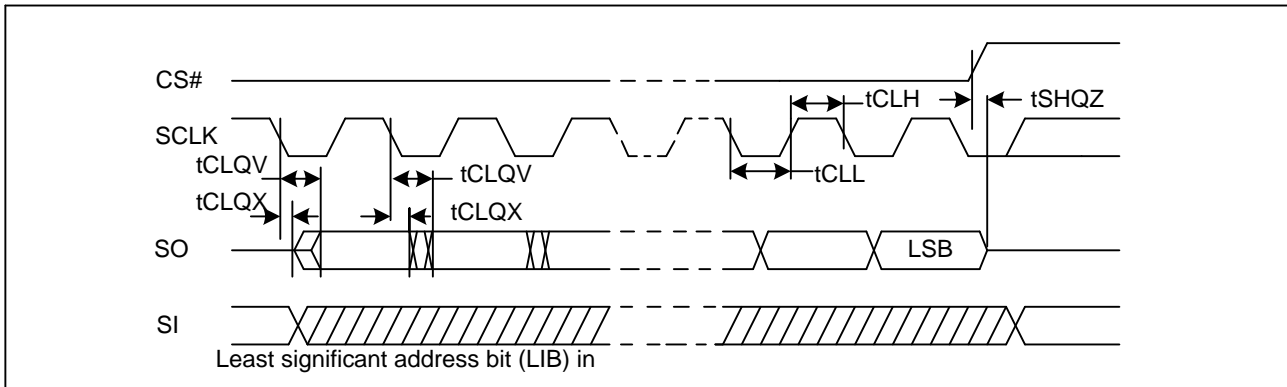


Figure 97. Serial Input Timing (DTR)

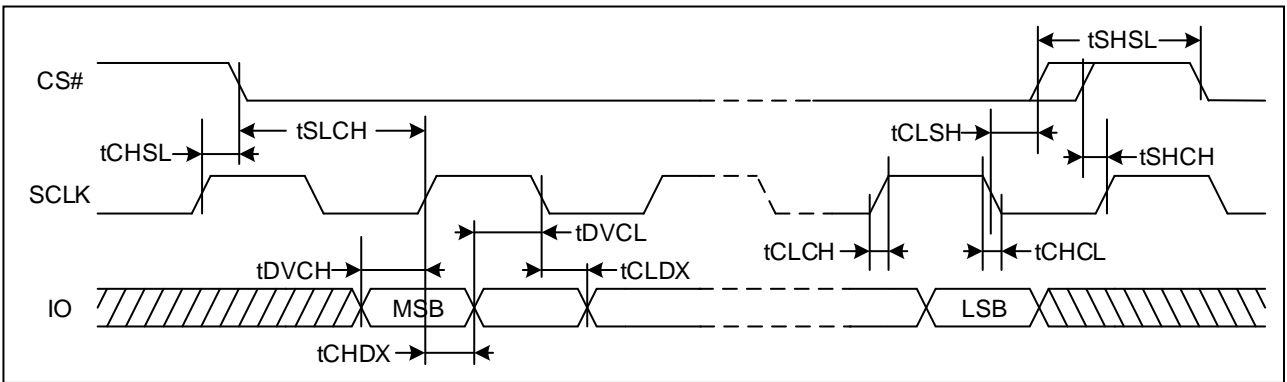


Figure 98. Serial Output Timing (DTR)

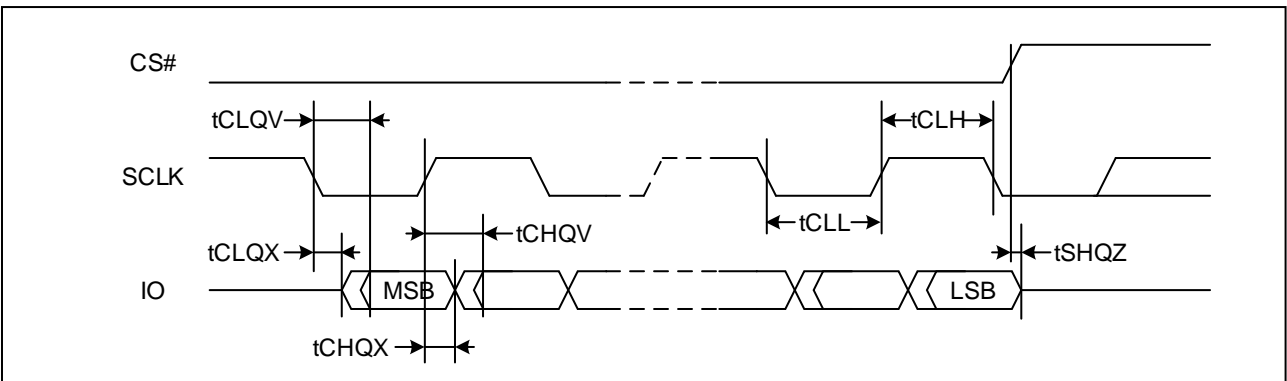




Figure 99. DQS Output Timing (STR)

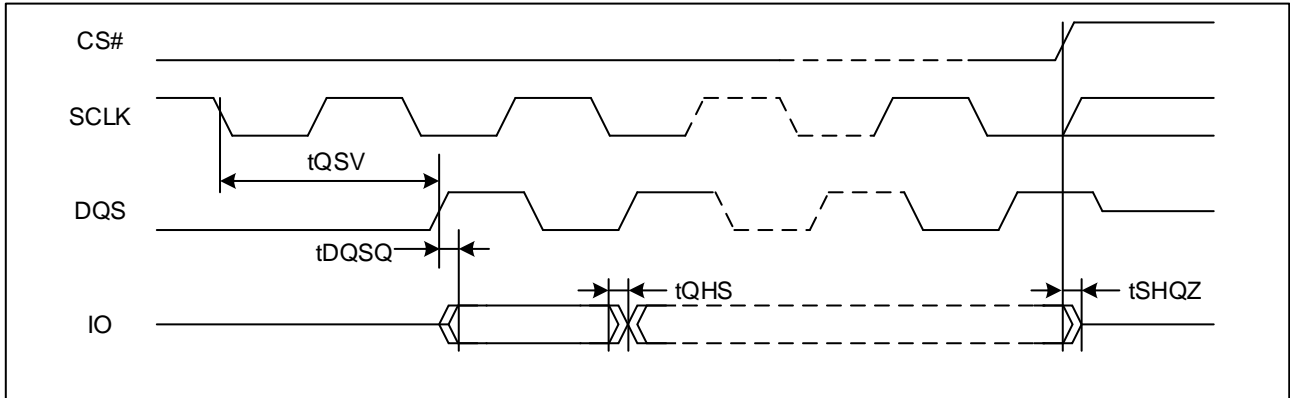


Figure 100. DQS Output Timing (DTR)

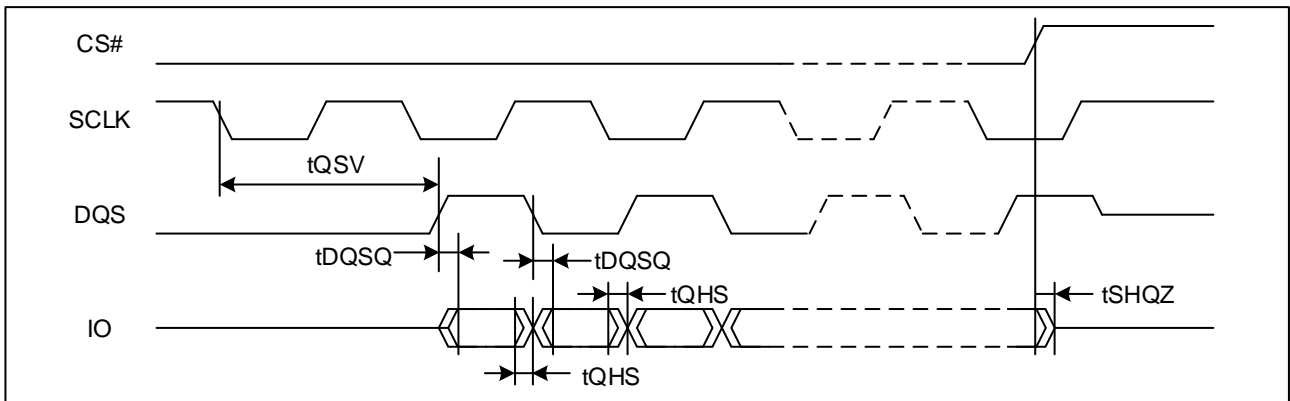


Figure 101. Resume to Suspend Timing Diagram

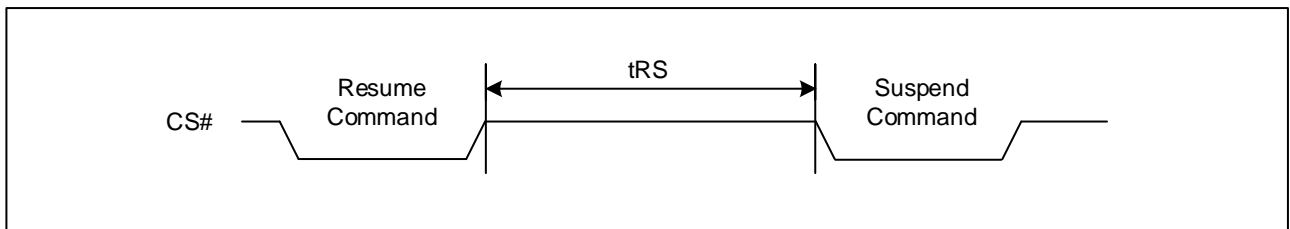


Figure 102. RESET Timing

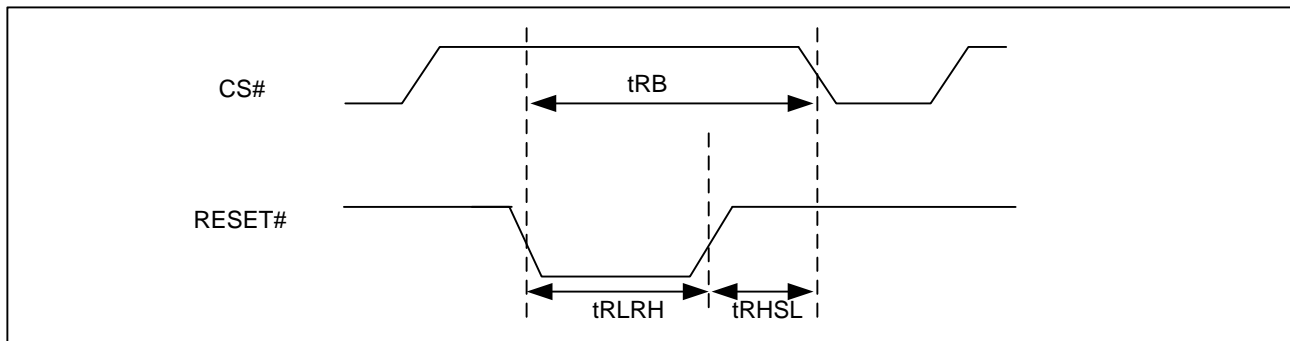




Table 25. Reset Timing

| Symbol            | Parameter                                  | Min. | Typ. | Max. | Unit. |
|-------------------|--|------|------|------|-------|
| t <sub>RLRH</sub> | Reset Pulse Width                          | 1    |      |      | μs    |
| t <sub>RHSL</sub> | Reset Hold time before next Operation      | 50   |      |      | ns    |
| t <sub>RB</sub>   | Reset Recovery Time (From Read or Program) |      |      | 40   | μs    |
|                   | Reset Recovery Time (From Erase)           |      |      | 25   | ms    |

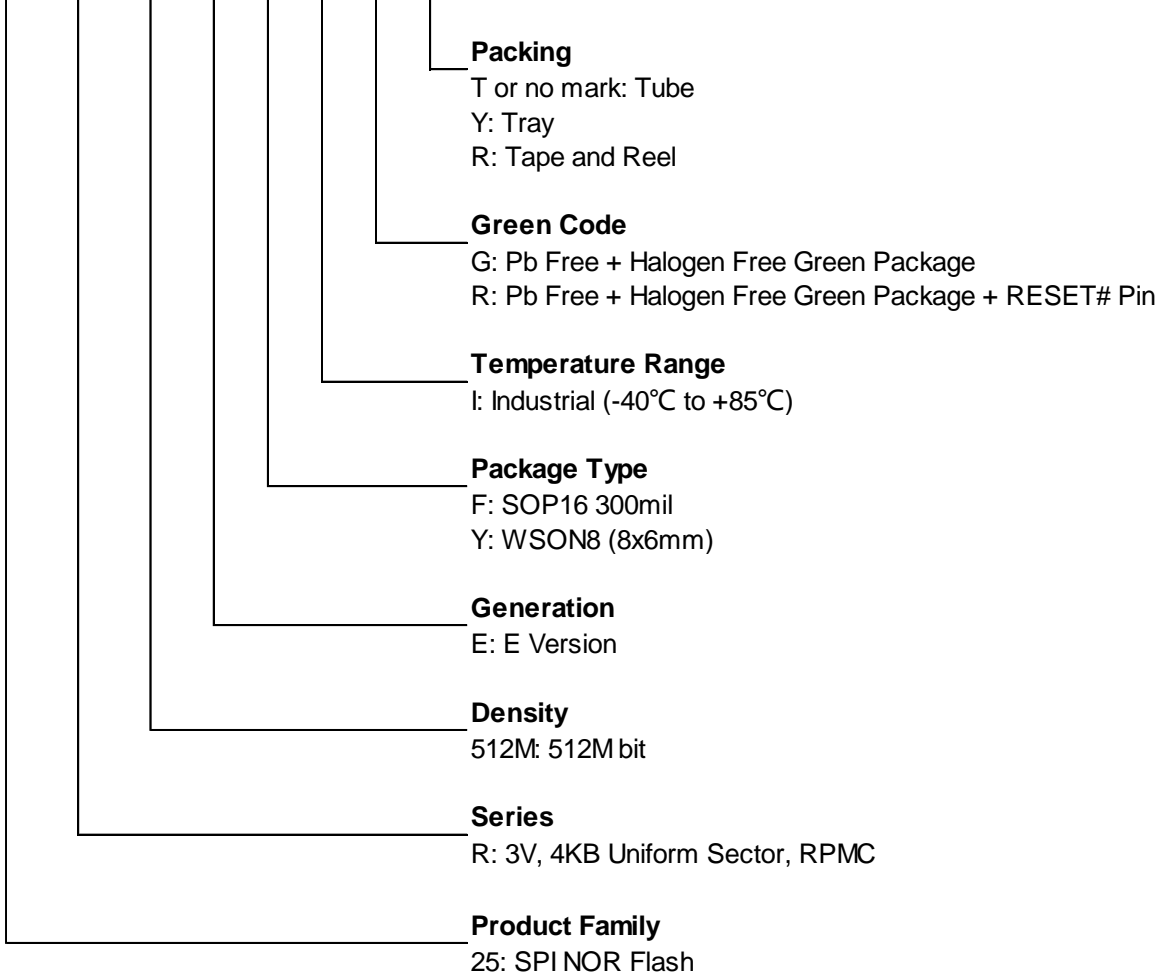
Note:

1. Time of Reset Recovery Time from 01H/B1H command would be t<sub>W</sub> + t<sub>RB</sub>
2. The device need t<sub>RB</sub> (max) at most to get ready for all commands after RESET# low.



## 11 ORDERING INFORMATION

**GD XX XX XX X X X X X**







## 11.1 Valid Part Numbers

Please contact GigaDevice regional sales for the latest product selection and available form factors.

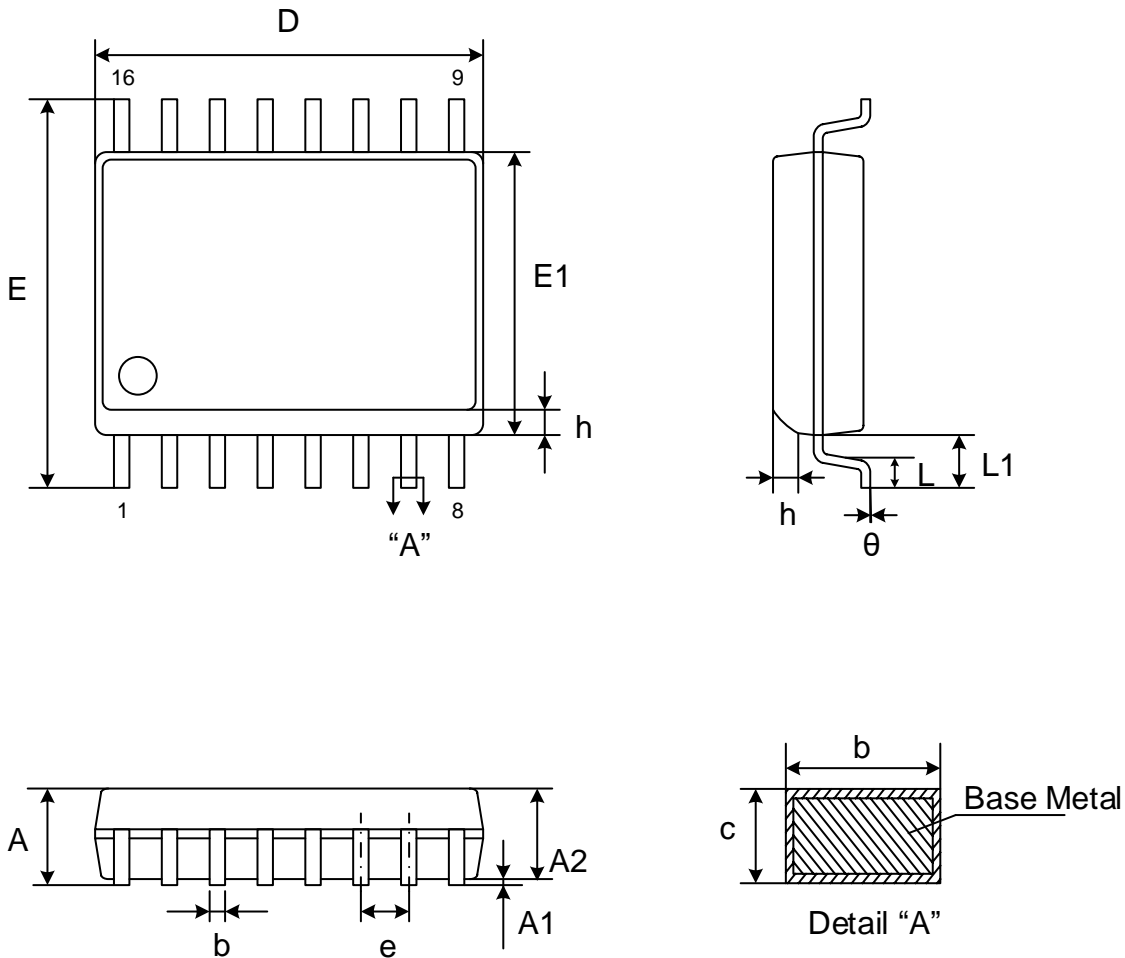
### Temperature Range I: Industrial (-40°C to +85°C)

| Product Number | Density | Package Type  | Packing Options |
|----------------|---------|---------------|-----------------|
| GD25R512MEFIR  | 512Mbit | SOP16 300mil  | T/Y/R           |
| GD25R512MEYIG  | 512Mbit | WSON8 (8x6mm) | Y/R             |



## 12 PACKAGE INFORMATION

### 12.1 Package SOP16 300MIL



#### Dimensions

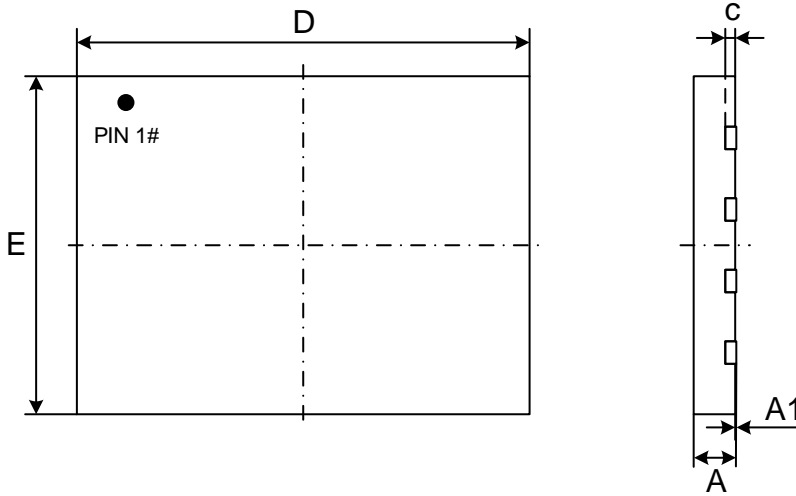
| Symbol |     | A    | A1   | A2   | b    | c    | D     | E     | E1   | e    | L    | L1   | h    | $\theta$ |
|--------|-----|------|------|------|------|------|-------|-------|------|------|------|------|------|----------|
| Unit   |     |      |      |      |      |      |       |       |      |      |      |      |      |          |
| mm     | Min | -    | 0.10 | 2.05 | 0.31 | 0.10 | 10.20 | 10.10 | 7.40 | 1.27 | 0.40 | 1.40 | 0.25 | 0        |
|        | Nom | -    | 0.20 | -    | 0.41 | 0.25 | 10.30 | 10.30 | 7.50 |      | -    |      | -    | -        |
|        | Max | 2.65 | 0.30 | 2.55 | 0.51 | 0.33 | 10.40 | 10.50 | 7.60 |      | 1.27 |      | 0.75 | 8        |

Note:

- Both the package length and width do not include the mold flash.
- Seating plane: Max. 0.1mm.

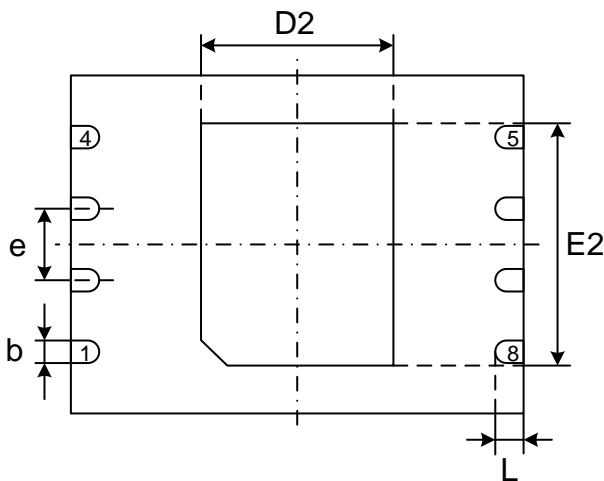


**12.2 Package WSON8 (8x6mm)**



Top View

Side View



Bottom View

**Dimensions**

| Symbol |     | A    | A1   | c     | b    | D    | D2   | E    | E2   | e    | L    |
|--------|-----|------|------|-------|------|------|------|------|------|------|------|
| Unit   |     |      |      |       |      |      |      |      |      |      |      |
| mm     | Min | 0.70 | 0.00 | 0.180 | 0.35 | 7.90 | 3.30 | 5.90 | 4.20 | 1.27 | 0.45 |
|        | Nom | 0.75 | 0.02 | 0.203 | 0.40 | 8.00 | 3.40 | 6.00 | 4.30 |      | 0.50 |
|        | Max | 0.80 | 0.05 | 0.250 | 0.45 | 8.10 | 3.50 | 6.10 | 4.40 |      | 0.55 |

Note:

- Both the package length and width do not include the mold flash.
- The exposed metal pad area on the bottom of the package is floating.
- Coplanarity  $\leq 0.08\text{mm}$ . Package edge tolerance  $\leq 0.10\text{mm}$ .
- The lead shape may be of little difference according to different package lead frames. These lead shapes are compatible with each other.



### 13 REVISION HISTORY

| Version No | Description  | Page                           | Date       |
|------------|--|--------------------------------|------------|
| 1.0        | Initial release  | All                            | 2020-11-26 |
| 1.1        | Update Description of RESET# pin<br>Modify Driver Strength Default value from 50 Ohm to 25 Ohm<br>Modify Supported Clock Frequencies<br>Modify Typo Input Timing Reference Voltage from 0.2VCC to 0.3VCC | P5, 6<br>P17,P18<br>P20<br>P65 | 2021-7-2   |



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